



SERVICE MANUAL

TR-7730

VHF FM TRANSCEIVER



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SPECIFICATIONS/CIRCUIT DESCRIPTION

[General]

Semiconductors	ICs	15 (K, M) 16 (W, T)
	Transistors	46 (K, M) 49 (W, T)
	FETs	7
	Diodes	91 (K, M) 95 (W, T)
Frequency range	144.000 to 147.995 MHz (K, M) 144.000 to 145.995 MHz (W, T)	
Frequency synthesizer	Digital control, phase locked VCO	
Mode	FM (F3)	
Antenna impedance	50 ohms	
Power requirement	13.8 V DC \pm 15%	
Grounding	Negative	
Operating temperature	- 20°C to + 60°C	
Current drain	0.4A in receive mode with no input signal 5.5A in HI transmit mode (Approx.) 3A in LOW transmit mode (Approx.) Less than 2.5 mA for memory back up (from power supply)	
Dimensions	147.5 mm (5-3/4") wide 51.5 mm (2") high 198.0 mm (7-3/4") deep (projections excluded)	
Weight	1.5 kg (3.3 lbs) (Approx.)	

[Transmitter Section]

RF output power

(at 13.8 V DC, 50 Ω load)	HI 25 Watts min. LOW 5 Watts approx. (Adjustable)
Modulation	Variable reactance direct shift
Frequency tolerance (- 10°C ~ + 50°C)	Less than $\pm 20 \times 10^{-6}$
Spurious radiation	HI Less than - 60 dB LOW Less than - 53 dB
Maximum frequency deviation (FM)	± 5 kHz
Microphone	Dynamic microphone with PTT, up, down, switches, 500 Ω

[Receiver Section]

Circuitry	Double conversion superheterodyne
Intermediate frequency	1st IF 10.7 MHz 2nd IF 455 kHz
Receiver sensitivity	Better than 0.5 μV for 30 dB S/N Better than 0.25 μV for 12 dB SINAD
Receiver selectivity	More than 12 kHz (- 6 dB) Less than 25 kHz (- 60 dB)
Spurious response	Better than 60 dB
Squelch sensitivity	0.16 μV (threshold)
Audio output	More than 2.0 watts across 8 ohm load (10% dist.)

Note: Circuit and ratings are subject to change without notice due to developments in technology.

NOTE : Letter designations used in this manual :

K U.S.A.	X AUSTRALIA
T BRITAIN	M GENERAL MARKET
W EUROPE	

< RECEIVER SECTION >

RX.TX UNIT (X44-1450-XX)

The antenna signal is applied to the RF amplifier (Q3 : 3SK76), a dual gate MOS FET and helical resonator L5 (3 poles) and L6 (2 poles), and is then converted to the 10.7 MHz 1st IF signal by Q4, the 1st mixer.

A 2-stage MCF (Monolithic crystal filter) is used in the 1st IF stage. All this achieves high dynamic range and high sensitivity.

The 1st IF signal, after passing through the MCF, is mixed with the 10.245 MHz 2nd local oscillator signal, generated by Q5 to obtain a 455 kHz 2nd IF signal.

This signal passes through the ceramic filter (CFW455F) and is amplified by IC1, Q7 through Q10, and is then demodulated. An S meter signal is obtained by detecting the signal from the collector of Q7 by diodes D2 and D3, and is then applied to the display unit. The S meter uses 8 LEDs, and indicates 6 amber and 1 red LED when the antenna input level is 15 dBμ.

CIRCUIT DESCRIPTION

Item	Rating
Nominal center frequency (f_0)	10.7 MHz
Pass bandwidth	$f_0 \pm 7.5$ kHz or more at 3 dB
Attenuation bandwidth	$f_0 \pm 25$ kHz or less at 40 dB $f_0 \pm 45$ kHz or less at 60 dB
Guaranteed attenuation	70 dB or more within $f_0 \pm 1$ MHz 80 dB or more within $f_0 - (910 \text{ kHz} \pm 10 \text{ kHz})$
Spurious	40 dB or more within f_0 to $f_0 + 500$ kHz
Ripple	1.0 dB or less
Loss	1.5 dB or less
Input and Output impedance	$3\text{k}\Omega$
Operating temperature	-20°C~+70°C

Table 1 MCF (L71-0219-05) (RX.TX unit, L17)

Item	Rating
Nominal center frequency	455 kHz
6 dB bandwidth	± 6 kHz or more
50 dB bandwidth	± 12.5 kHz or less
Ripple (within 455 ± 4 kHz)	3 dB or less
Loss	6 dB or less
Guaranteed attenuation (within 455 ± 100 kHz)	35 dB or more
Input and output impedance	$2.0\text{k}\Omega$

Table 2 Ceramic filter CFW455F (L72-0315-05) (RX.TX unit, L18)

Item	Rating
Center frequency and deviation	$455 \text{ kHz} \pm 1.0 \text{ kHz}$
Peak separation	15 kHz or more
Voltage sensitivity (at 455 kHz)	15 mV/kHz or more
Operating temperature	-10°C~+50°C

Table 3 Ceramic discri CFY455S (L79-0446-05) (RX.TX unit, L19)

< TRANSMITTER >

RX.TX UNIT (X44-1450-XX)

The microphone signal is amplified and limited by IC2 (TA7061AP), and is then applied to D1 (1S2208) in the PLL unit to directly modulate the VCO. The VCO generates 144~145.995 MHz (W, T) or 143.9~148.995 MHz (K, M) according to the control signal from the microprocessor.

The VCO signal is amplified by Q2 and Q3 in the PLL unit, and then applied to the RX.TX unit via the LT terminal. The signal is amplified by Q1 and Q2 before it is applied to the power module. This simple transmitter structure provides superior spurious radiation characteristic. The HIGH/LOW switch signal is applied to Q28, Q22 and Q21 in the RX.TX unit, which controls the B+ voltage applied to the driver stage (Q2), so that final input and output power is varied. The RF meter is adjusted so that 6 amber LEDs light at HIGH power. However, the number of LEDs on may vary according to the VSWR of the antenna system.

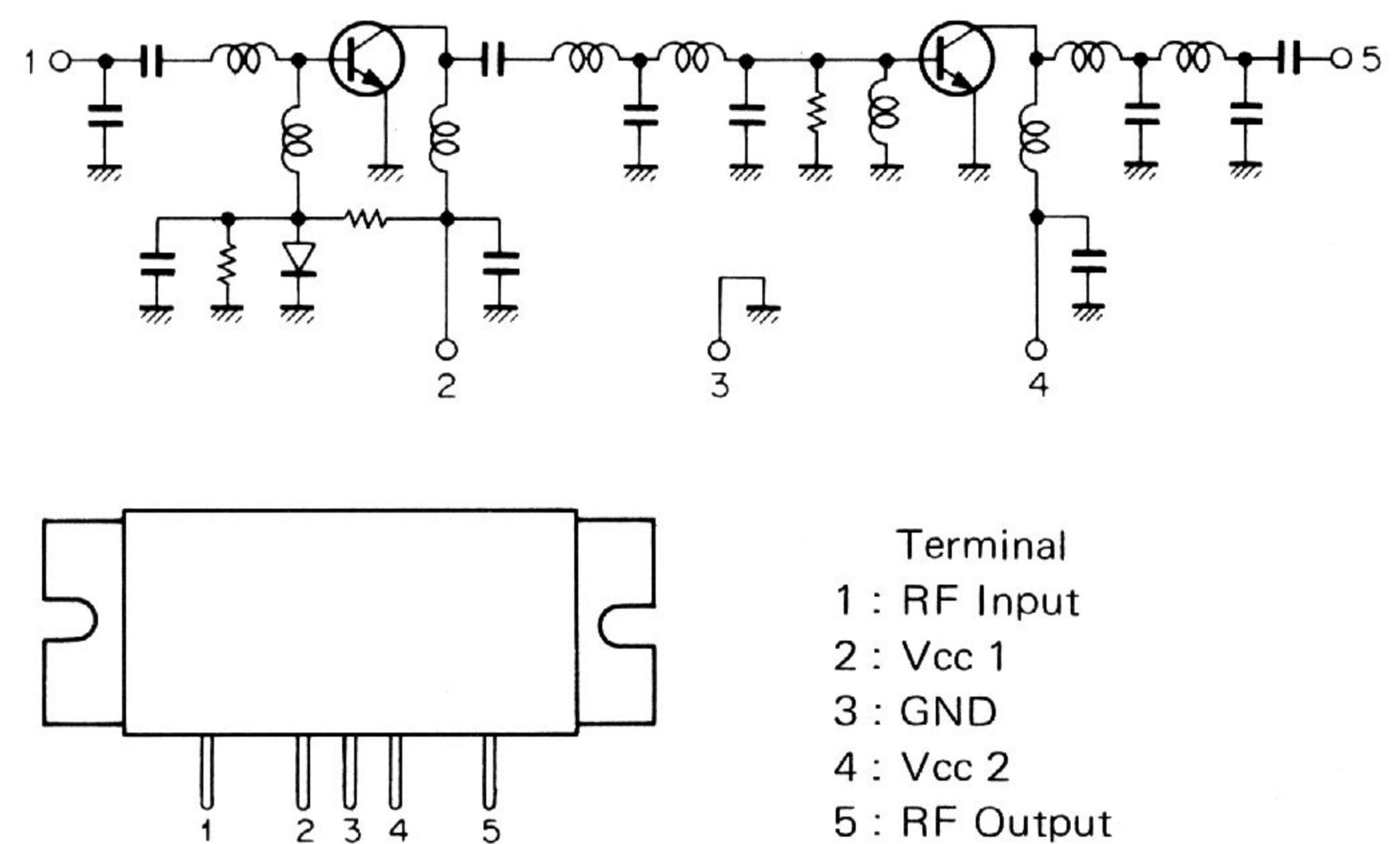


Fig. 1 POWER MODULE VP-15E1305

Item	Symbol	MAX Rating	Condition
Power supply voltage	Vcc	17V	Tc = 25°C
DC current	Icc	8A	Tc = 25°C
Operating case temperature	Top	-30~100°C	
Storage temperature	Tstg	-40~110°C	

VP-15E1305 MAX Rating

Item	Symbol	Condition	Rating			Unit
			MIN	TYP	MAX	
f range	f		144		148	MHz
Power input	Pin			250		mW
Power output	Po	Pin = 250 mW Vcc = 13.0V	30			W
Operating voltage	Vcc			13.0		V
Input and output impedance	Z	Pin = 250 mW Vcc = 13.0V		50		Ω
Total efficiency	ηT	Pin = 250 mW Vcc = 13.0V	45	50		%

VP-15E1305 Electrical Characteristic

CIRCUIT DESCRIPTION

PLL CIRCUIT (X50-1750-10)

VCO Q1 : 2SK19 (GR) generates 143.900~148.995 MHz (K, M) or 144.00~145.995 MHz (W, T) during transmission and 133.200~138.295 MHz (K, M) or 133.30~135.295 MHz (W, T) during reception.

The VCO signal is buffered by Q2 and amplified by Q3 and Q4. It is then mixed with the HET signal (from Q5) by Q12 to obtain a PLL IF signal (5.4~10.495 MHz [K, M] or 5.5~7.49 MHz [W, T]).

The HET signal is generated by Q5, a third overtone oscillator using a 46.1666 MHz crystal to generate 138.5 MHz for transmission and a 42.6 MHz crystal to generate 127.8 MHz for reception. Both frequencies are shifted 5 kHz when the 5K control signal from the control unit (X53-1120-10) is applied to D9 and D10 to shunt TC3 and TC4.

The resonant frequencies of L5, L7, L10, and the VCO tank circuit and the HET frequency are switched for reception and transmission using the 8R (8V DC during reception) and 8T (8V DC during transmission) control lines.

The PLL IF signal is amplified by Q10 and buffered by Q11 and Q9, and then applied to pin 2 of IC3 (TC9122P) the programmable divider. IC3 is supplied with frequency dividing data from the control unit : 550~1049 (K, M) or 550~749 (W, T) in BCD, and the PLL IF frequency is also divided to a 10 kHz signal for a phase-lock comparison signal. IC2 (TC5082P-GL) is the 10.24 MHz oscillator. Its output is divided by 1024 to 10 kHz for IC1's reference signal. These comparison and reference signals are input to the phase comparator (IC1 : TC5081P) and the resultant DC output signal is applied through the low pass filter Q8 and Q7 to the VCO tank circuit through varicap diode (D2 : 1S2208) to control the VCO output frequency. If the PLL unlocks, the voltage at IC1 pin4 drops to turn off Q6 and D11, which shuts off Q3.

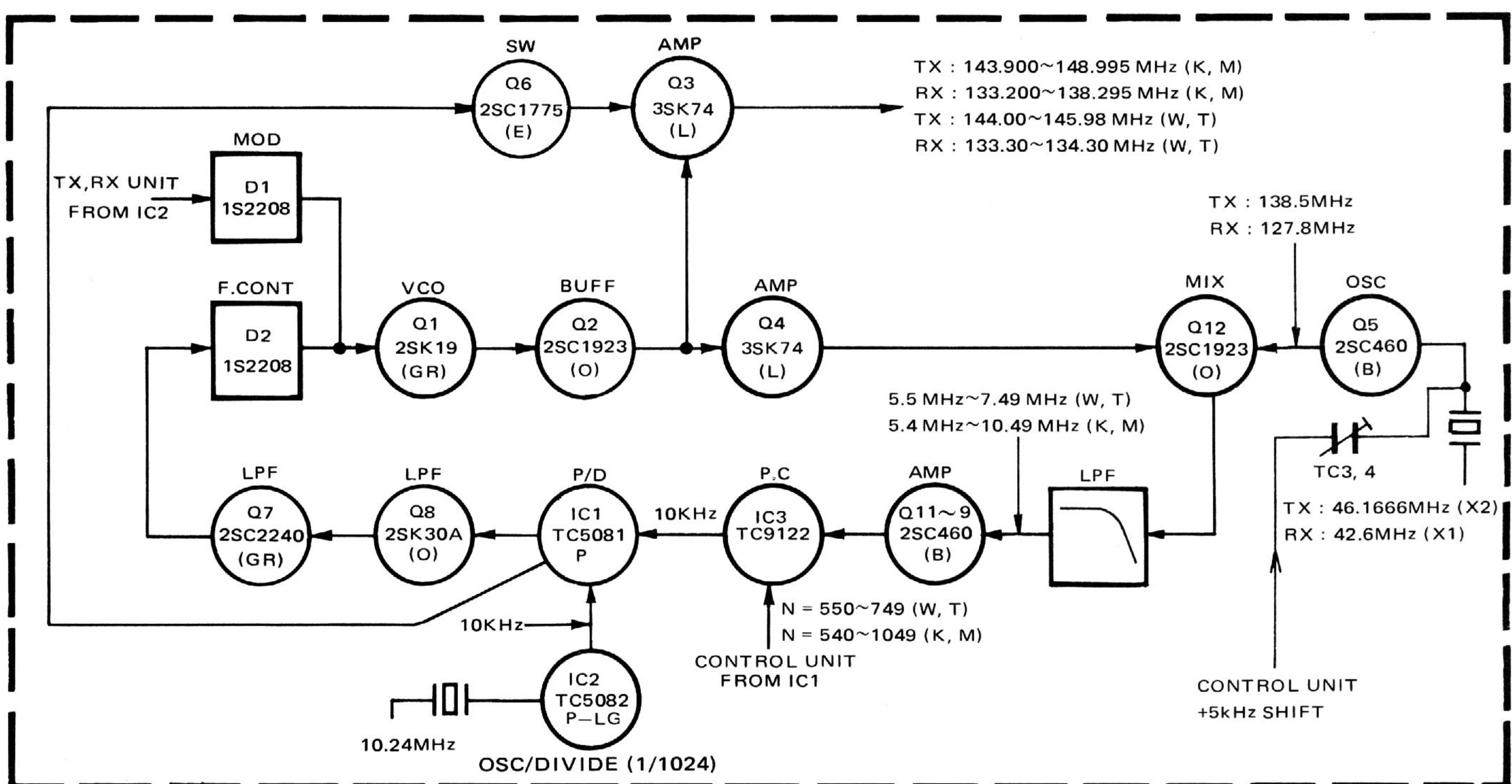


Fig. 2 PLL unit block diagram

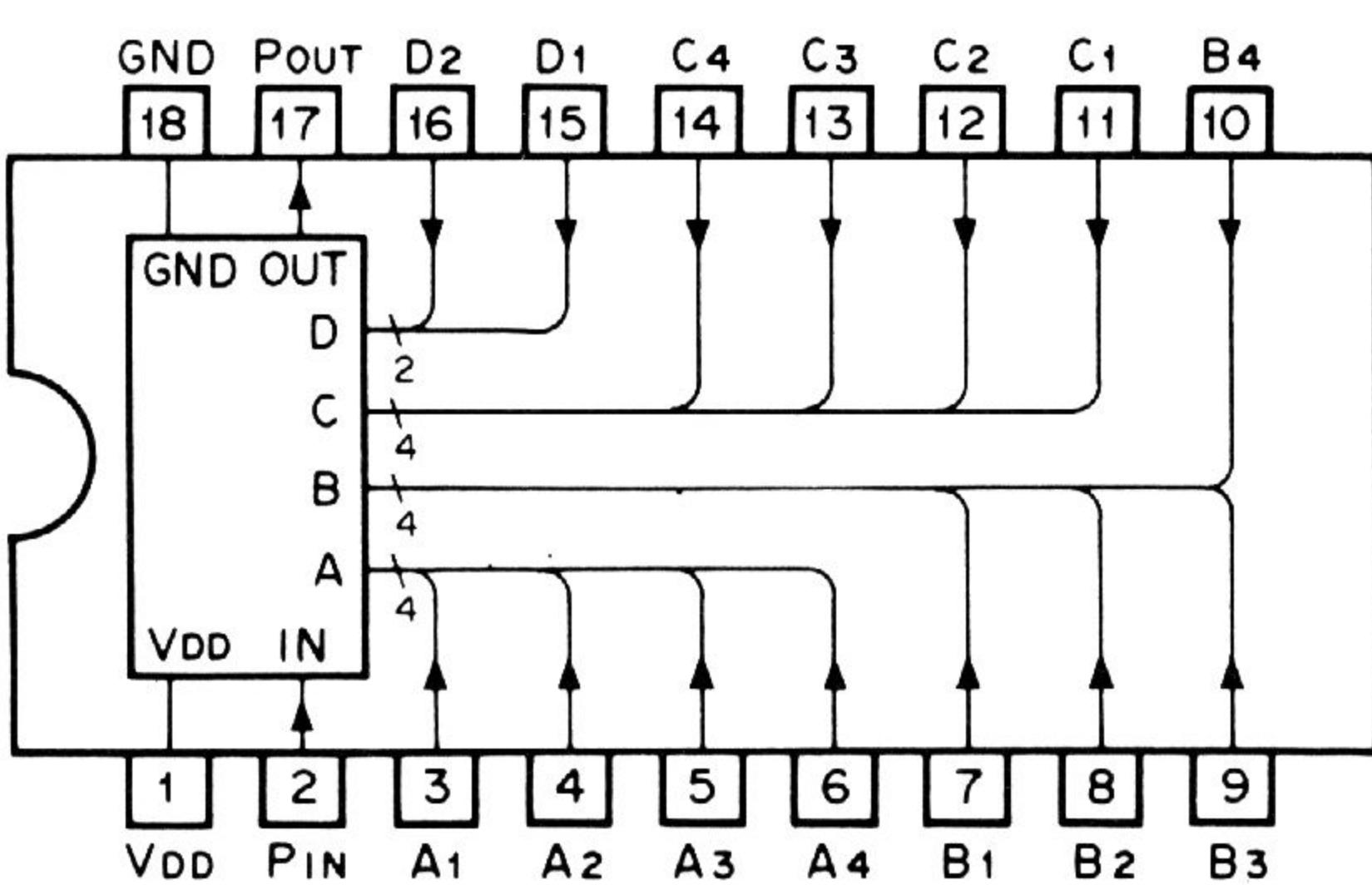
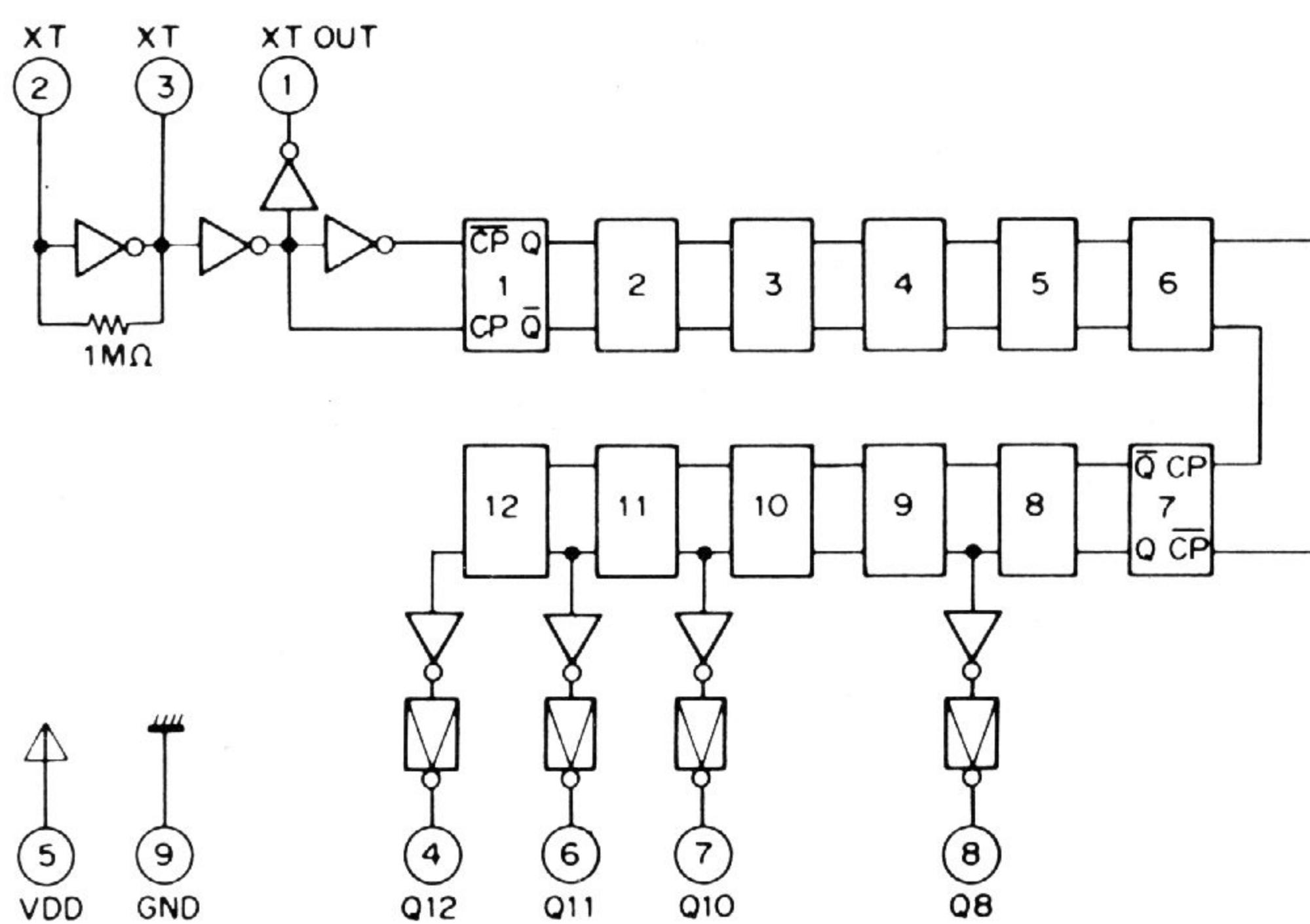


Fig. 3 TC9122P (PLL unit, IC3)

Symbol	Name	Content and operation	Remarks
Pin	Programmable counter input terminal	Programmable counter input terminal to which the signal to be divided is input.	Build-in bias circuit
Pout	Programmable counter output terminal	Programmable counter output terminal. Output is 1/N of the input frequency. The output pulse width equals 5 bit of the input.	
A ₁ ~A ₄ B ₁ ~B ₄ C ₁ ~C ₄ D ₁ ~D ₄	x 1 x 10 x 100 x 1000 Program input terminals	Terminal to set the dividing ratio. The following input combination is prohibited. A ₁ A ₂ A ₃ A ₄ B ₁ B ₂ B ₃ B ₄ C ₁ C ₂ C ₃ C ₄ D ₁ D ₂ 1 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 1 0 0 0 0 0 0 0 0 0 0 0 0 0 0 1 1 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 1 0 0 0 0 0 0 0 0 0 0 0 0 0 1 0 1 0 0 0 0 0 0 0 0 0 0 0 0 0 0 1 1 0 0 0 0 0 0 0 0 0 0 0 0 0 1 1 1 0 0 0 0 0 0 0 0 0 0 0 0 0	Built-in pull-down resistor

Table 4 TC9122P (PLL unit, IC3)

CIRCUIT DESCRIPTION



PIN NO	8	7	6	4	1
PIN NAME	Q_8	Q_{10}	Q_{11}	Q_{12}	XT _{out}
Dividing ratio	1/256	1/1024	1/2048	1/4096	1/1
Output frequency X-tal 10.24 MHz	40 kHz	10 kHz	5 kHz	2.5 kHz	10.24 MHz

Fig. 4 TC5082P-GL (PLL unit, IC2)

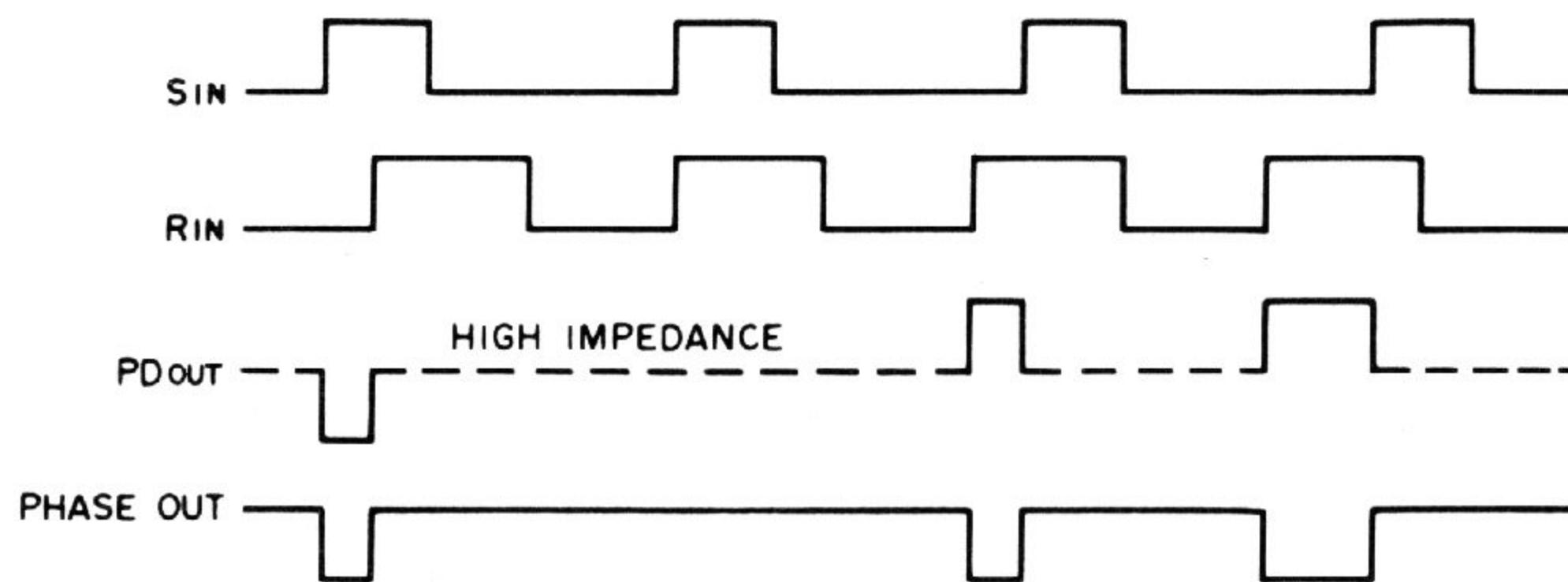


Fig. 5-A TC5081P (PLL unit, IC1) Timing chart

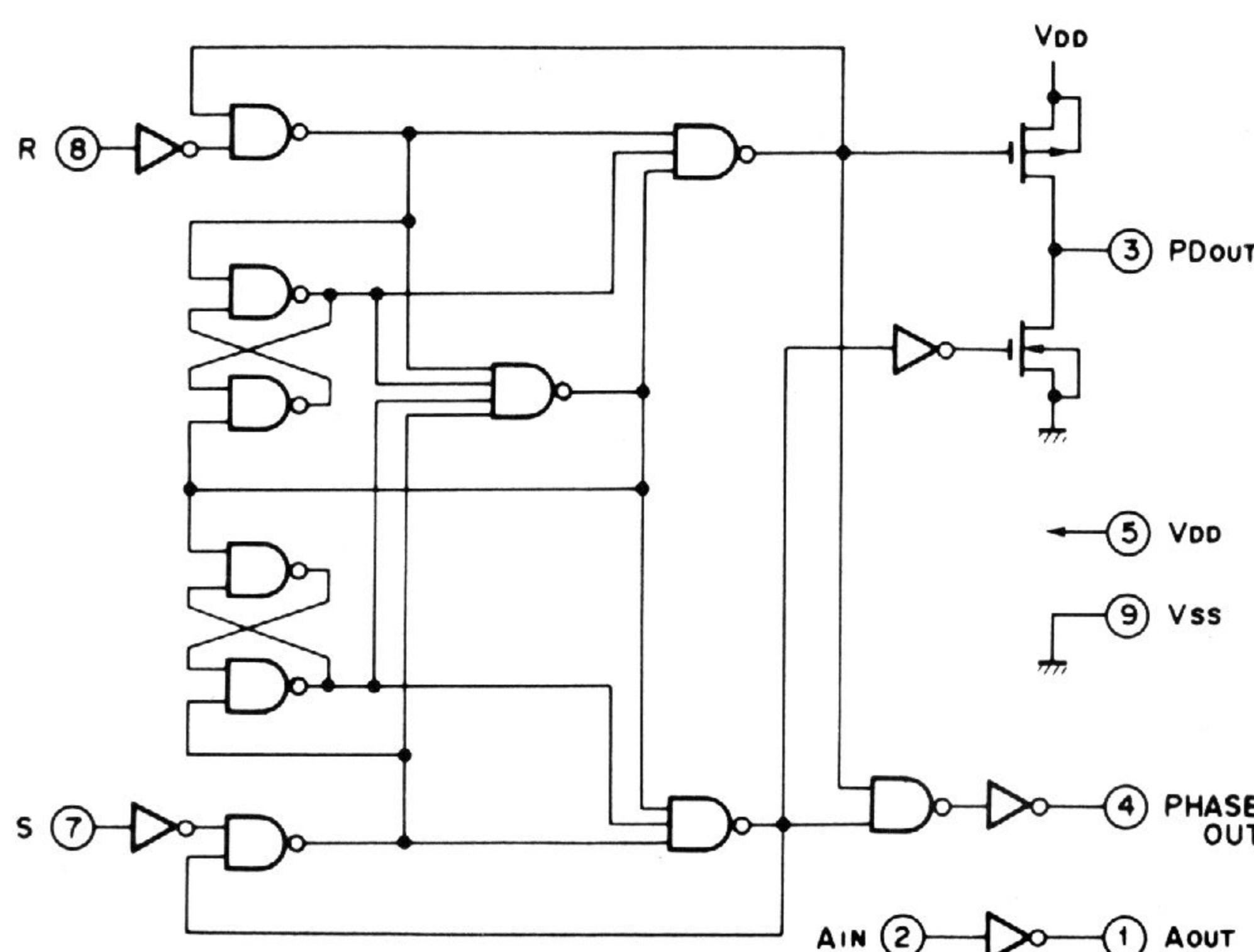


Fig. 5-B TC5081P (PLL unit, IC1) Equivalent circuit

CONTROL CIRCUIT (X53-1230-10)

Fig. 6 shows a block diagram of the control circuit, which uses a microprocessor to minimize the number of peripheral circuits.

● Frequency Indicator

The frequency indicator uses a 4 digit dynamically driven LED display. The BCD data from the microprocessor D port (pins 8~11) is converted by decoder driver IC2 (TC 5022BP) into the segment signals which are applied to the corresponding segments of all digits. The signals from the E port (pins 12~15) turn ON Q7 through Q10 (2SC1959) to light the digits.

● PLL Data (Frequency Dividing Data)

The frequency dividing data is output from ports D, E, G, H and I (pins 9~11, 12, and 22~32) in BCD. It is 550 when 4.000 is displayed, 650 when 5.000 is displayed, 749 when 5.99 is displayed and 1049 (K, M only) when 8.99 is displayed.

● Reset Circuit

Current flows through D36 when the power source voltage supplied to the microprocessor exceeds about 3.5V. The collector voltage of Q5 (2SC1815 (Y)) then becomes H and a pulse is generated by the CR differentiating circuit. This pulse is applied to and resets the microprocessor.

● Switch Circuit

One terminal of each control switch is connected to one of the control pulse signal output terminals of the microprocessor and the other terminal to one of the input terminals. When a control switch is turned ON, the corresponding output pulse signal is input to the corresponding input terminal and the prescribed function is performed. Diodes are used to prevent the control pulse signals from being input to the wrong circuit.

● Encoder and UP/DOWN Switch Input Circuit

The mechanical encoder output signals are applied to the Schmitt circuits formed by IC102 (TC7404UBP), then applied to part A (pins 33~36) of the microprocessor. The microprocessor judges UP/DOWN and counts the number of applied pulses. One turn of the dial equals 50 step output.

● Scan Circuit

Scan operation is controlled entirely by the microprocessor. It starts when the SCAN switch is pressed and stops when either the HOLD switch is pressed or the transmit signal (8T) becomes H. Scan operation temporarily stops when the squelch stop signal (input to the SS terminal) becomes H. Variation of the frequency dividing data for the least significant digit is detected by the circuit consisting of Q1, Q2 and the OR circuit D10~13 so that a pulse is obtained every time the data changes. This pulse signal is applied to the scan stop terminal (pin 4) of the microprocessor to momentarily suspend slow scanning after the frequency has been changed.

CIRCUIT DESCRIPTION

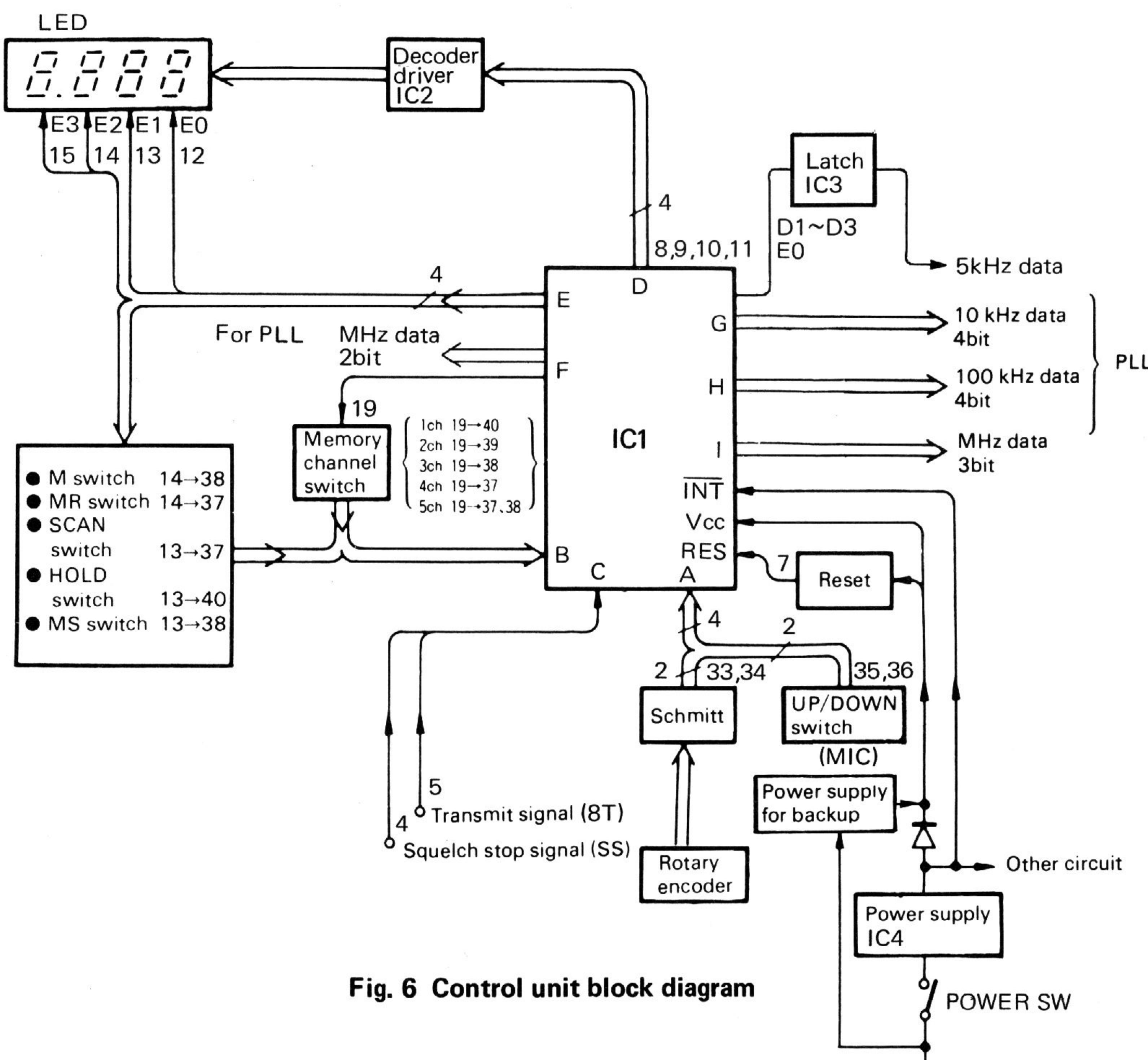


Fig. 6 Control unit block diagram

Pin No.	Pin	Input signal	Output signal	Note	Pulse signal
1	CL1			Clock signal 400 kHz	
2	PC0			Normally L	
3	PC1	O		Normally L	
4	PC2	O		Squelch signal, SCAN stops when H.	
5	PC3	O		Normally L, H during transmission.	
6	INT	O		Normally H	
7	RES	O		Microprocessor is reset when H.	
8	PD0	O	O	10 kHz, 100 kHz, and MHz digit signals are output.	O
9	PD1	O	O		O
10	PD2	O	O		O
11	PD3	O	O		O
12	PE0		O	5 kHz digit signal is output.	O
13	PE1		O	10 kHz digit signal, SCAN, HOLD or M.S is output.	O
14	PE2		O	100 kHz digit signal, M or MR is output.	O
15	PE3		O	1 MHz digit signal is output.	O
16	PF0			Not connected.	
17	PF1		O	1 MHz data signals for PLL	L
18	PF2		O		L
19	PF3		O	Memory output signal	O
20	TEST			Normally H	
21	Vcc			5V power supply	

Pin No.	Pin	Input signal	Output signal	Note	Pulse signal
22	PG0		O	(Level at 145.00 MHz) A } 10 kHz data signals for PLL	I L
23	PG1		O		I L
24	PG2		O		I L
25	PG3		O		I L
26	PH0		O	A } 100 kHz data signals for PLL	I H
27	PH1		O		I L
28	PH2		O		I H
29	PH3		O		I L
30	PI0		O	A } 1 MHz data signals for PLL	I L
31	PI1		O		I H
32	PI2		O		I H
33	PA0	O		Encoder signal	
34	PA1	O		Encoder signal	
35	PA2	O		Normally H, L when MIC UP switch is pressed.	
36	PA3	O		Normally H, L when MIC DOWN switch is pressed.	
37	PB0	O		MR, SCAN, Memory CH4 or 5 pulse signal is input.	O
38	PB1	O		M, MS, Memory CH3 or 5 pulse signal is input.	O
39	PB2	O		Memory CH2 pulse signal is input.	O
40	PB3	O		STEP or Memory CH1 pulse signal is input.	O
41	GND			GND	
42	CL0			Clock signal 400 kHz	

Table 5 Microprocessor Functions μPD650C-021 (Control unit, IC1)

CIRCUIT DESCRIPTION

● Power Supply for control system

Transistor Q6 (2SC496 (Y)) generates 5V for the frequency display. A 6V AVR (Automatic voltage regulator) IC (IC4 : NJM78L06K) supplies power to the microprocessor through diode D18.

● Backup Circuit

The level at the microprocessor INT terminal becomes L when the POWER SW is turned OFF, and the microprocessor enters the backup mode. In this mode, all output ports are low to minimize power consumption. At power OFF, the backup supply is Q24 (2SC2603 (E)) on the RX.TX unit.

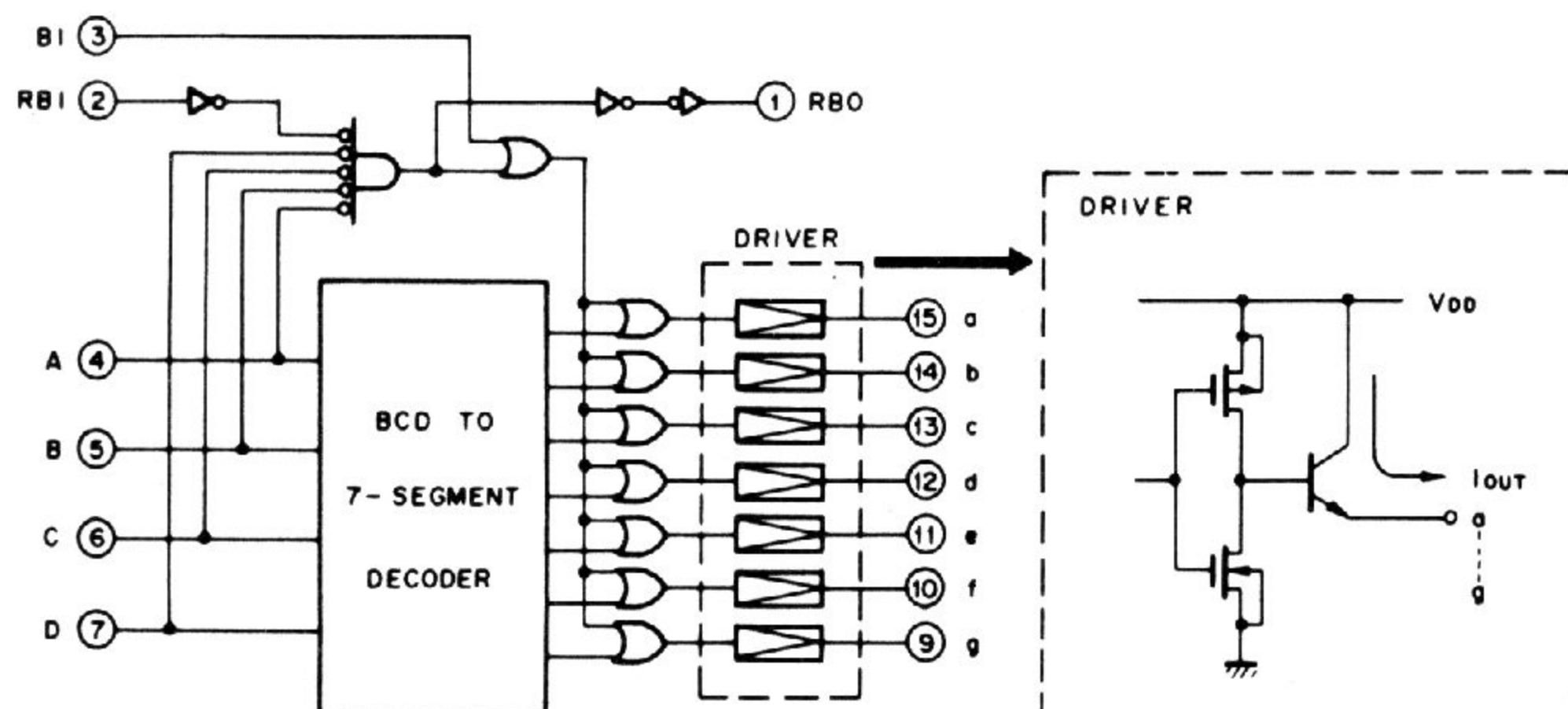


Fig. 7 TC5022BP (Control unit, IC2) Equivalent circuit

INPUT					OUTPUT								☆	
B	I	RBI	A	B	C	D	a	b	c	d	e	f	g	☆
H	*	*	*	*	*	*	L	L	L	L	L	L	L	☆
L	H	L	L	L	L	L	L	L	L	L	L	L	H	
L	L	L	L	L	L	L	H	H	H	H	H	H	L	
L	*	H	L	L	L	L	L	H	H	L	L	L	L	
L	*	L	H	L	L	L	H	H	L	H	H	L	L	
L	*	H	H	L	L	L	H	H	H	H	L	L	L	
L	*	L	L	H	L	L	L	H	H	L	L	H	L	
L	*	H	L	H	L	L	H	L	H	H	L	H	L	
L	*	L	H	H	L	L	H	L	H	H	H	H	L	
L	*	H	H	H	L	L	H	H	H	L	H	L	L	
L	*	L	L	H	H	L	H	H	H	H	H	H	L	
L	*	H	H	H	H	L	H	H	L	H	H	H	L	
L	*	L	L	H	H	H	H	H	L	H	H	H	L	
L	*	H	H	H	H	H	H	H	H	L	H	H	L	
L	*	L	H	H	H	H	L	H	H	L	H	H	L	
L	*	H	H	H	H	H	H	H	H	H	H	H	L	

☆ : Undetermined
* : Don't Care

Table 6 TC5022BP (Control unit, IC2) Truth table

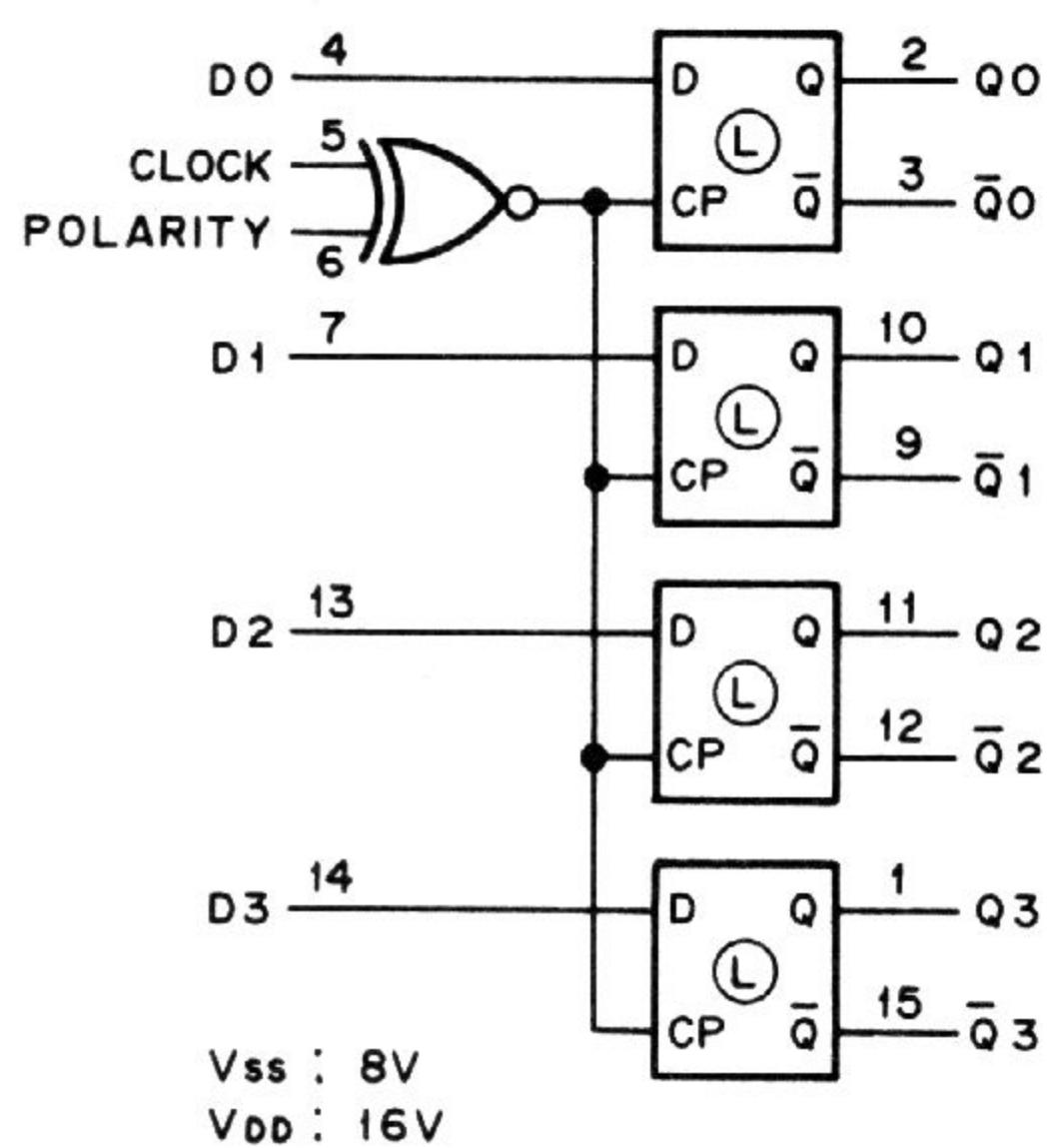


Fig. 8 TC4042BP Block diagram

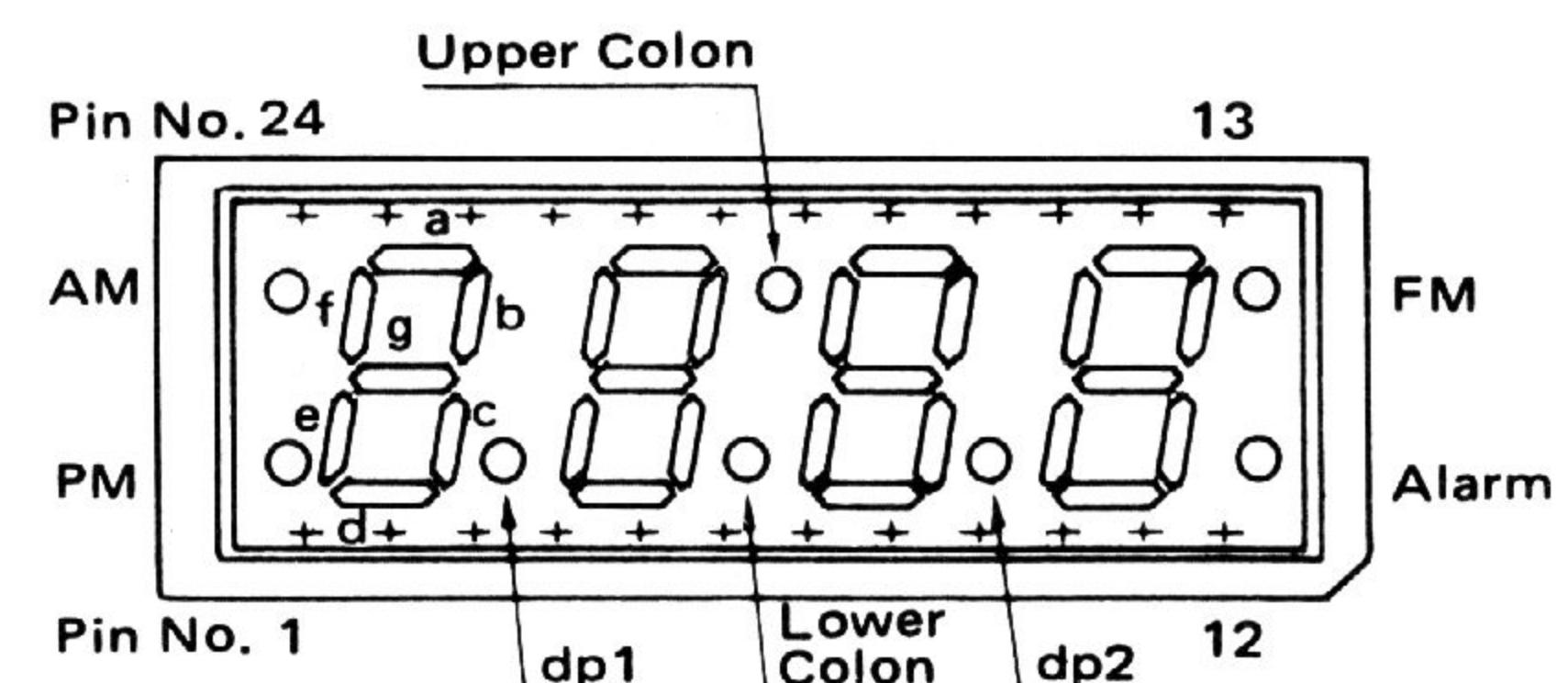
INPUTS		OUTPUT
CLOCK	POLARITY	Qn *
H	H	Dn
L	L	Dn
	L	LATCH
	H	LATCH

△ Level change
* n : 0~3

Table 7 TC4042BP Truth table

When the POWER SW is turned ON, the levels at both the INT (pin 6) and UP/DOWN (pins 35 and 36) terminals become H, returning the microprocessor to operation as before the POWER SW was turned OFF.

Input port B pins (37~40) are grounded by Q3 and Q4 when the POWER SW is turned OFF, and scan operation is stopped by momentarily simulating the transmission mode through Q11.



PIN NO	FUNCTION	PIN NO	FUNCTION		
1	PM	Anode	13	FM, Alarm	Cathode
2	Dig 1	Cathode	14	FM	Anode
3	Seg d	Anode	15	Seg a	Anode
4	dp 1	Anode	16	dp 2	Cathode
5	Dig 2	Cathode	17	Upper/Lower Colon	Cathode
6	Lower Colon	Anode	18	Seg f	Anode
7	Upper Colon	Anode	19	Seg b	Anode
8	Dig 3	Cathode	20	Seg c	Anode
9	dp 2	Anode	21	dp 1	Cathode
10	Dig 4	Cathode	22	Seg g	Anode
11	Seg e	Anode	23	AM	Anode
12	Alarm	Anode	24	AM, PM	Cathode

Fig. 9 4-digit LED LN543RK (Display unit, D1)

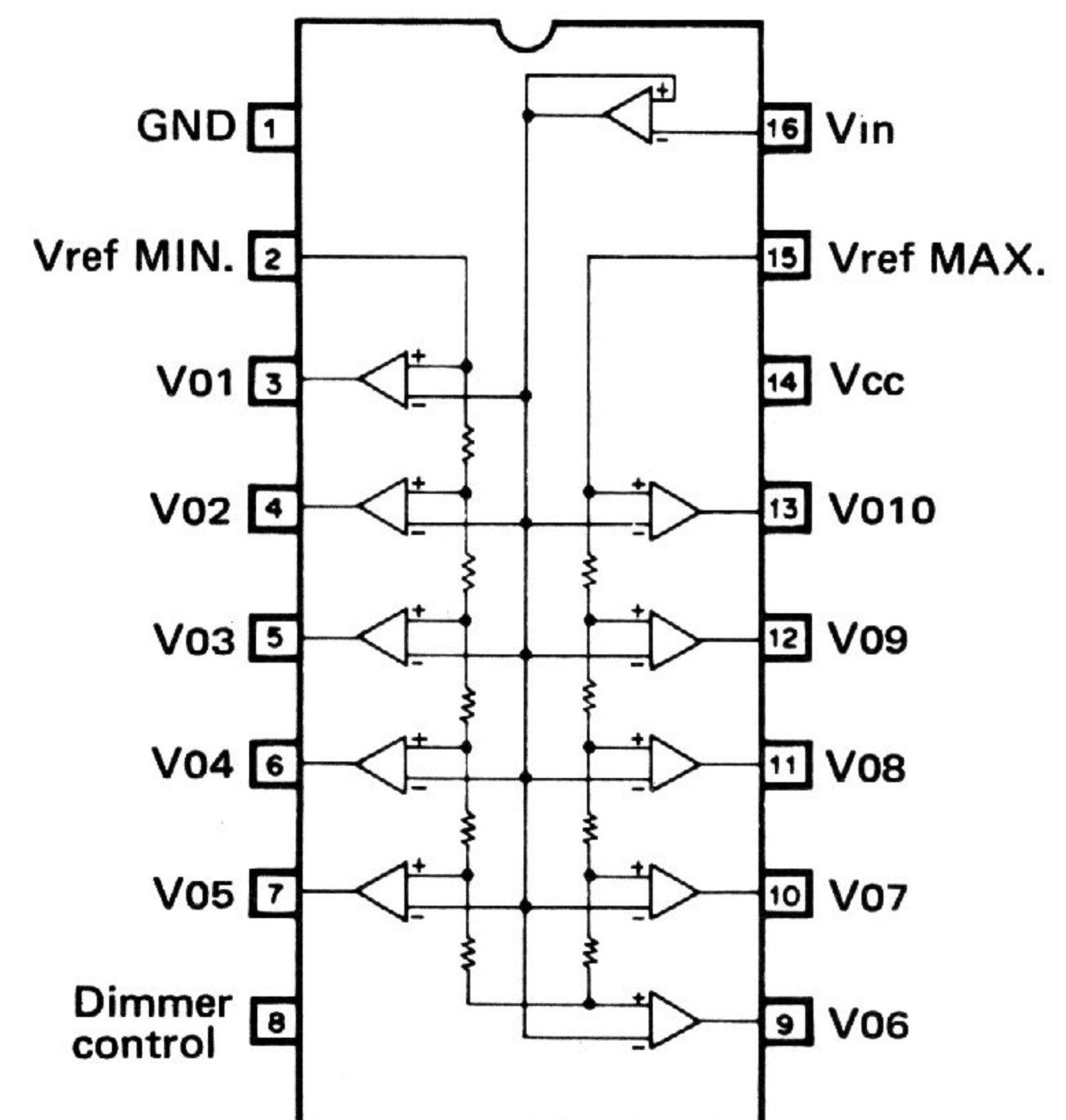
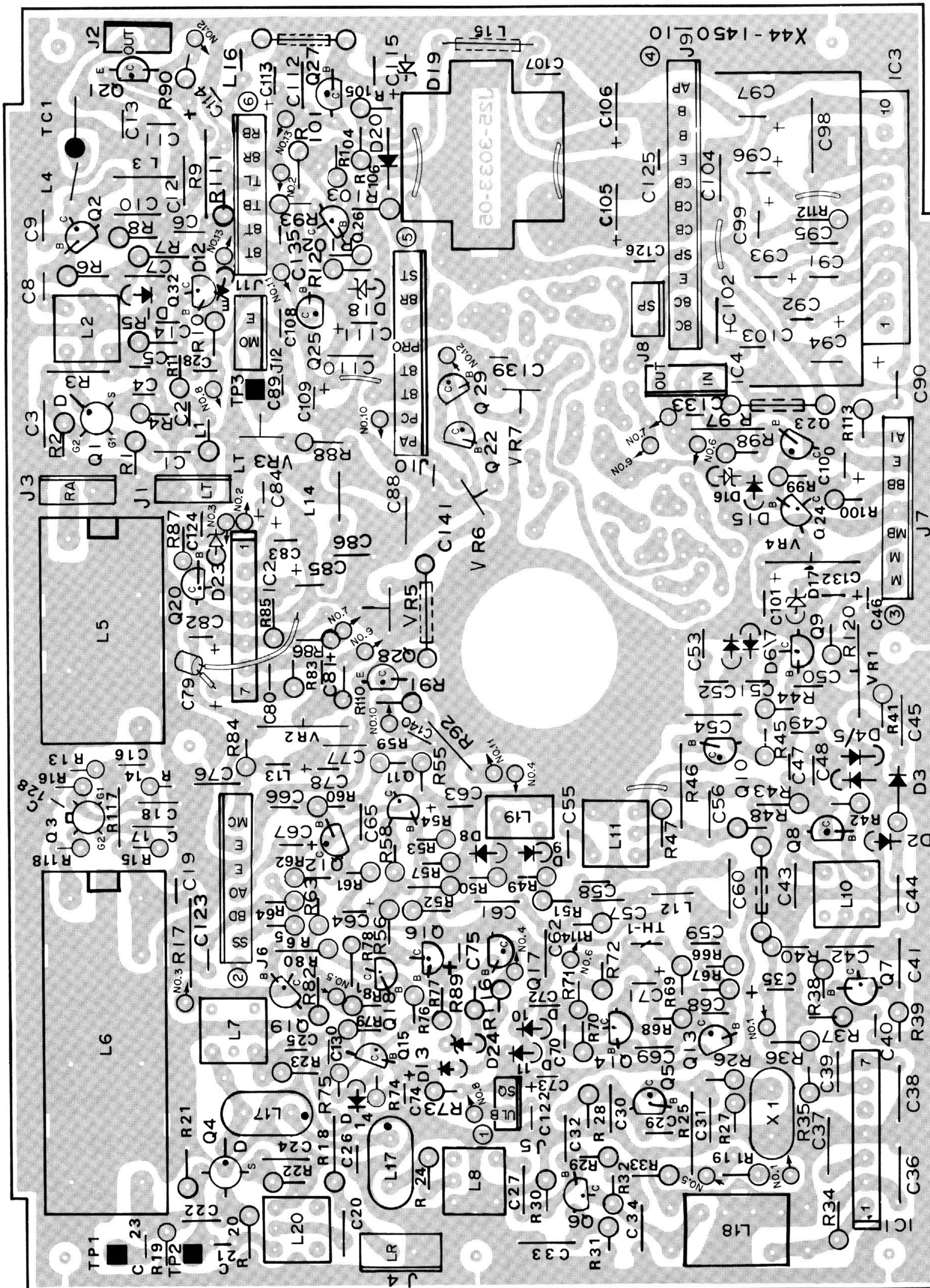


Fig. 10 TA7612AP (Display unit, IC1)

TR-7730 PC BOARD VIEW

▼RX.TX UNIT (X44-1450-10) (K, M TYPE) Components side view



2SA1015
2SC1815
2SC1923

2SC2538

2SC458
2SC460

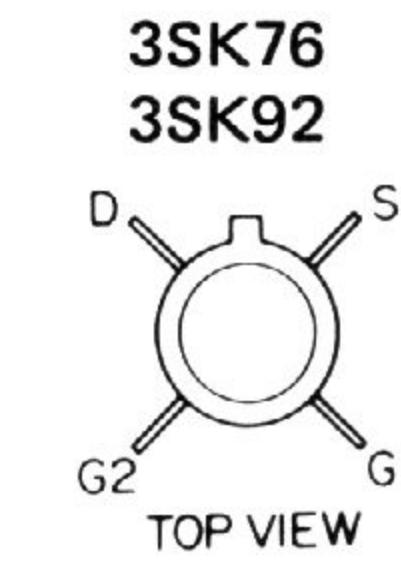
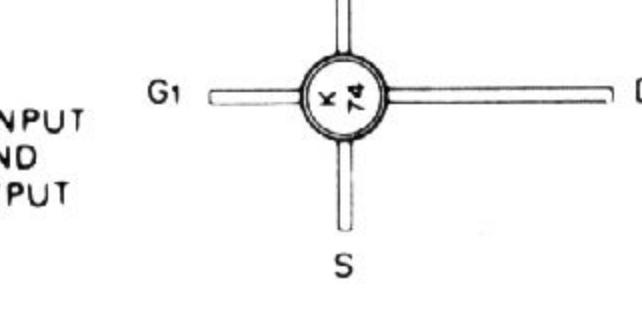
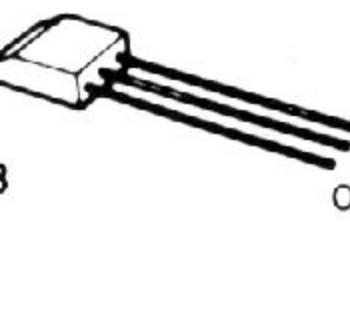
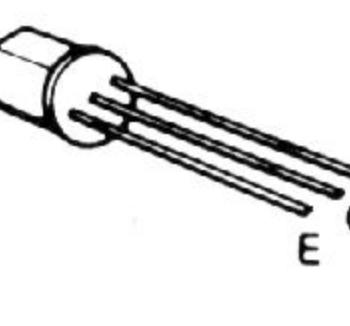
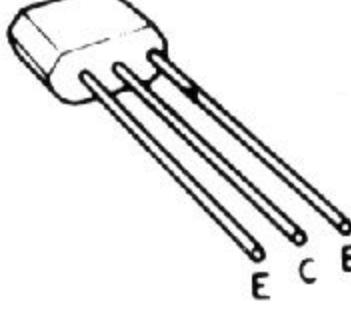
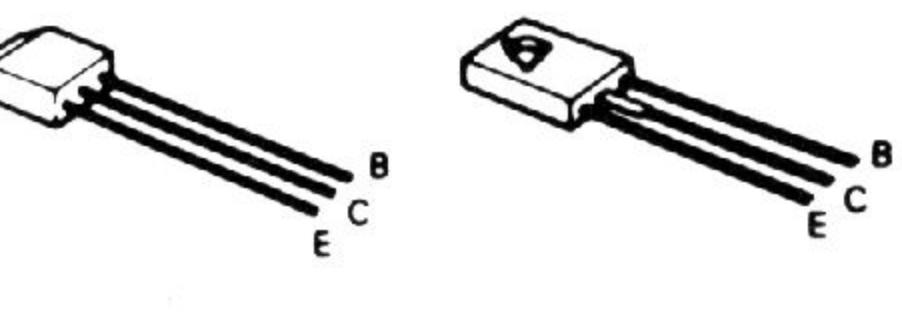
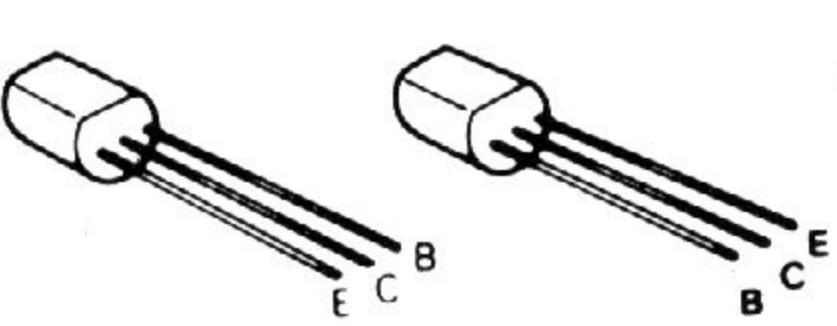
2SC496
2SC2603

2SA1115
2SC2603

2SA562-TM

μ PC78L08A

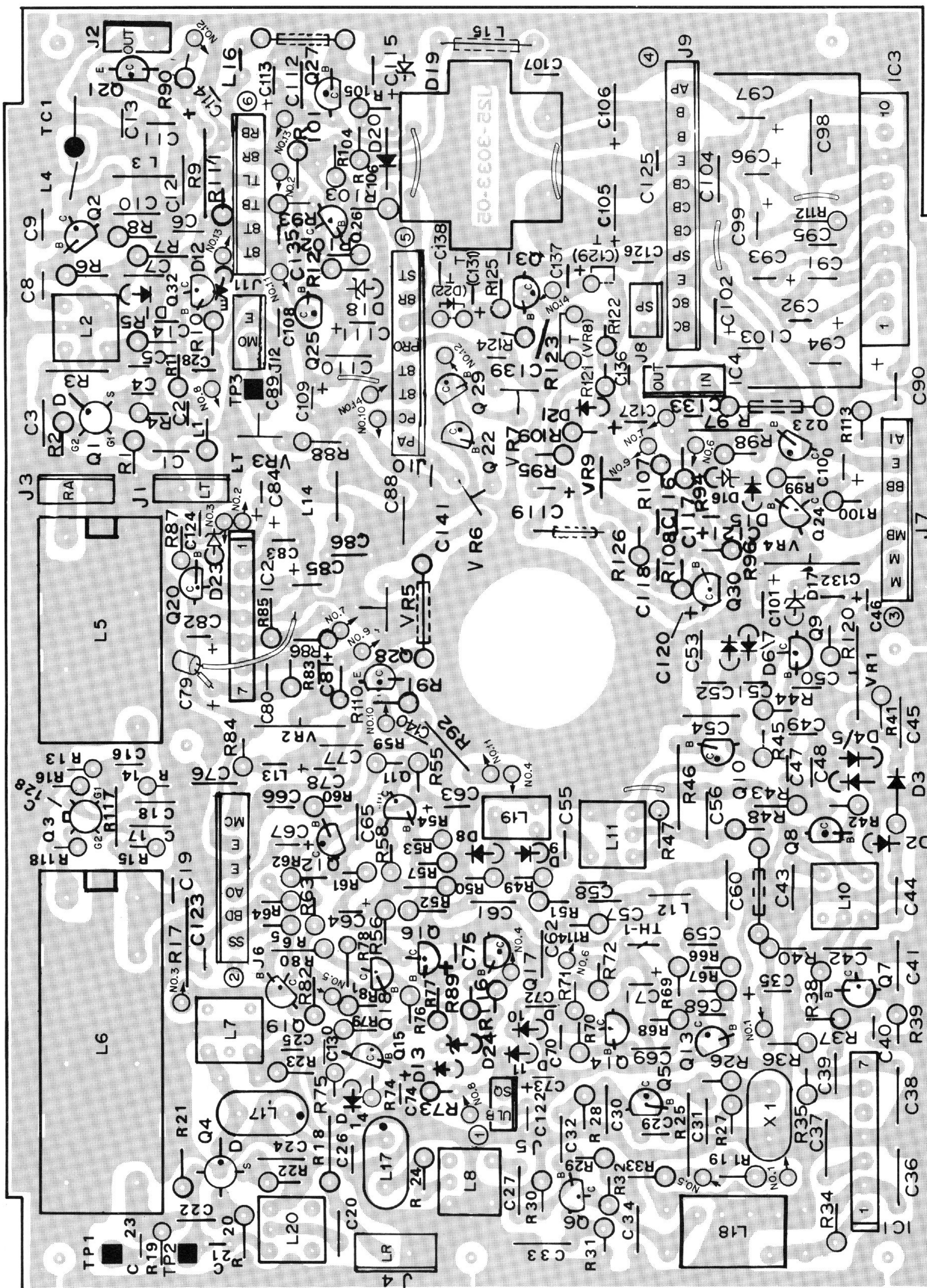
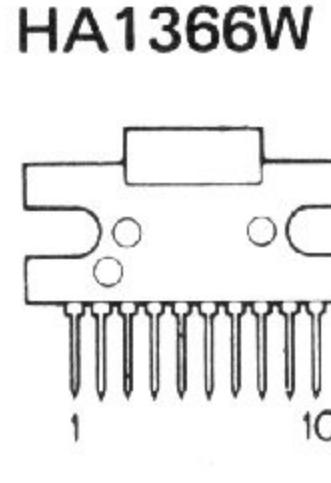
3SK74



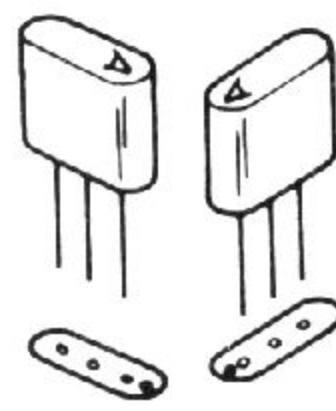
Q1,4 : 3SK74(L) Q2 : 2SC2538 Q3 : 3SK76 or 3SK92 Q5,7~10 : 2SC460(B) Q6 : 2SC1923(O) Q11~14 : 2SC1815(Y) Q15~18,20,23,24 : 2SC2603(E)
Q19 : 2SA1115(E) Q21,25,27 : 2SC496(Y) Q22,28,29 : 2SC458(B) Q26 : 2SA1015(Y) Q32 : 2SA562TM(Y)
IC1 : TA7302P IC2 : TA7061AP IC3 : HA1366W IC4 : μ PC78L08A

D1,4~7,12,13,15,20 : 1S1555 D2,3,8~11 : 1N60 D14 : 1S1212 D16 : XZ-060 D17 : XZ-070 D18 : XZ-100 D19 : XZ-090 D23,24 : WZ-040

▼RX.TX UNIT (X44-1450-51, -61) (T, W TYPE) Components side view

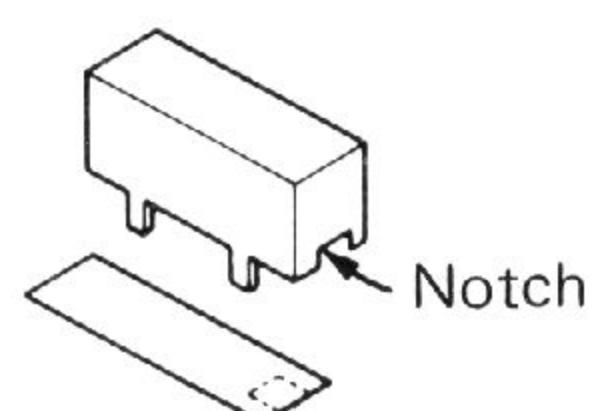
TA7061AP
TA7302P

< Attachment direction of L17 >



L17 should be used as a pair.

< Attachment direction of L5, 6 >



< Attachment direction of IC4 >



	T	W
D22	Used	Not used
VR8	Used	Not used
C129, 131	Used	Not used

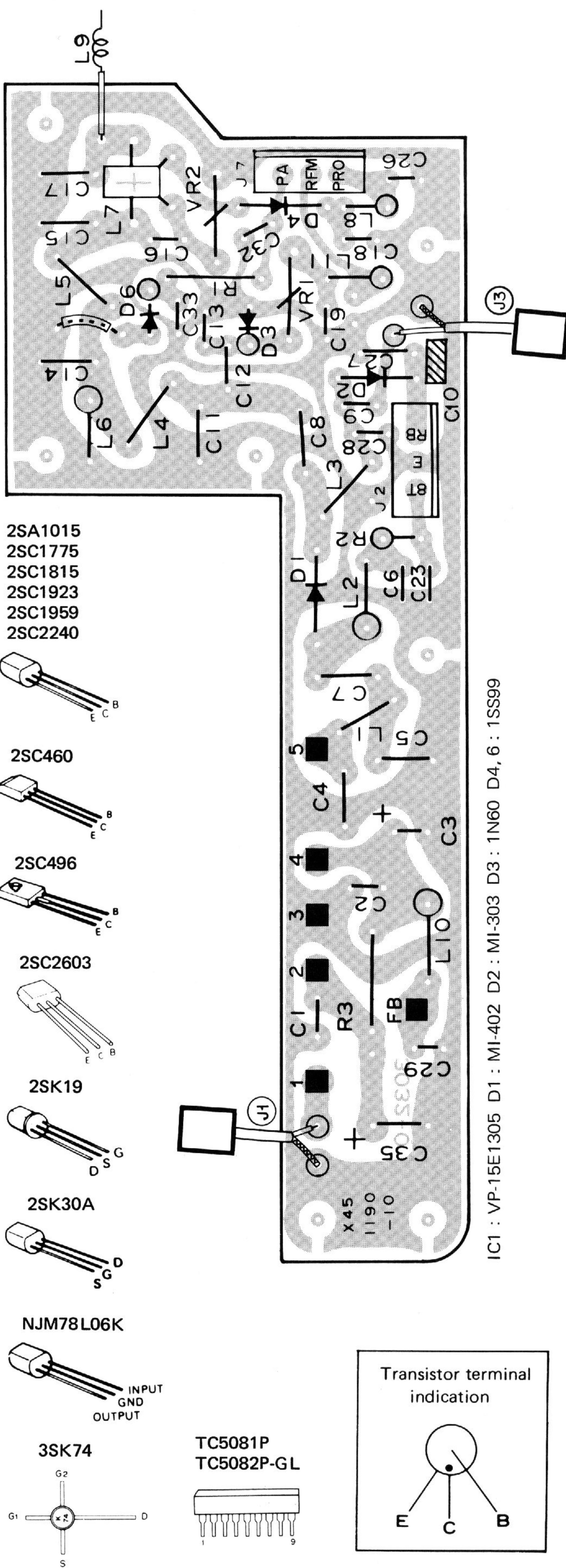
Q1, 4 : 3SK74(L) Q2 : 2SC2538 Q3 : 3SK76 or 3SK92 Q5, 7~10 : 2SC460(B) Q6 : 2SC1923(O) Q11~14 : 2SC1815(Y) Q15~18, 20, 23, 24 : 2SC2603(E)
 Q19 : 2SA1115(E) Q21, 25, 27 : 2SC496(Y) Q22, 28~31 : 2SC458(B) Q26 : 2SC1015(Y) Q32 : 2SA562TM(Y)

IC1 : TA7302P IC2 : TA7061AP IC3 : HA1366W IC4 : μPC78L08A

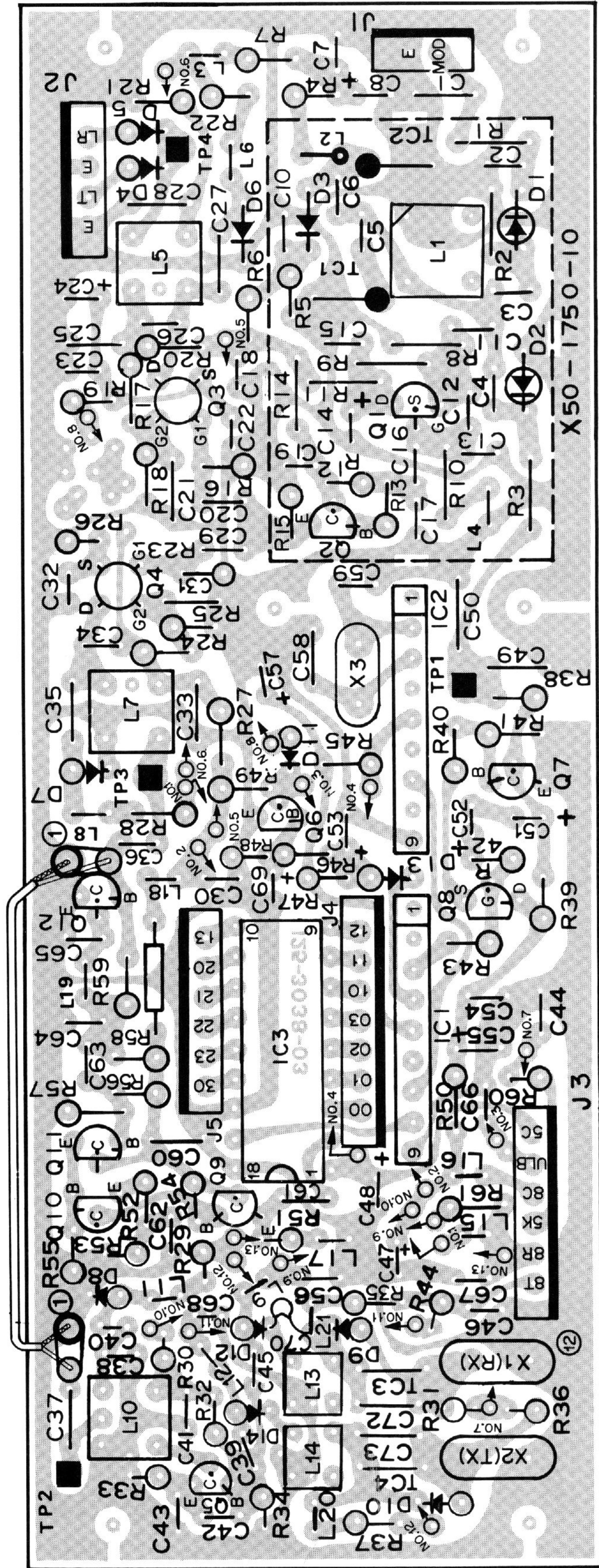
D1, 4~7, 12, 13, 15, 20~22 : 1S1555 D2, 3, 8~11 : 1N60 D14 : 1S1212 D16 : XZ-060 D17 : XZ-070 D18 : XZ-100 D19 : XZ-090 D23, 24 : WZ-040

TR-7730 PC BOARD VIEWS

▼FINAL UNIT (X45-1190-10) Components side view

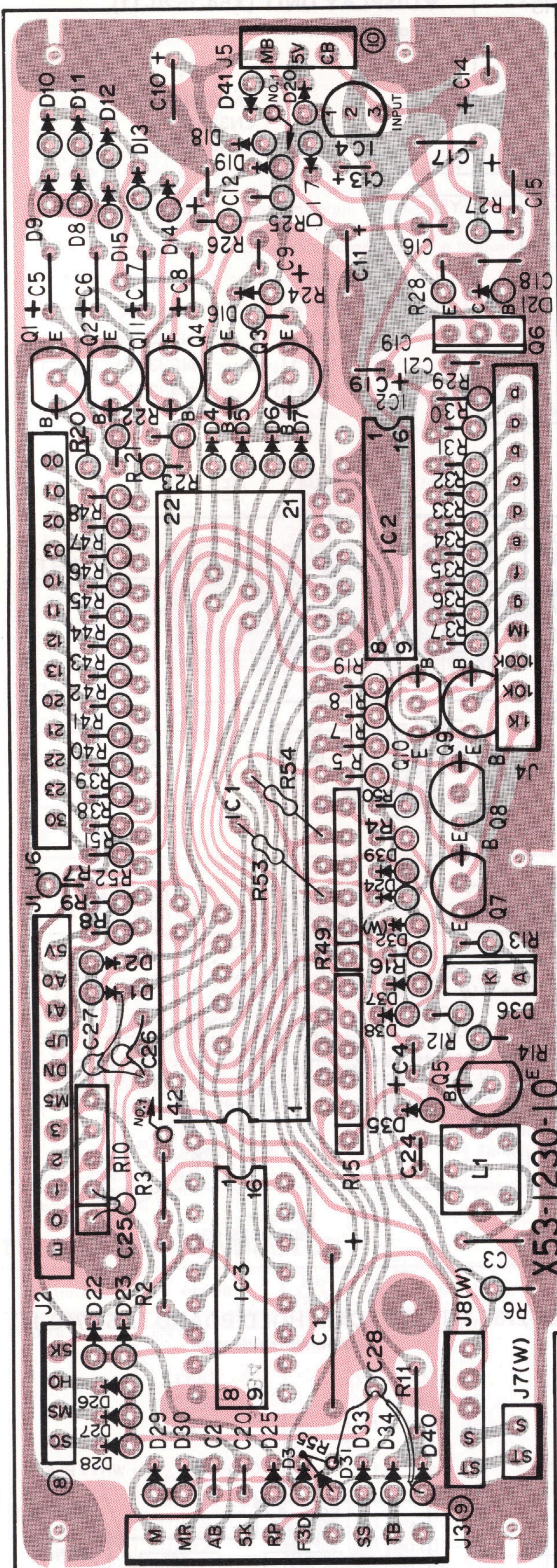


▼PLL UNIT (X50-1750-10) Components side view



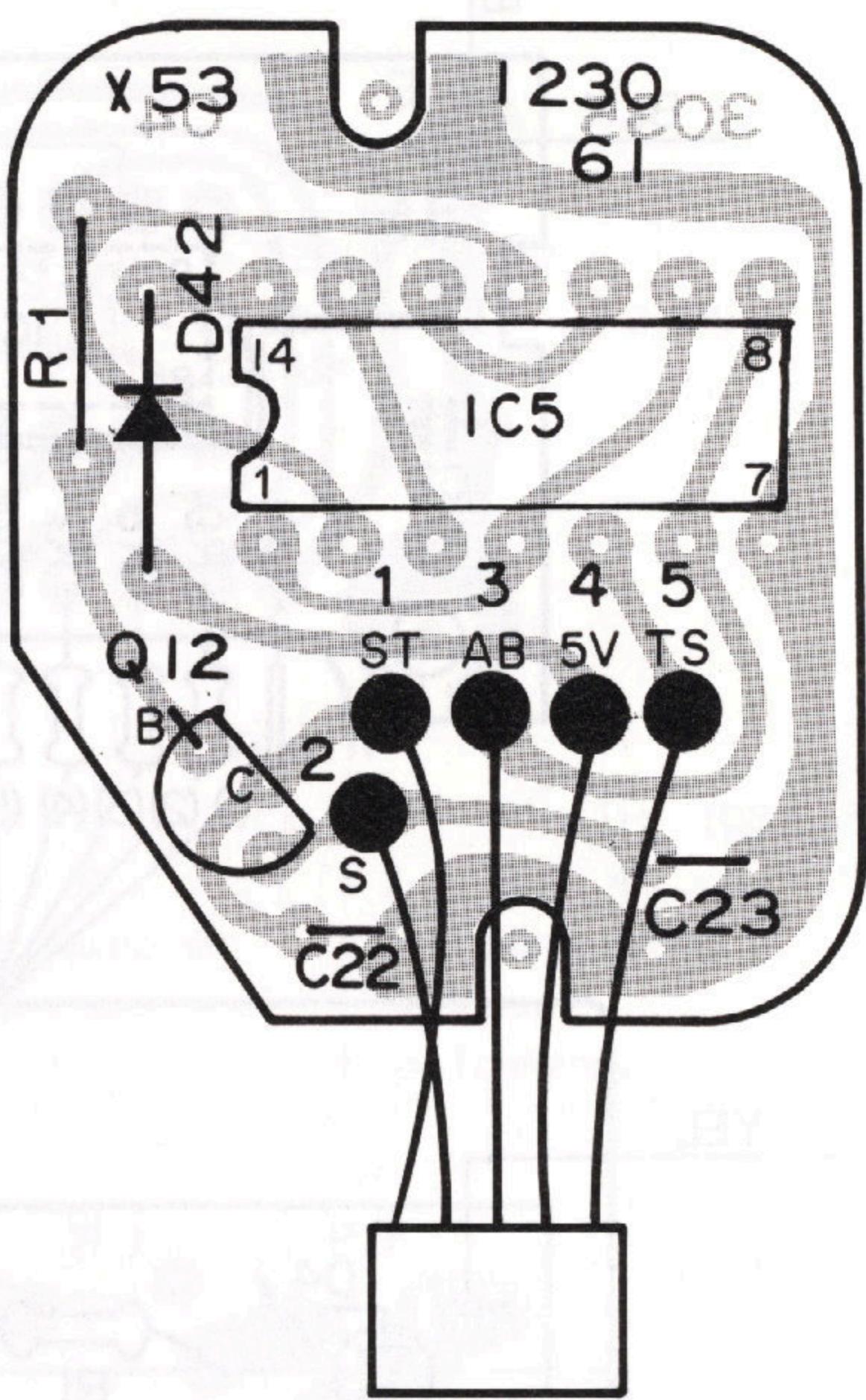
Q1 : 2SK19(GR) Q2, 12 : 2SC1923(O) Q3, 4 : 3SK74(L)
Q5, 9~11 : 2SC460(B) Q6 : 2SC1775(E) Q7 : 2SC2240(GR)
Q8 : 2SK30A(O) IC1 : TC5081P IC2 : TC5082P-GL IC3 : TC9122P
D1, 2 : 1S2208 D3 : 1S2588 D4, 5, 9, 10, 12, 14 : BA243S
D6~8 : 1S1555 D11, 13 : 1N60

▼ CONTROL UNIT (X53-1230-10, -61) -10 : K, M -61 : T, W
Components side view



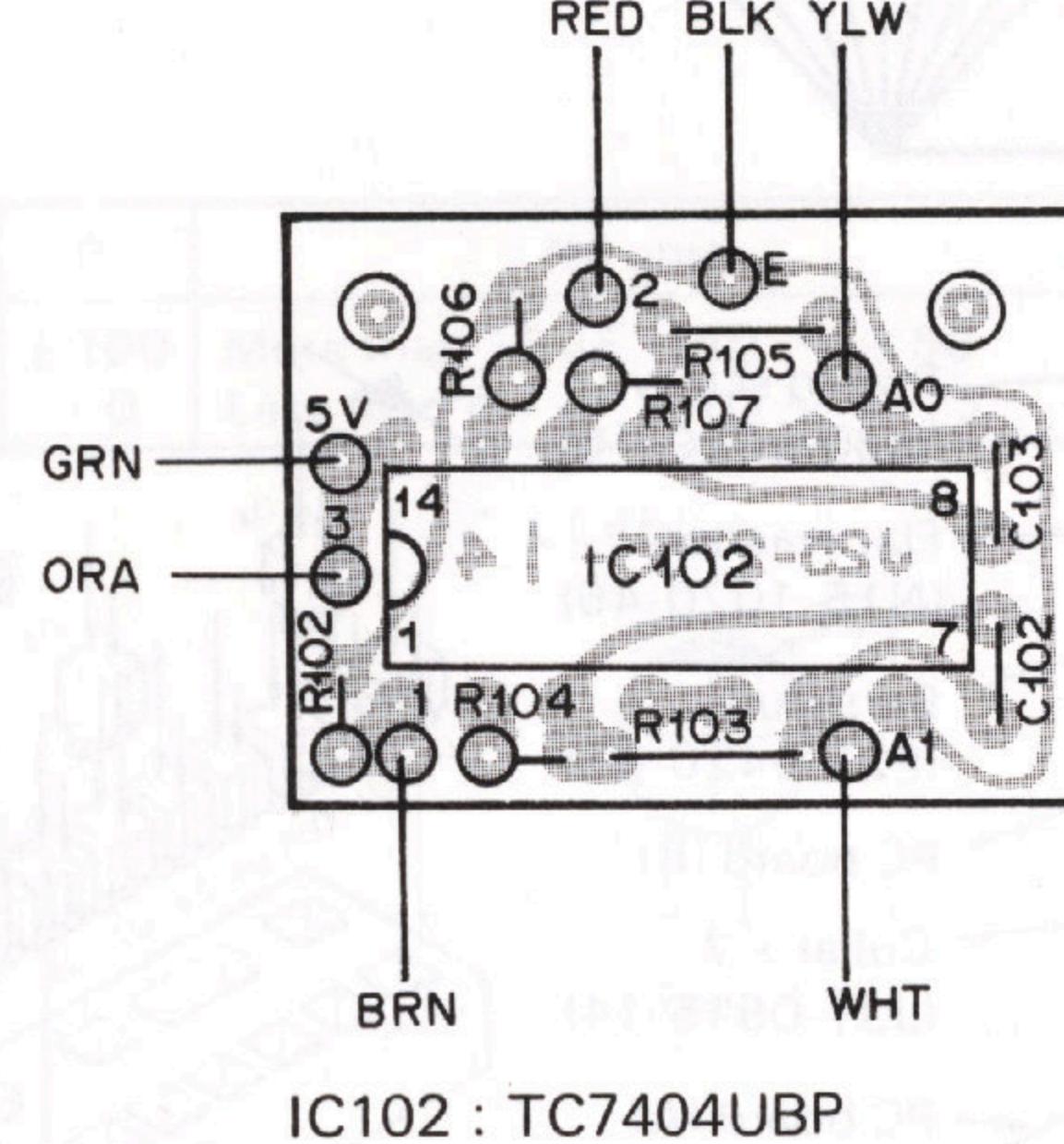
Q1~3, 5 : 2SC1815(Y) Q4, 11 : 2SA1015(Y) Q6 : 2SC496(Y)
Q7~10 : 2SC1959(Y) IC1 : μPD650C-078 IC2 : TC5022BP
IC3 : TC4042BP IC4 : NJM78L06K
D1~3, 8~15, 22~31, 33, 34 : 1N60
D4~7, 16~20, 35, 37~39, 41 : 1S1555 D21 : XZ-060
D32 : 1N60 (T, W only) D36 : MA522 (Q) D40 : XZ-090

▼ CONTROL UNIT (X53-1230-61)
T, W TYPE ONLY Components side view



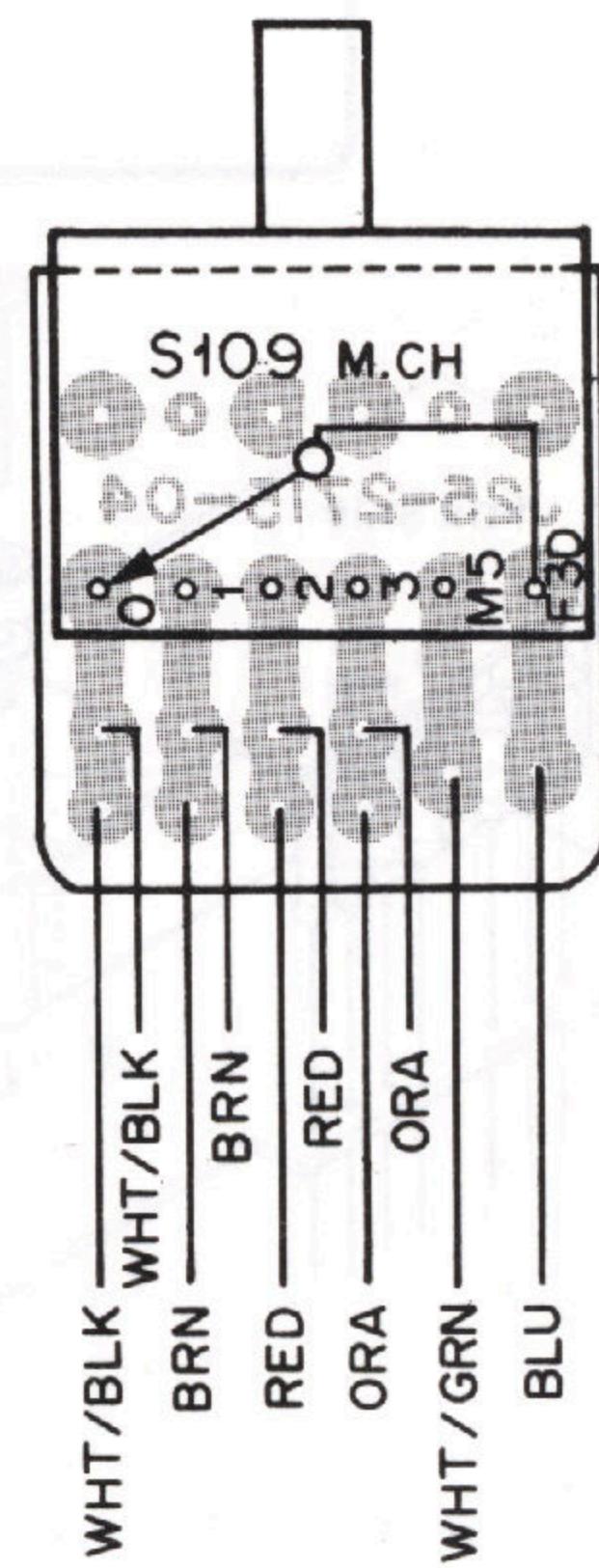
Q12 : 2SC2603(E) IC5 : TC4011BP
D42 : 1N60

▼ SCHMITT BOARD (J25-2755-14)
Components side view

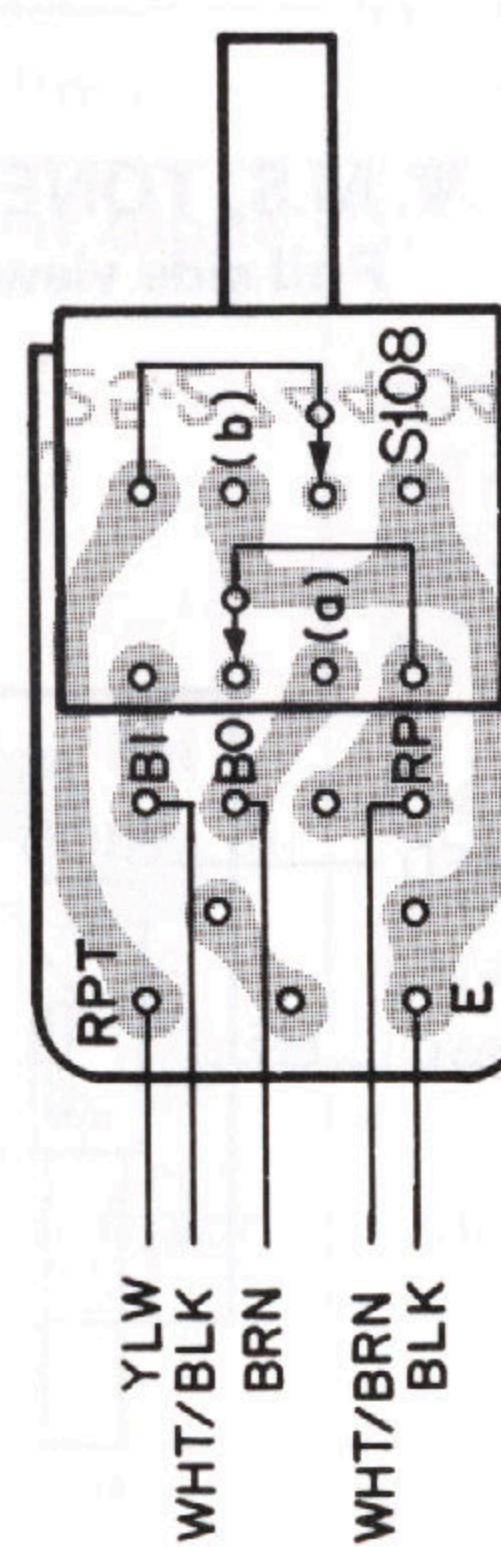


IC102 : TC7404UBP

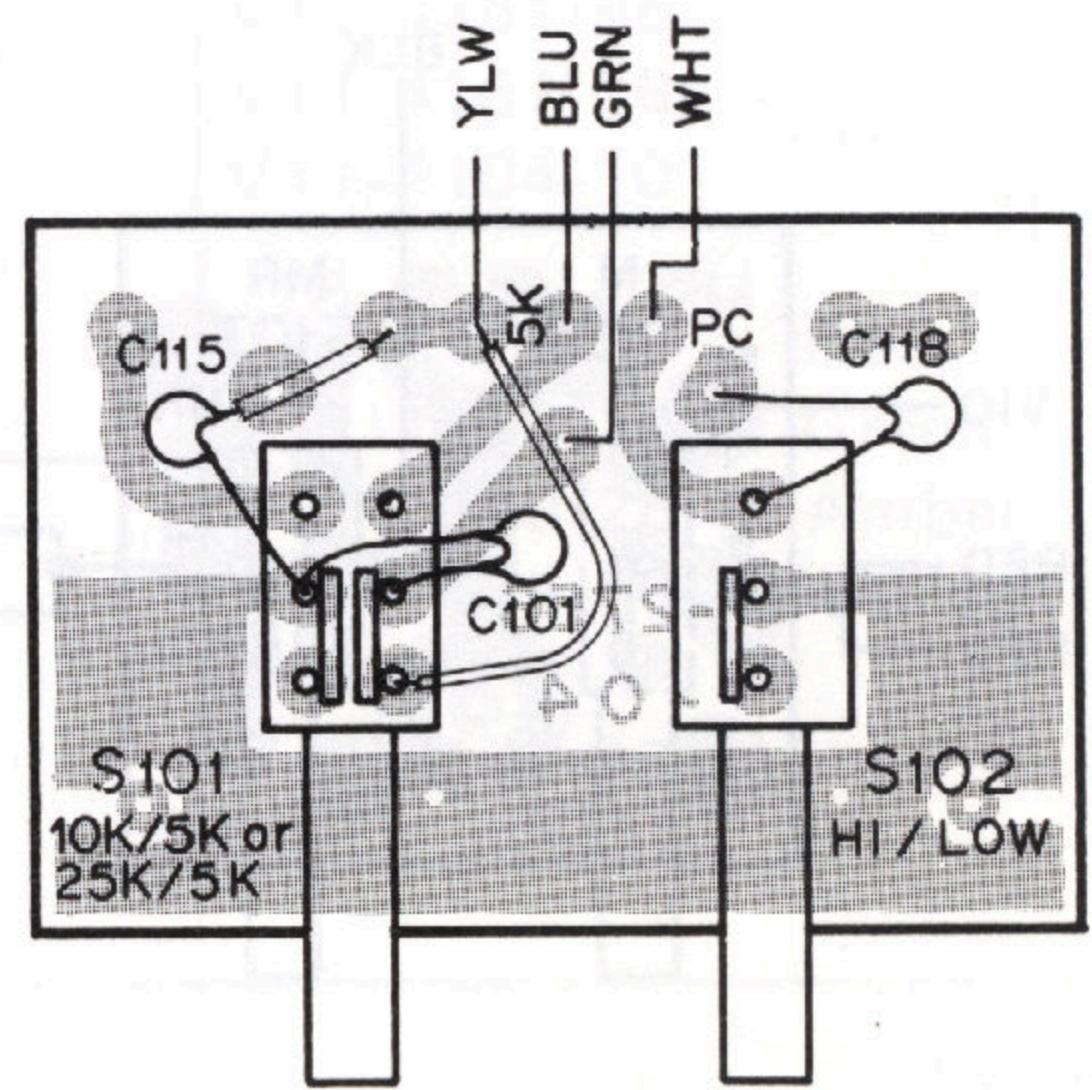
▼ M. CH BOARD (J25-2715-04)
Components side view



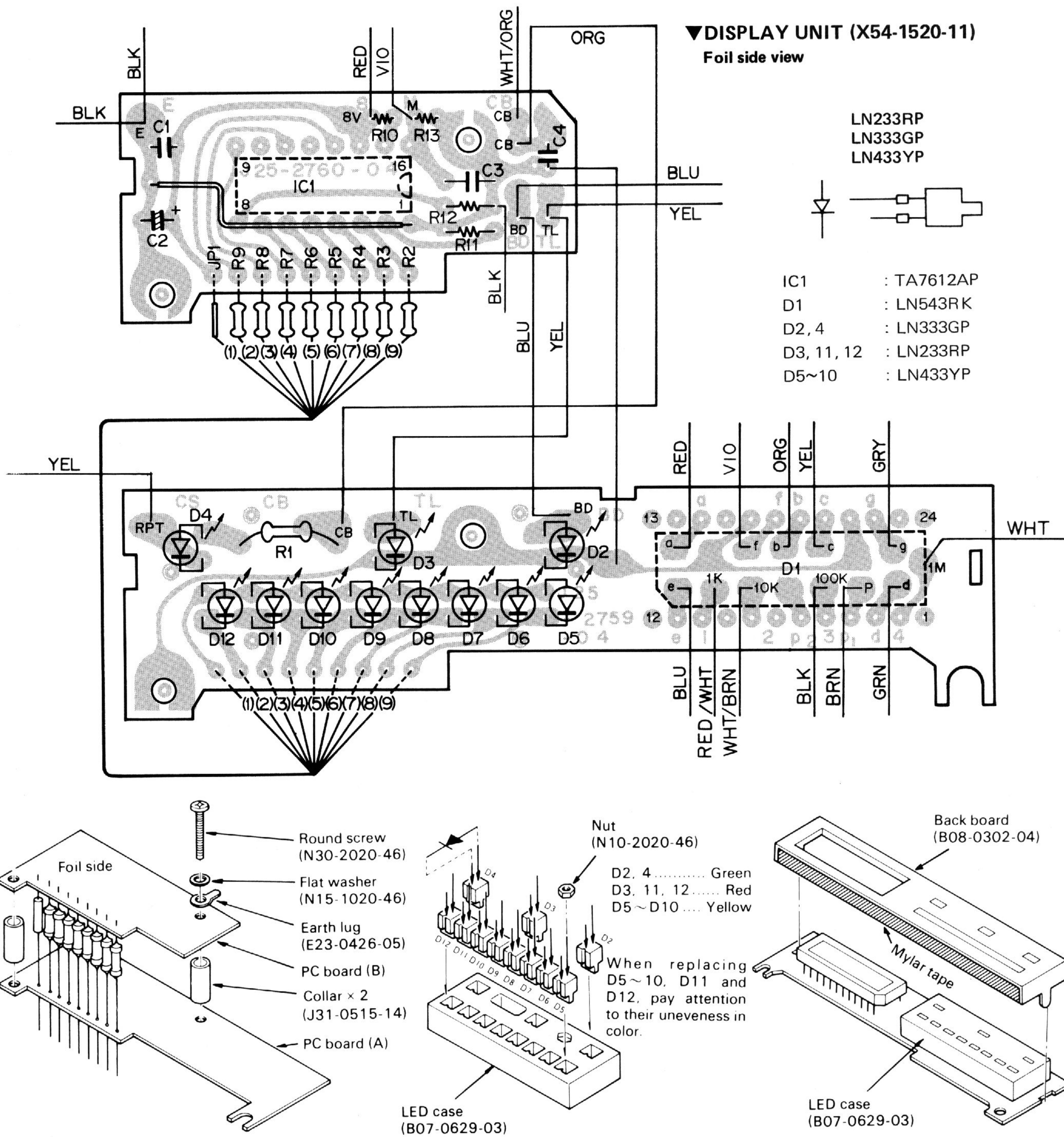
▼ RPT BOARD (J25-2744-04)
Components side view



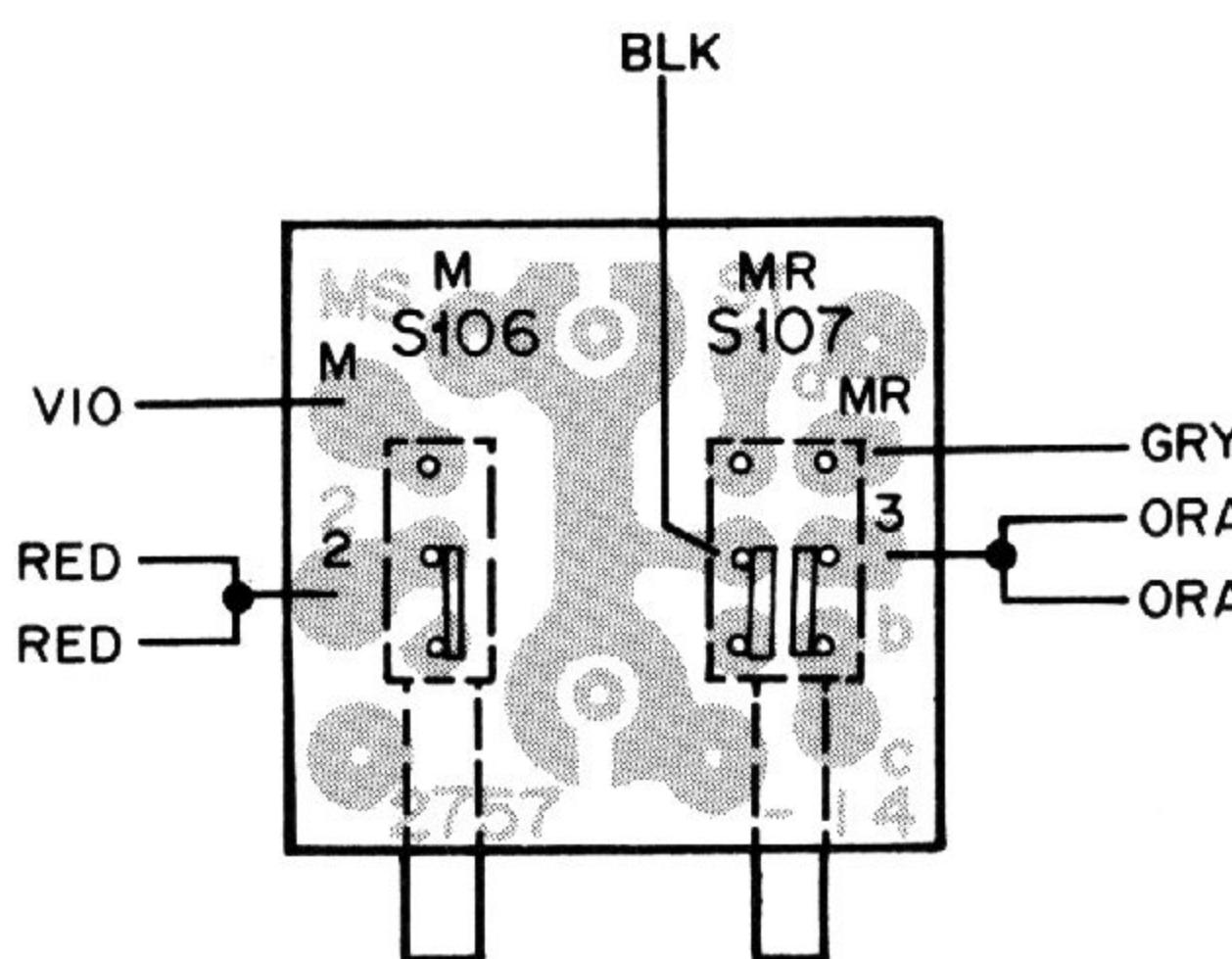
▼ 10k/5k or 25k/5k, HI/LOW BOARD
(J25-2756-04) Components side view



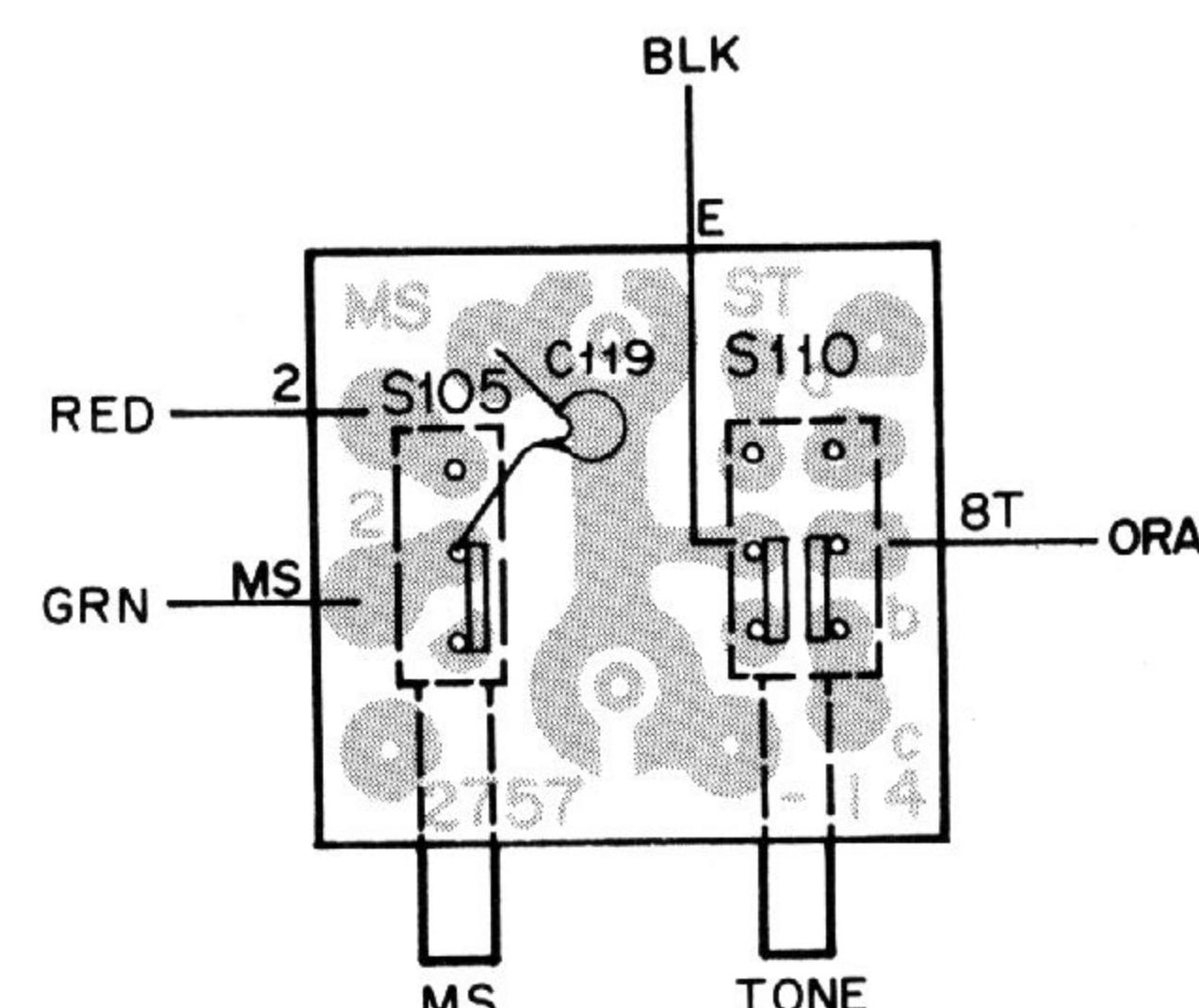
TR-7730 PC BOARD VIEWS



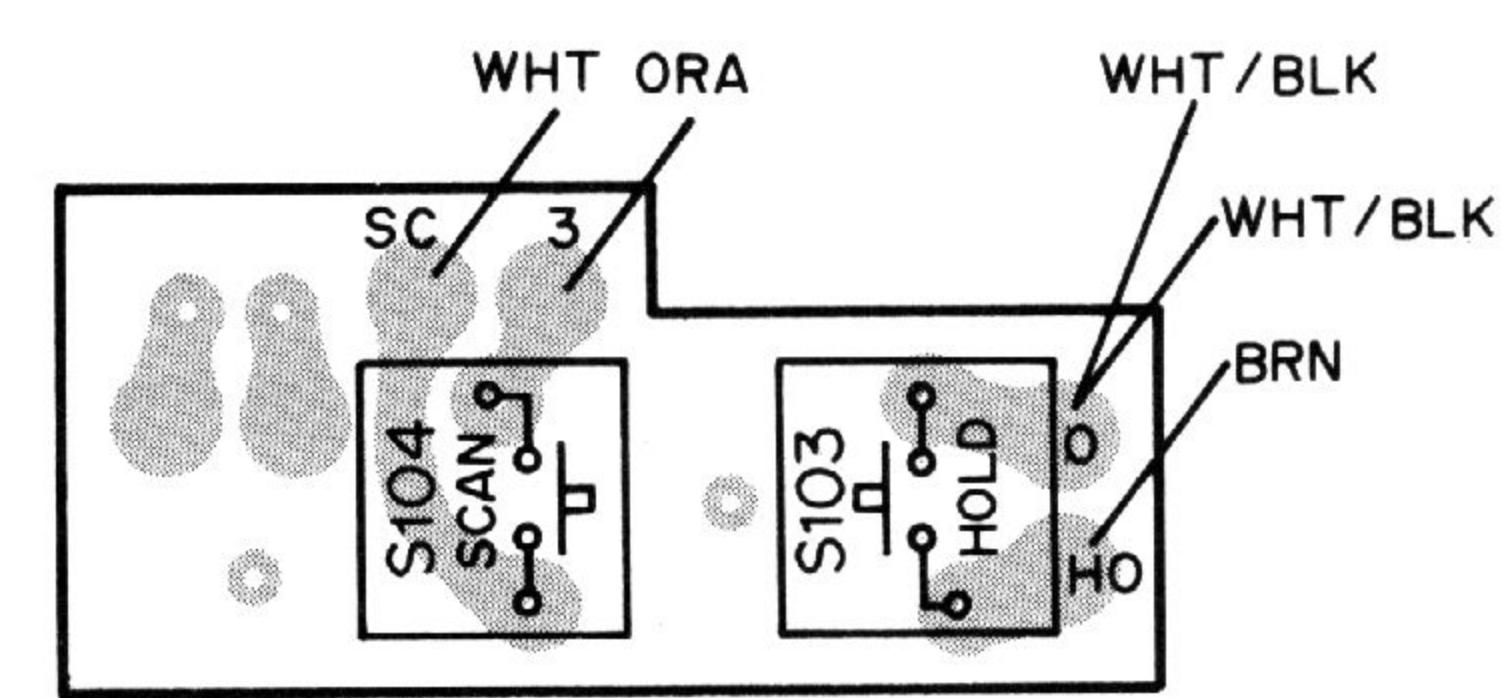
▼M, MR BOARD (J25-2757-14)
Foil side view



▼M.S, TONE BOARD (J25-2757-14)
Foil side view



▼SCAN, HOLD BOARD (J25-2758-14)
Components side view



PARTS LIST

Note 1:

K: U.S.A. T: Britain W: Europe X: Australia

Note 2:

Only special type of resistors (example: cement, metal film, etc.) and capacitors (example: electrolytic, tantalum, mylar, temp, coeff, capacitors) are detailed in the PARTS LIST. For the value of all common type components, refer to the schematic diagram of the P.C. board illustration. Resistors not otherwise detailed are carbon type (1/4W or 1/8W).

Order carbon resistors and capacitors according to the following example:

A carbon resistor's part number is RD14BY 2E222J.

A ceramic capacitor's number is CK45F1H103Z, CC45TH1H220J.

RESISTOR

1. Type of the carbon resistor



RD14BY

RD14BB (small size)



RD14CY

RD14CB (small size)

2. Wattage

1W → 3A	3W → 3F	5W → 3H
2W → 3D	4W → 3G	

3' = CC45 ○ ○ ...

Ceramic capacitor (type I) temperature coeff. capacitor 1' 3'

1st word (Color)	C (Black)	L (Red)	P (Orange)	R (Yellow)	S (Green)	T (Blue)	U (Violet)
ppm/°C	0	-80	-150	-220	-330	-470	-750

3 = CK45 ○

Ceramic capacitor (type II) 3

Cord	B	D	E	F
Operating temperature °C	-30 +85	-30 +85	-30 +85	-10 +70

6 = Tolerance

Cord	C	D	G	J	K	M	X	Z	P	No cord
(%)	±0.25	±0.5	±2	±5	±10	±20	+40 -20	+80 -20	+100 -0	More than 10 μF -10 ~ +50 Less than 4.7 μF -10 ~ +75

Less than 10 pF

Cord	B	C	D	F	G
(pF)	±0.1	±0.25	±0.5	±1	±2

Abbreviation	Abbreviation	Abbreviation	Abbreviation
Cap. C E MC	Capacitor Ceramic Electrolytic Mica	ML S T	Mylar Styren Tantalum

3. Resistance value

② ② ② → means $22 \times 10^2 = 2200\Omega$ (2.2 kΩ)

Example: 221 → 220Ω 223 → 22 kΩ 225 → 2.2 MΩ
222 → 2.2 kΩ 224 → 220 kΩ

4. Tolerance

J = ±5% (Gold) K = ±10% (Silver)

CAPACITORS

Type I

Type II

CC	45	TH	1H	220	J	CK	45	F	1H	103	Z
1'	2	3'	4	5	6	1	2	3	4	5	6

1 = Type ceramic, electrolytic, etc 4 = Voltage rating

2 = Shape round, square, etc 5 = Value

3 = Temp range 6 = Tolerance

3' = Temp coefficient

Ex. CC45TH = -470 ±60 ppm/°C

2nd Word	G	H	J	K	L
ppm/°C	±30	±60	±120	±250	±500

5 = Capacitor value

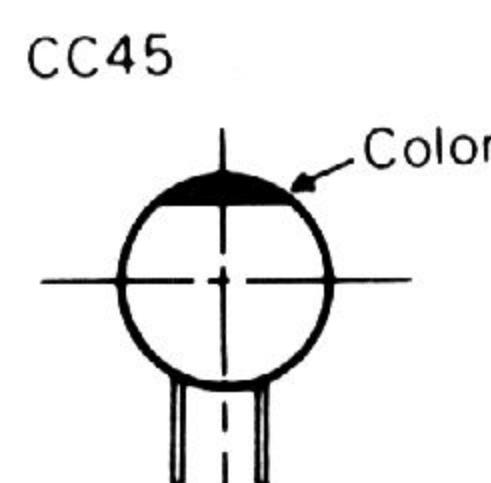
Example: 010 → 1 pF

100 → 10 pF

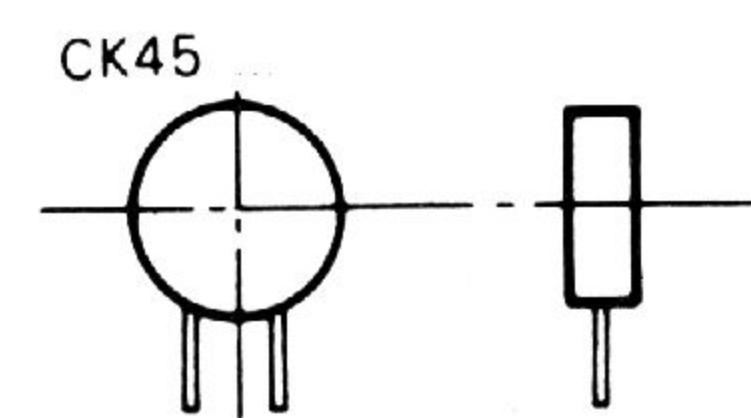
101 → 100 pF

102 → 1000 pF = 0.001 μF

103 → 0.01 μF



Type I



Type II

TR-7730 SEMICONDUCTOR

☆: New parts

Item	Name	Re-marks	Parts No.
Diode	1N60		V11-0051-05
	1S1555		V11-0076-05
	1S2588		V11-0414-05
	1SS99		V11-1277-86
	BA243S		V11-7767-06
	MA522 (Q)		V11-1173-46
	MI303		V11-5273-66
	MI402		V11-5260-16
	U05B		V11-0270-05
Vari-Cap	1S2208		V11-0317-05
Varistor	1S1212		V11-1262-06

Item	Name	Re-marks	Parts No.
Zener diode	WZ-040		V11-4102-50
	XZ-060		V11-4101-20
	XZ-070		V11-4161-96
	XZ-090		V11-4167-06
	XZ-100		V11-4104-10
LED	LN233RP		V11-1173-06
	LN333GP		V11-1173-16
	LN433YP		V11-1173-26
	LN543RK		V11-1173-36
Thermistor	D33A		V11-3161-86

PARTS LIST

Item	Name	Re-marks	Parts No.	Ref. No.	Parts No.	Re-marks	Description
TR	2SA562TM (Y)		V01-0562-16		B07-0636-04	☆	Side escutcheon x 2
	2SA1015 (Y)		V01-1015-06		B10-0629-04		Front glass
	2SA1115 (E)		V01-1115-16		B40-2571-04	☆	Model name plate K, M
	2SC458 (B)		V03-0093-05		B40-2572-04	☆	Model name plate T
	2SC460 (B)		V03-0079-05		B40-2573-04	☆	Model name plate W
	2SC496 (Y)		V03-0336-05		B46-0058-10		Warranty card K
	2SC1775 (E)		V03-1775-06		B50-3911-00	☆	Operating manual K, M
	2SC1815 (Y)		V03-1815-06		B50-3912-00	☆	Operating manual T
	2SC1923 (O)		V03-1923-06		B50-3913-00	☆	Operating manual W
	2SC1959 (Y)		V03-1959-06		C101	CC45SL1H470J	C 47pF
	2SC2240 (GR)		V03-2240-06		C102, 103	C91-0430-05	Laminated cap. 0.047μF
	2SC2538		V03-2538-06		C104~113	C91-0469-05	Cap. 0.001μF
	2SC2603 (E)		V03-2603-06		C115, 118, 119	CC45SL1H470J	C 47pF
	2SK19 (GR) TRIO-5		V09-1001-16				
FET	2SK30A (O)		V09-0056-05				
	3SK74 (L)		V09-1002-56		E06-0651-05		6P male socket MIC
	3SK76		V09-1012-06		E07-0651-05		6P metal plug MIC
	3SK92		V09-1006-16		E12-0001-05		Phone plug (accessory)
Power module	VP-15E1305	☆	V30-1240-26		E30-1689-05	☆	DC cord (C) (accessory)
	HA1366W		V30-1045-06		E31-2074-15		Connector with lead (B)
IC	NJM78L06K		V30-1067-06		F05-6021-05		Fuse 6A (accessory)
	TA7061AP		V30-0039-05		G02-0518-04		Gnd spring (C) x 2 Helical
	TA7302P		V30-1134-06		G10-0607-04		Cushion cloth x 4 120 x 4 mm
	TA7612AP		V30-1169-06		G10-0611-04		Cushion cloth (B) 30 x 13 mm
	TC4011BP		V30-0301-70		G10-0612-04		Cushion cloth (C) 150 x 45 mm
	TC4042BP		V30-1052-06		G10-0613-14		Cushion cloth (D) 140 x 24 mm
	TC5022BP		V30-1054-06		G10-0615-04	☆	Cushion cloth (E) x 2 73 x 15 mm Case
	TC5081P		V30-1132-06		G13-0638-04		Cushion (A) x 2 53 x 24 x 5 mm
	TC5082P-GL		V30-1147-06		G16-0503-03		Conductive rubber sheet
	TC7404UBP		V30-1028-06		H01-2760-03	☆	Carton case (inside) K, M, W
	TC9122P		V30-1036-16		H01-2761-03	☆	Carton case (inside) T
	μPC78L08A		V30-1030-26		H10-2536-04		Packing fixture (B)
	μPC78M08H		V30-1222-16		H10-2551-02		Packing fixture (A)
	μPD650C-078		V30-1219-16		H12-0474-04		Cushion
					H20-1417-03		Protective cover
					H25-0029-04		Protective bag Boss
					H25-0049-03		Accessory bag
					H25-0079-04		Protective bag MIC
					H25-0103-04		Protective bag Cord
					J02-0022-05		Foot x 2 (accessory) Rear
					J02-0420-04		Foot (accessory) Front
					J21-2676-04		Foot mounting hardware x 2 (accessory)

Ref. No.	Parts No.	Re-marks	Description	
TR-7730 GENERAL				
	A01-0905-03	☆	Case (upper)	
	A01-0906-03	☆	Case (lower)	
	A13-0618-22		Angle ass'y (accessory)	
	A20-2433-04	☆	Panel	
	B01-0639-03	☆	Panel escutcheon	K, M
	B01-0640-03	☆	Panel escutcheon	T
	B01-0641-03	☆	Panel escutcheon	W
	B03-0517-04		Switch mask x 2	M, MR
	B03-0518-04		Switch mask x 4	5k/10k, H/L, TONE, MS
	B05-0714-04		SP grill cloth	

	J25-2715-04		PC board	M, CH
	J25-2744-04		PC board (E)	RPT
	J25-2755-14		PC board (A)	Schmitt
	J25-2756-04		PC board (B)	10k/5k, H/L
	J25-2757-14		PC board (C)	M/MR, M.S/TONE
	J25-2758-14		PC board (D)	SCAN, HOLD
	J32-0748-04		Boss x 4 (accessory)	
	K21-0752-03		Main knob	
	K23-0736-04		Knob (A) x 2	VOL, SQU
	K23-0737-04		Knob (B)	M, CH
	K23-0743-04		Knob (C)	RPT
	K27-0416-05		Push knob (A)	M
	K27-0417-05		Push knob (B)	MR
	K27-0418-05		Push knob (C) x 3	10k/5k, H/L, TONE

PARTS LIST

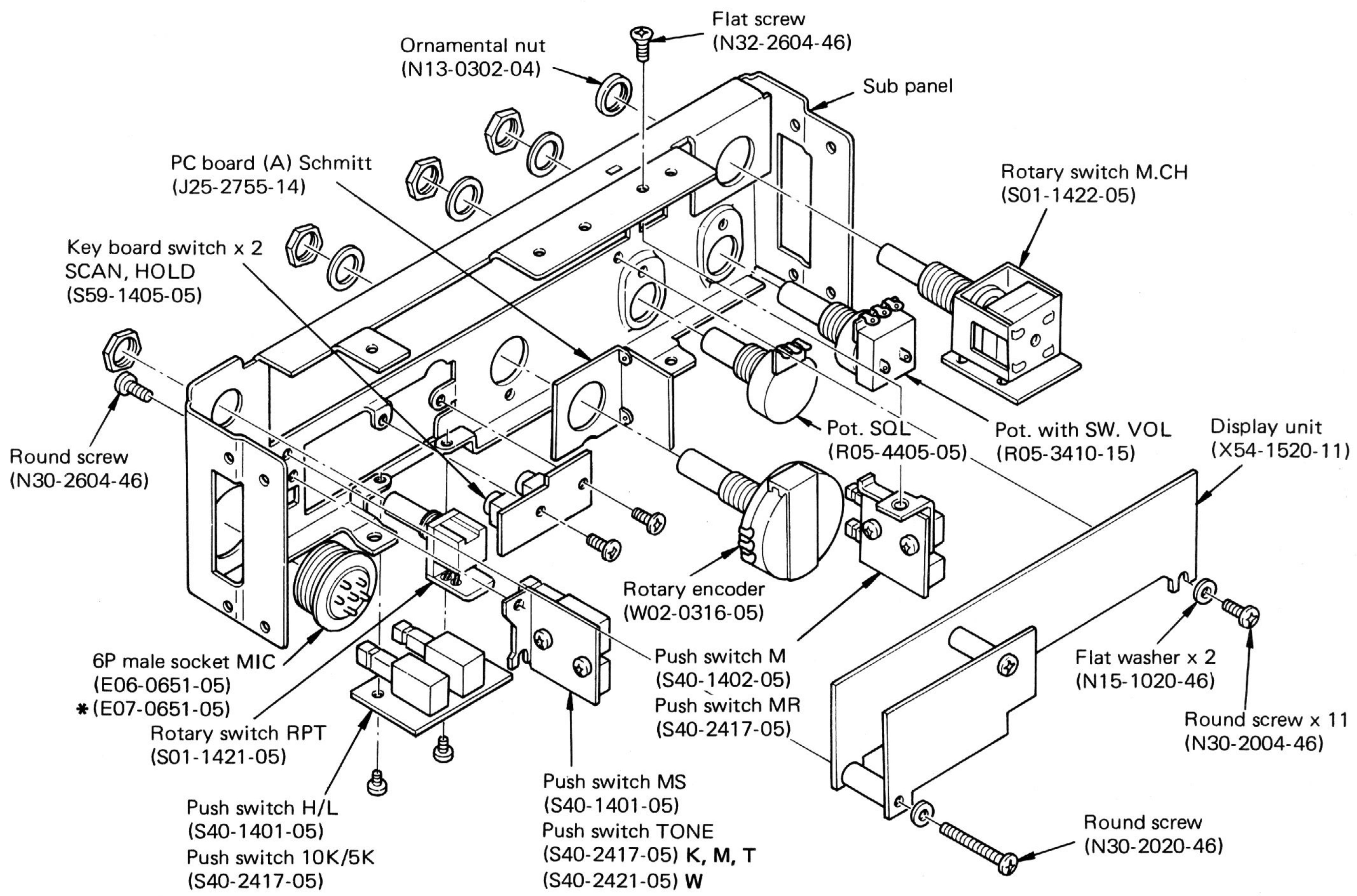
Ref. No.	Parts No.	Re-marks	Description	Ref. No.	Parts No.	Re-marks	Description	
	K27-0419-05 K27-0420-04		Push knob (D) MS Push knob (E) x 2 SCAN, HOLD	C25 C26 C30 C32 C33 C34 C35 C36, 37 C38 C39 C41~43 C47 C50, 53 C54 C55 C56 C57 C58 C59 C60 C61, 62 C63 C64 C65 C66 C67 C68 C69 C70 C71 C72 C73, 74 C75 C78 C79 C81 C82 C83 C84 C85 C86 C88 C89 C90 C91 C92 C93 C94 C95 C96 C97 C98 C99		C91-0131-05 CC45CH1H050C CC45SL1H151J CC45CH1H150J CQ92M1H393K CQ92M1H223K CE04W1A101M CQ92M1H473K CQ92M1H393K CQ92M1H103K CQ92M1H223K CC45SL1H470J CQ92M1H222K CQ92M1H473K CQ92M1H102K CQ92M1H223K CQ92M1H222K CQ92M1H332K CQ92M1H222K CQ92M1H393K CQ92M1H223K CE04W1A470M CS15E1A220M CQ92M1H103K CQ92M1H392K CS15E1V0R1M CC45CH1H220J CQ92M1H103K CC45CH1H220J CS15E1A100M CQ92M1H332K CS15E1C3R3M CS15E1C4R7M CS15E1V0R1M CE04W1A330M CS15E1V0R1M CE04W1A220M CS15E1C4R7M CS15E1V0R1M CE04W1A330M CE04W1H010M CQ92M1H103K CQ92M1H473K C91-0131-05 CE04W1H010M CQ92M1H332K CE04W1A101M CE04W1A470M CQ92M1H102K CC45SL1H101J CE04W1A470M CE04W1A101M CQ92M1H104K CE04W1H010M		C 0.01μF C 5pF ±0.25pF C 150pF C 15pF ML 0.039μF 50V ML 0.022μF 50V E 100μF 10V ML 0.047μF 50V ML 0.039μF 50V ML 0.01μF 50V ML 0.022μF 50V C 47pF ML 0.0022μF 50V ML 0.047μF 50V ML 0.001μF 50V ML 0.022μF 50V ML 0.0022μF 50V ML 0.0033μF 50V ML 0.0022μF 50V ML 0.039μF 50V ML 0.022μF 50V E 47μF 10V T 22μF 10V ML 0.01μF 50V ML 0.0039μF 50V T 0.1μF 35V C 22pF ML 0.01μF 50V C 22pF T 10μF 10V ML 0.0033μF 50V T 3.3μF 16V T 4.7μF 16V T 0.1μF 35V E 33μF 10V T 0.1μF 35V E 22μF 10V T 4.7μF 16V E 33μF 10V E 1μF 50V ML 0.01μF 50V ML 0.047μF 50V C 0.01μF E 1μF 50V ML 0.0033μF 50V E 100μF 10V E 47μF 10V ML 0.001μF 50V C 100pF E 47μF 10V E 100μF 10V ML 0.1μF 50V E 1μF 50V E 47μF 10V E 470μF 16V C 0.01μF E 10μF 16V E 47μF 10V E 10μF 16V ML 0.0039μF 50V W, T E 1μF 50V W, T T 22μF 10V W, T C 100pF E 1μF 50V W, T
VR101 VR102	R05-3410-15 R05-4405-05		Pot. 10kΩ (A) with SW VOL Pot. 50kΩ (B) SQU	C100, 101, 103 C105, 106 C107 C109 C111 C113, 115 C116~118 C119 C120, 121 C126 C127	CE04W1A470M C90-0820-05 C91-0131-05 CE04W1C100M CE04W1A470M CE04W1A101M CQ92M1H392K CE04W1H010M CS15E1A220M CC45SL1H101J CE04W1H010M			
	X44-1450-10 X44-1450-51 X44-1450-61 X45-1190-10 X50-1750-10 X53-1230-10 X53-1230-61 X54-1520-11	★	RX.TX unit K, M RX.TX unit T RX.TX unit W Final unit PLL unit Control unit K, M Control unit W, T Display unit					
RX.TX UNIT (X44-1450-10, -51, -61) -10 : K, M -51 : T -61 : W								
C1 C4, 5, 7 C8 C11 C13 C16 C19 C20 C21 C22 C23	CC45CH1H220J C91-0131-05 CC45CH1H060D CE04W1C100M CC45CH1H220J CC45SL1H101J C91-0131-05 CC45CH1H180J CC45CH1H050C CC45CH1H220J CC45CH1H0R5C		C 22pF C 0.01μF C 6pF ±0.5pF E 10μF 16V C 22pF C 100pF C 0.01μF C 18pF C 5pF ±0.25pF C 22pF C 0.5pF ±0.25pF					

PARTS LIST

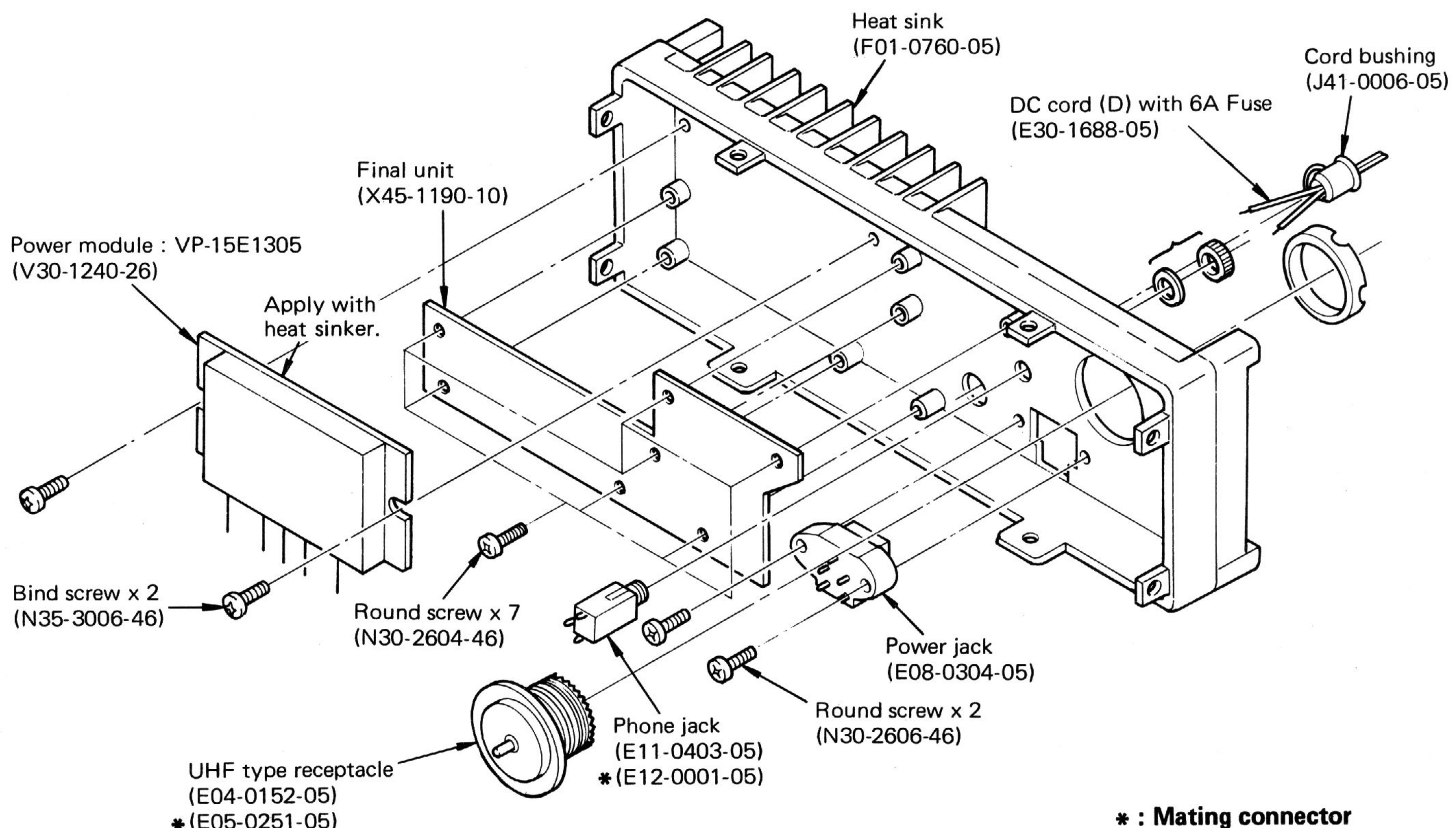
Ref. No.	Parts No.	Re-marks	Description			Ref. No.	Parts No.	Re-marks	Description			
C129	CS15E1A150M		T	15μF	10V	T	C10	C91-0466-05		Cap.	0.001μF	
C130	C91-0131-05		C	0.01μF			C11	CC45SL2H330J		C	33pF	500V
C131	CS15E1A150M		T	15μF	10V	T	C12	CC45CH1H0R5C		C	0.5pF	±0.25pF
C132	CE04W1HR47M		E	0.47μF	50V		C13	CC45CH1H030C		C	3pF	±0.25pF
C139~141	C91-0131-05		C	0.01μF			C14	CC45SL2H330J		C	33pF	500V
TC1	C05-0030-15		Ceramic trimmer 20pF				C15	CC45SL2H100D		C	10pF	±0.5pF 500V
	E23-0046-04		Square terminal x 3				C16	CC45CH1H0R5C		C	0.5pF	±0.25pF
J1~5	E40-0273-05		Mini connect wafer 2P				C17	CC45SL2H220J		C	22pF	500V
J6	E40-0673-05		Mini connect wafer 6P				C19	C91-0131-05		C	0.01μF	
J7	E40-0773-05		Mini connect wafer 7P				C21	CC45SL2H150J		C	15pF	500V
J8	E40-0273-05		Mini connect wafer 2P				C30, 31	CC45SL1H101J		C	100pF	
J9	E40-1173-05		Mini connect wafer 11P				C35	CE04W1C221M		E	220μF	16V
J10	E40-0873-05		Mini connect wafer 8P				J1	E31-2093-05	☆	Coax. connector with 2P lead		
J11	E40-0673-05		Mini connect wafer 6P				J2	E40-0373-05	☆	Mini connect wafer 3P		
J12	E40-0273-05		Mini connect wafer 2P				J3	E31-2093-05	☆	Coax. connector with 2P lead		
L1	L33-0002-05		Choke coil 1μH				J4	E04-0152-05	☆	UHF type receptacle		
L2	L34-0948-05		Tuning coil				J5	E11-0403-05		Phone jack		
L3	L34-0452-05		VHF coil 3φ 6T				J6	E08-0304-05		Power jack Backup		
L4	L34-0691-05		VHF coil 5φ 5T				J7	E40-0373-05		Mini connect wafer 3P		
L5	L79-0482-05	☆	Helical resonator (A) 4 MHz 2pole				E23-0046-04			Square terminal x 6		
L6	L79-0483-05	☆	Helical resonator (B) 4 MHz 3pole				E30-1688-05			DC cord (D) with 6A Fuse		
L7, 8	L30-0281-05		IFT 10.7 MHz				F01-0760-05	☆	Heat sink			
L10	L30-0504-05		IFT 455 kHz				F05-6021-05		Fuse 6A			
L11	L30-0503-05		IFT 455 kHz				J41-0006-05		Cord bushing DC cord			
L12	L40-6825-04		Ferri-inductor 6.8mH				L1	L34-0951-05		Coil (A) 4φ 2.5T		
L13	L40-1021-03		Ferri-inductor 1mH				L2	L34-0438-05		Coil 0.94μH		
L14	L40-1541-27		Ferri-inductor 150mH				L3	L34-0952-05		Coil (B) 4φ 5.5T		
L15	L15-0016-05		Choke trans.				L4, 5	L34-0953-05		Coil (C) 4φ 3.5T		
L16	L40-1511-03		Ferri-inductor 150μH				L6	L33-0025-05		Choke coil 1μH		
L17 (A), (B)	L71-0219-05		MCF 10.7 MHz				L7	L39-0409-05		Detector coil		
L18	L72-0315-05		Ceramic filter CFW455F				L8	L33-0002-05		Choke coil 1μH		
L19	L79-0446-05		Ceramic discri CFY455S				L9	L34-0955-15		Coil (E) 4φ 3.5T		
L20	L34-0683-05		Tuning coil				L10	L33-0074-05		Heater choke		
X1	L77-0327-05		Crystal 10.245 MHz				L11	L33-0002-05		Choke coil 1μH		
	N30-3008-11		Round screw x 2 IC							Round screw x 7		
										Round screw x 2 Back up		
R96	R92-0616-05		Metal film 10kΩ ±1% 1/4W W, T							Bind screw x 2 Module		
R101	RC05GF2H5R6J		Solid 5.6Ω 1/2W				R3	R92-0144-05		Metal film 1Ω		
R107	R92-0616-05		Metal film 10kΩ ±1% 1/4W W, T				VR1	R12-5024-05		Trim. pot 100kΩ (B)		
R108	RN14BK2E4703F		Metal film 470kΩ ±1% 1/4W W, T				VR2	R12-0053-05		Trim. pot 500Ω (B)		
R126	R92-0617-05		Metal film 7.5kΩ ±1% 1/4W W, T									
VR1	R12-4016-05		Trim. pot 50kΩ (B)									
VR2	R12-1020-05		Trim. pot 1kΩ (B)									
VR3	R12-1414-05		Trim. pot 1kΩ (B)									
VR4	R12-1020-05		Trim. pot 1kΩ (B)									
VR5~7	R12-1405-05		Trim. pot 3kΩ (B)									
VR8	R12-4403-05		Trim. pot 50kΩ T									
VR9	R12-2409-05		Trim. pot 5kΩ W, T									
	R92-0150-05		Short jumper									
PLL UNIT (X50-1750-10)												
C3	CC45CH1H0R5C						C	0.5pF		±0.25pF		
C4	CC45TH1H080D						C	8pF		±0.5pF		
C5	CC45CH1H020C						C	2pF		±0.25pF		
C6	CC45CH1H050C						C	5pF		±0.25pF		
C7	CE04W1A220M						E	22μF		10V		
C11	CC45CH1H070D						C	7pF		±0.5pF		
C12	CC45CH1H030C						C	3pF		±0.25pF		
C13	CC45CH1H050C						C	5pF		±0.25pF		
C14	CE04W1A101M						E	100μF		10V		
C16	CC45CH1H040C						C	4pF	</			

PARTS LIST

DISASSEMBLY

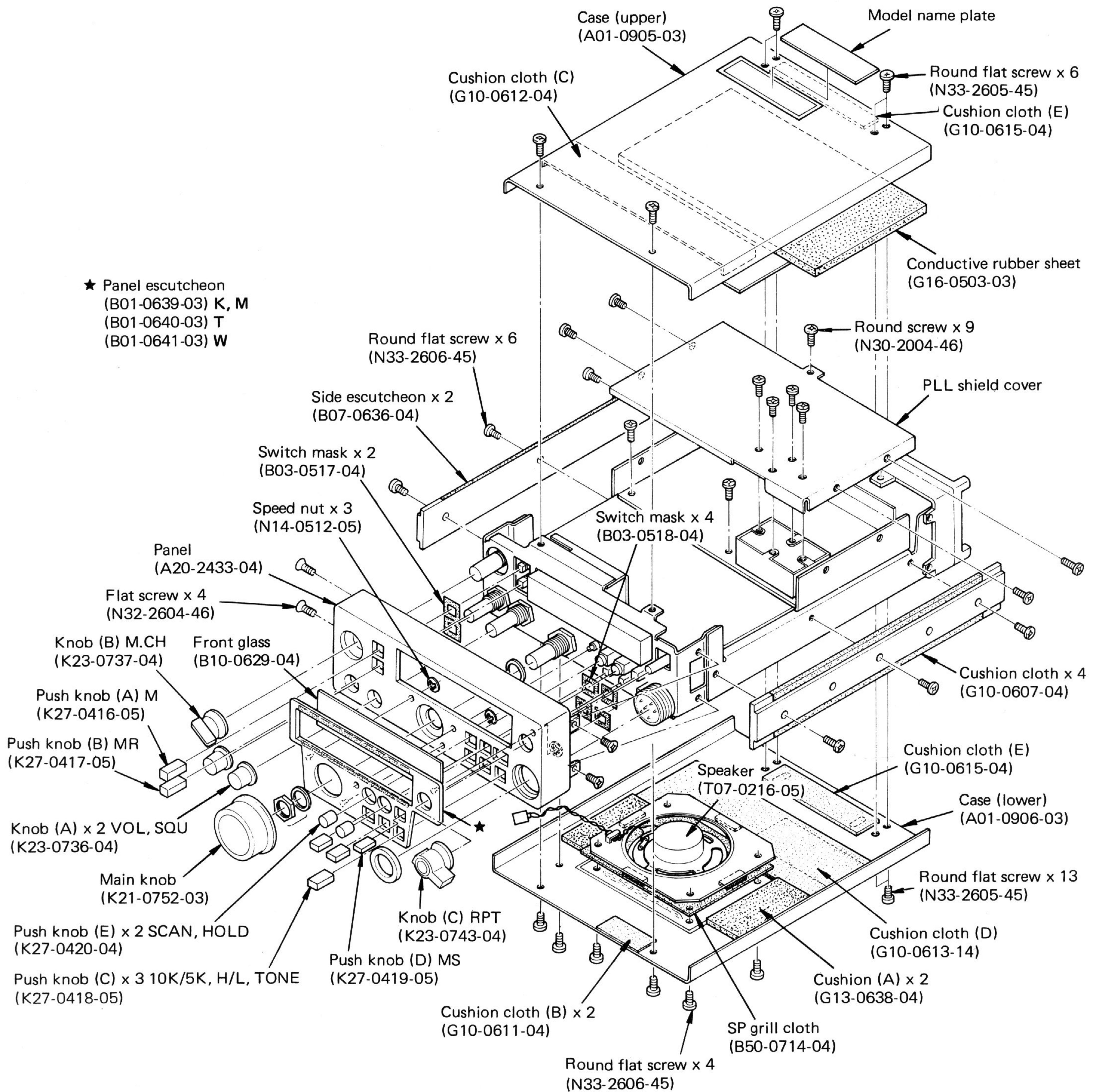


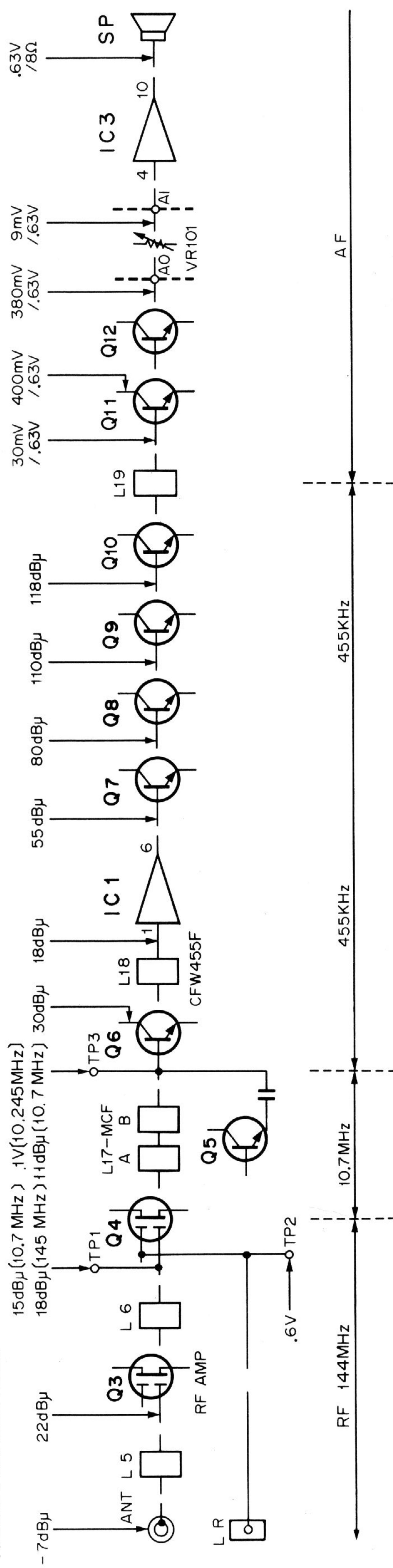
* : Mating connector



* : Mating connector

DISASSEMBLY





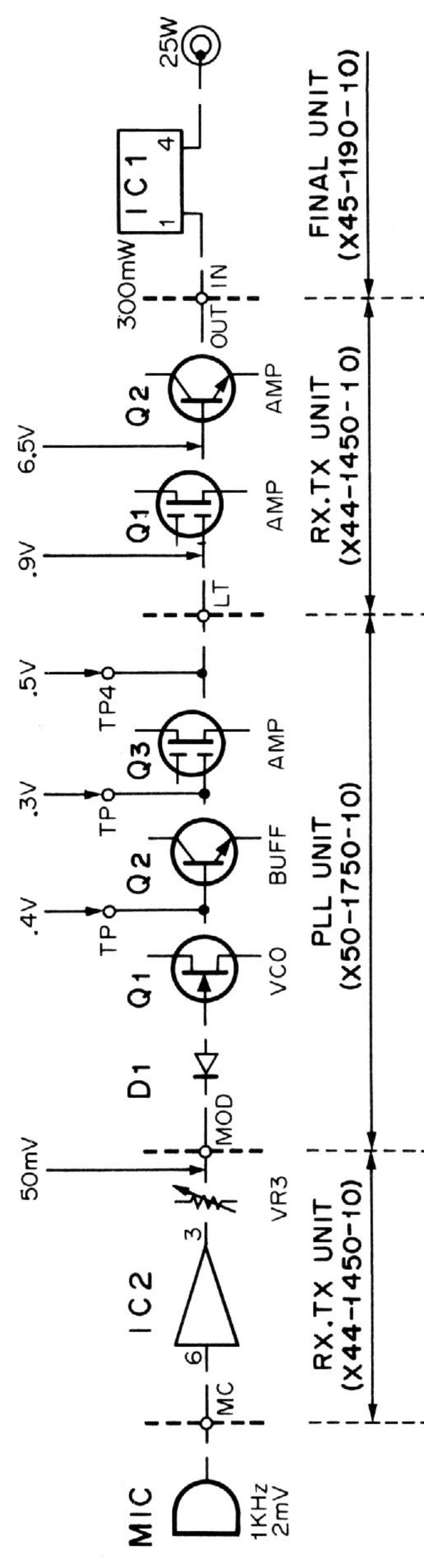
- Notes :**
1. To inject signal generator output connect a $0.01\mu F$ capacitor between the signal generator and the check point.
 2. In measuring the circuit from the ANT terminal to the base of Q10, unmodulated 144 MHz, 10.7 MHz, and 455 kHz signals from an SSG are applied to the check point to obtain a 20 dB NQ sensitivity.

LEVEL DIAGRAM

< REFERENCE >

Japanese "SG"	American "SG"
-6dB	0.25 μ V
0dB	0.5 μ V
6dB	1 μ V
12dB	2 μ V
24dB	8 μ V
30dB	15.8 μ V
40dB	50 μ V
50dB	158 μ V
60dB	500 μ V
70dB	1.58 mV
80dB	5mV
90dB	15.8 mV
100dB	50 mV
120dB	0.5 V

TRANSMITTER SECTION



- Notes :**
1. Voltages in MIC AMP are measured by an AF VTVM with an input of 1 kHz, 2 mV.
 2. Voltage measurements before OUT terminal are read from an RF VTVM with OUT cable disconnected at HI power position.

ADJUSTMENT

<Test Equipment>

1. Tester or DVM
 - Input: Sufficient
2. RF VTVM (RF V.M.)
 - Input impedance: 1 MΩ and less than 2 pF
 - Voltage range: F.S. = 10 mV to 300V
 - Frequency range: 150 MHz or greater
3. Frequency counter (*f* counter)
 - Minimum input voltage: 50 mV
 - Frequency range: 150 MHz or greater
4. DC power supply
 - Voltage 10V to 17V variable
 - Current: 8A min.
5. RF Power Meter
 - Dissipation: 50W
 - Impedance: 50Ω
 - Frequency range: 144 MHz
6. AF VTVM (AF V.M.)
 - Input impedance: 1 MΩ or greater
 - Voltage range: F.S. = 1 mV to 30V
 - Frequency range: 50 Hz to 10 kHz
7. AF Generator (AG)
 - Frequency range: 100 Hz to 10 kHz
 - Output: 0.5 mV to 1V
8. Linear detector
 - Frequency range: 144 MHz
9. Directional coupler
10. Oscilloscope
 - With horizontal input and high sensitivity
11. Standard signal generator (SSG)
 - Frequency range: 144 ~ 149 MHz
 - Modulation: amplitude and frequency modulation
 - Output: -20 dB ~ 100 dB
12. AF Dummy load
 - 8Ω, 5W (approx.)
13. Sweep generator
 - Frequency range: 144 ~ 149 MHz

<Preparation>

Unless otherwise specified, set the controls as follows.

POWER / VOL SW	ON
SEND / REC	REC
SQUELCH VOL	MIN
M. CH SW	1
M. SW	OFF
M.R SW	OFF
SCAN SW	OFF
HOLD SW	OFF
M.S SW	OFF
TONE	OFF
HI /LOW SW	HI
25k / 5k (W) (T)	25k
10k / 5k (K) (M)	5k

Notes:

- When adjusting the trimmers or coils, use a non-induced adjusting rod of bakelite, etc.
- When adjusting the RX section never transmit to prevent SSG damage.
- Connect MIC connector as shown in Fig. 11.

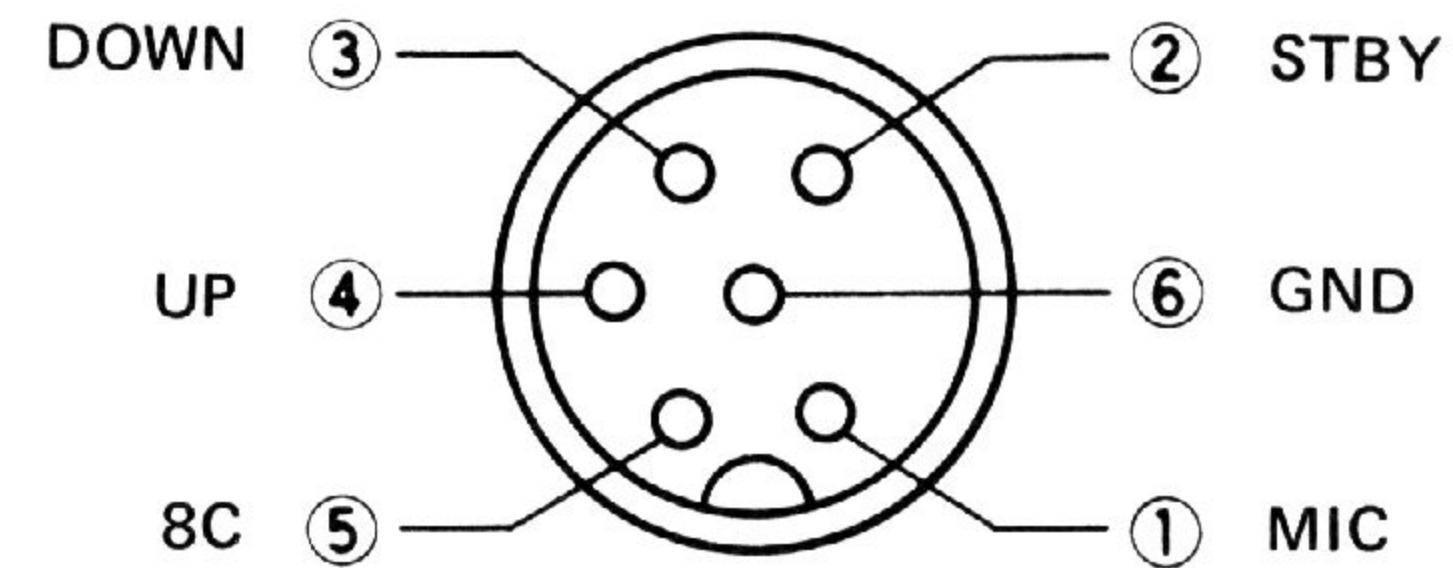


Fig. 11 MIC terminals (view from front panel side)

- The output level of SSG is indicated as SSG's open circuit.

ADJUSTMENT

VOLTAGE CHECK

Item	Condition	Measuring point			Adjustment			Specifications	Remarks
		Test equipment	Unit	Ter-minal	Unit	Part	Method		
1. Voltage check	1) Connect DC power (13.8V) to the radio.	DVM	RX.TX	8C				7.8~8.25V	Verify all voltage levels.
				8R				7.8~8.25V	
				8T				0V	
				ST				13~13.8V	
	2) POWER SW : OFF		Control	Pin 21 of IC1				5.0~5.4V	
				Pin 16 of IC2				5.0~5.4V	
	3) POWER SW : ON Transmit.		Control	Pin 21 of IC1	RX.TX	VR4	5.2V	±0.2V	Verify voltages.
				8T				9.3~9.7V	
	4) Return to receive.			8R				0.5V or less	

PLL ADJUSTMENT

Item	Condition	Measuring point			Adjustment			Specifications	Remarks				
		Test equipment	Unit	Ter-minal	Unit	Part	Method						
1. PLL (1)	1) Remove the PLL shield. f : 147.000 MHz Disconnect the coax. connector J2 from the RX. TX unit.	Oscillo-scope	PLL	R51 (Emitter of Q9)	PLL	L7, 10	Adjust for square wave.	 OK  NG					
2. PLL (2)	2)	RF V.M	PLL	TP4	PLL	L5	MAX	(0.4V)	() : reference value				
	1) f : 144.000 MHz Receive. Transmit.	f counter	PLL	TP4	PLL	L14	133.3000 MHz	±100 Hz					
						L13	144.0000 MHz						
						TC4	133.3050 MHz	±100 Hz					
	2) f : 144.005 MHz Receive. Transmit.					TC3	134.0050 MHz						
						L14	133.3000 MHz	±100 Hz	Check				
	3) f : 144.000 MHz Receive. Transmit.					L13	144.0000 MHz						
3. Lock voltage		DVM	PLL	TP1	PLL	TC1	1.9V	±0.01V					
						TC2	2.0V						
								7V or less					
4. Unlock voltage	1) f : 144.000 MHz Receive. Transmit.	DVM	PLL	TP1	PLL	TC1	1.7V	6V or less	Check				
						TC2	2.0V						
	2) f : 148.990 MHz Receive. Transmit.												
5. Lock voltage check	1) Replace the PLL shield.	DVM	PLL	TP1	PLL	TC1	1.7V	±0.3V					
	2) Disconnect ground from TP1.												
6. Frequency adjustment	1) f : 144.000 MHz Transmit. Receive.	f counter	PLL	TP4	PLL	L14	144.0000 MHz	±100 Hz					
						L13	133.3000 MHz						

ADJUSTMENT

RECEIVER ADJUSTMENT

Item	Condition	Measuring point			Adjustment			Specifications	Remarks
		Test equipment	Unit	Terminal	Unit	Part	Method		
1. Helical resonator	1) Disconnect the LR coax. connector J4 from the RX. TX unit. Connect the sweep generator output to the ANT terminal.		RX.TX	TP1	RX.TX	L5, 6	Adjust L5 and 6 to obtain the waveform shown at right.	144.00MHz 148.990MHz	
	2) Reconnect the LR coax. connector on the RX.TX unit.								
2. Sensitivity	1) Connect a 100 μ A S meter to the M terminal on the RX.TX unit. Connect an AF V.M., oscilloscope and an 8 Ω load to the EXT.SP terminal. Connect an SSG (MOD : 1 kHz, DEV : 5 kHz) to the ANT terminal.							(0.7V)	
	2) f : 145.000 MHz		RF V.M.	RX.TX	TP2	RX.TX PLL	L20 L5		
	3) SQ VOL : Min. Receive the SSG signal.		External S meter	RX.TX	M	RX.TX	L7, 8		
	4) SSG output level : 40 dB μ		AF V.M., Oscilloscope	Rear panel	EXT. SP	RX.TX	L11		
3. S meter	1) SSG output level : 15 dB μ Disconnect the external S meter from the M terminal.	S-indicator			RX.TX	VR1	Adjust VR1 so that the LED "8" indicator is lit.		
4. Squelch	1) SSG output level : -10 dB μ Fine tune the SSG frequency so that the SSG signal is received at maximum strength.								
	2) f : 145.020 MHz Turn the squelch control until noise is gated.	BUSY-indicator						Must go off.	Check
		Squelch control setting						9 o'clock to 12 o'clock	
	3) f : 145.000 MHz	BUSY-indicator						Must be lit when the SSG signal is again received.	Check
5. Sensitivity measurement	1) SSG output level : -6 dB μ f : 145.000 MHz AF gain control setting : 0.63V/ 8 Ω Fine tune the SSG frequency to obtain the maximum AF V.M reading.	AF V.M.			< REFERENCE >			S/N 20 dB or more	Check
					Japanese "SG"	American "SG"			
					-6dB	0.25 μ V			
					0dB	0.5 μ V			
					6dB	1 μ V			
					12dB	2 μ V			
					24dB	8 μ V			
					30dB	15.8 μ V			
					40dB	50 μ V			
					50dB	158 μ V			
					60dB	500 μ V			
					70dB	1.58mV			
					80dB	5mV			
					90dB	15.8mV			
					100dB	50mV			
					120dB	0.5V			

ADJUSTMENT

TRANSMITTER ADJUSTMENT

Item	Condition	Measuring point			Adjustment			Specifications	Remarks
		Test equipment	Unit	Ter-minal	Unit	Part	Method		
1. Setting	Connect the power meter to the ANT terminal. f : 146.000 MHz RX.TX unit, TC1 : centered RX.TX unit, VR6 : fully clockwise								
2. Power and RF indicator adjustment	1) Transmit.	DC A.M., Power meter			RX.TX	L2 TC1	} MAX	30W or more	
					RX.TX	VR6	29W		
	2) HI/LOW : LOW				RX.TX	VR5	5W		
	3) HI/LOW : HI				RX.TX	VR6	20W		
	4) RF indicator at high power				Final	VR1	Set VR1 so that LED "10" is lit.		
	5) HI/LOW : HI				RX.TX	VR6	29W		
3. Protection	6) RF indicator at low power							At least one of the LEDs should light.	Check
	1) HI/LOW SW : HI	DVM	RX.TX	PRO	Final	VR2	Min.	(0.4V or less)	
4. Power check	2) Disconnect the power meter from the ANT terminal.	DC A.M.			RX.TX	VR7	1.5A	±0.1A	Adjust as quickly as possible.
	1) Adjust the power supply voltage to 13.8V. Connect the power meter to the ANT terminal. f : 144.000MHz 146.000 148.990	Power meter, DC A.M.						25W or more 5.5A or less	Check
	2) HI/LOW SW : LOW	Power meter, DC A.M.						0.8~1.5W 1.2A or less	
5. Modulation	1) HI/LOW SW : HI Connect the AG (20mV, 1 kHz) to the MIC terminal.	Linear detector			RX.TX	VR3	5 kHz deviation	±0.3 kHz	
	2) AG output level : 2 mV, 1 kHz	Linear detector			RX.TX	VR2	3.5 kHz deviation	±0.3 kHz	
	3) Check for abnormal oscillation by varying the power supply voltage from 11.5 V to 16 V at any frequency.							There should be no abnormal oscillation.	
	4) Return to receive.								

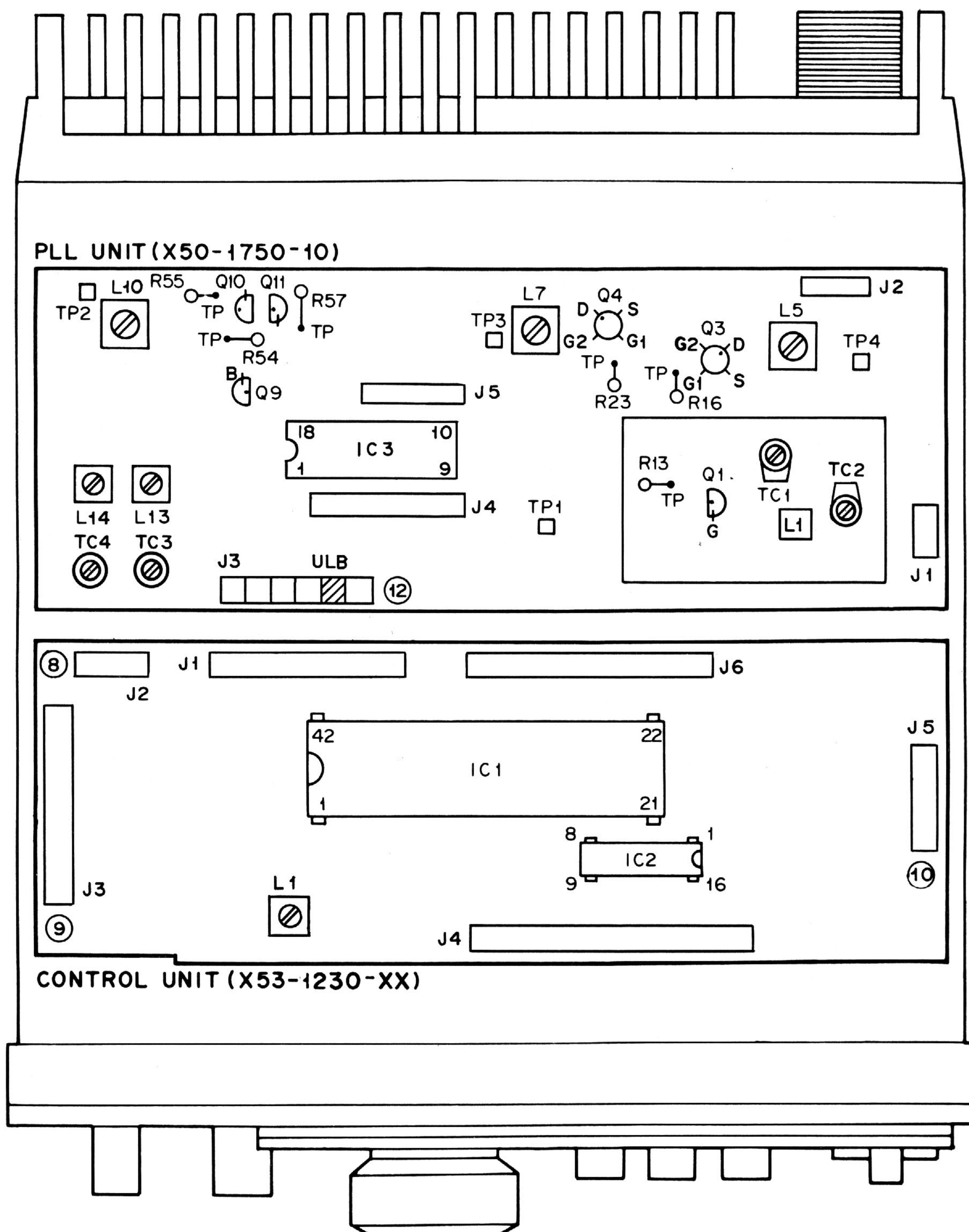
ADJUSTMENT

MICROPROCESSOR OPERATION CHECK

Item	Control functions	Microprocessor functions	Remarks
1.	1) Disconnect DC power. Reconnect after waiting 20 sec.	<i>E.7730</i> is displayed.	Reset operation check
2. Main dial	1) Turn the main dial. 2) 5K/10K SW : 10K, Turn the main dial.	Indication changes in 5 kHz increments. Indication changes in 10 kHz increments.	
3. UP/DOWN	1) Press the UP or DOWN switch once. 2) 5K/10K SW : 5K 2) Press and hold the UP or DOWN switch. 3) Press the UP and DOWN switch simultaneously.	When pressed, the frequency indication increases or decreases in 5 kHz increments. The frequency indication increases or decreases continuously. The frequency does not change.	The frequency indication changes in 10 kHz steps with 5K/10 kHz SW at 10 K.
4. Memory entry	1) M.CH switch : 1~5 M.R switch : ON 2) M.R switch : OFF M.S switch : ON 3) M.S switch : OFF M.CH switch : 1~5 M switch : ON 4) M.CH switch : 5 Set the main dial in a position different from that set during step (3). Set in transmit mode and then press the M switch. 5) Return to receive.	<i>4.7730</i> is displayed. <i>4.7730</i> is displayed. Pressing the M switch causes the displayed frequency to be stored in the selected memory corresponding to the M.CH switch setting. The displayed frequency is stored in the transmit frequency memory of memory 5.	In memory channel 5, the transmitting frequency is different from the receiving frequency.
5. Memory recall	1) M.CH switch : 1~5 M.R switch : ON 2) Turn the main dial. 3) UP/DOWN switch : ON 4) M.S switch : ON 5) SCAN switch : ON 6) M.S switch : OFF 7) M.CH switch : 5 Set in transmit. 8) Return to receive. M.R switch : OFF	Each frequency stored during step 4. (3) is displayed. The frequency displayed does not vary.	M.R operation has priority.
6. SCAN	1) Squelch control : Max SCAN switch : ON 2) Press and hold the SCAN switch. 3) Squelch control : Min. 4) Squelch control : Max 5) Set in transmit. 6) Set in receive. SCAN switch : ON 7) HOLD switch : ON 8) SCAN switch : ON	The frequency increases in increments of 5 kHz. Scan speed becomes faster. BUSY indicator is lit and scan stops. Scan resumes. Scan stops. Scan stops. Scan stops.	
7. Memory scan	1) M.S switch : ON 2) Squelch control : Min. 3) Squelch control : Max 4) Set in transmit. 5) Return to receive. SCAN switch : ON	Frequencies stored in the memory during step 4. (3) are scanned. BUSY indicator is lit and scan stops. Scan resumes. Scan stops. Scan resumes.	Memory scan has priority. Scanning order → 1 → 2 → 3 5 ← 4 ← 1~5 continuous.
8. Switch priority	1) M.R : ON 2) M.S : ON 3) SCAN, HOLD : ON 4) UP DOWN : ON 5) Main dial 6) M : ON	Memory reading Memory scan Scanning operation UP/DOWN operation Memory entry	Priority 1st 2nd 3rd 4th 5th 6th

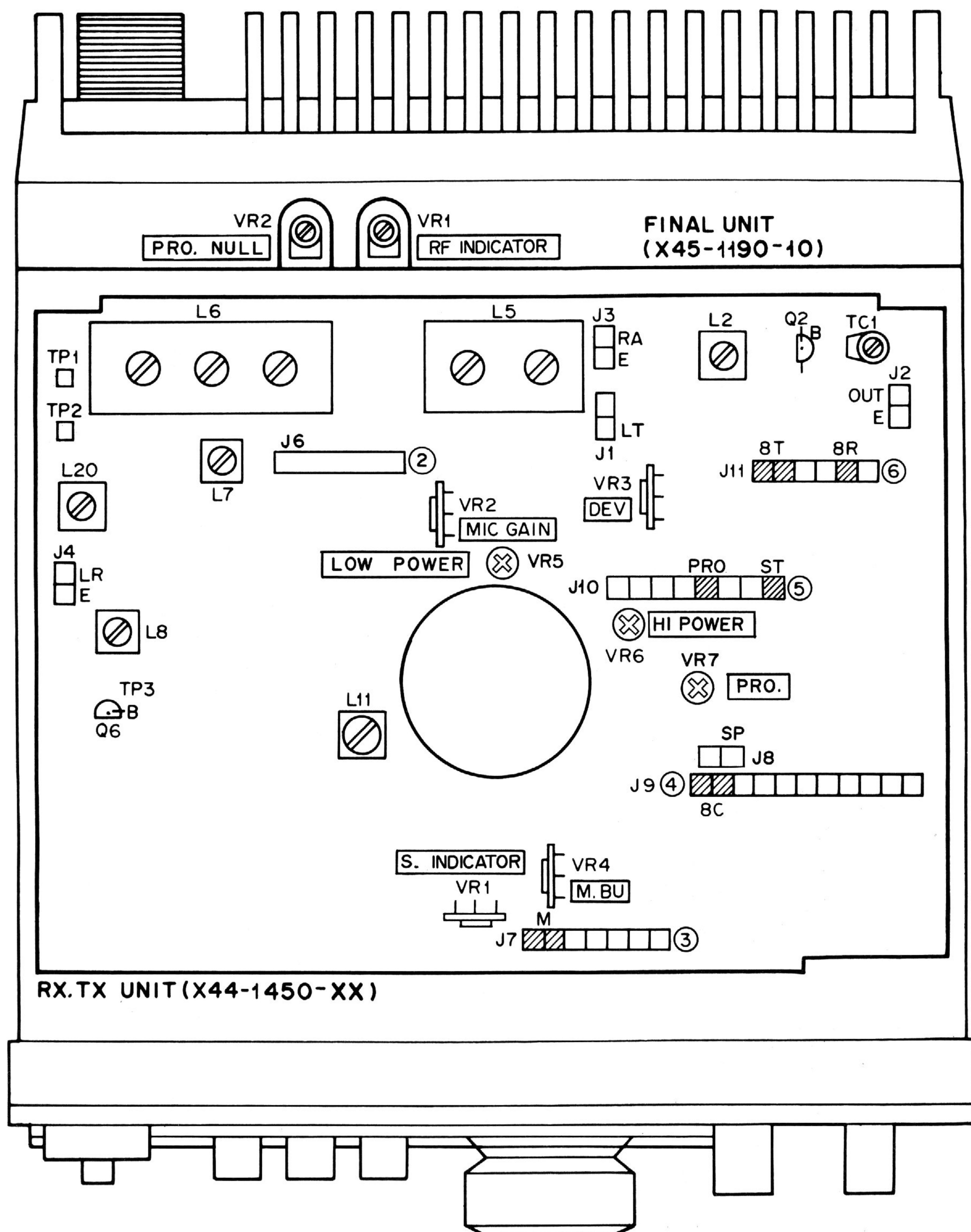
ADJUSTMENT

TOP VIEW

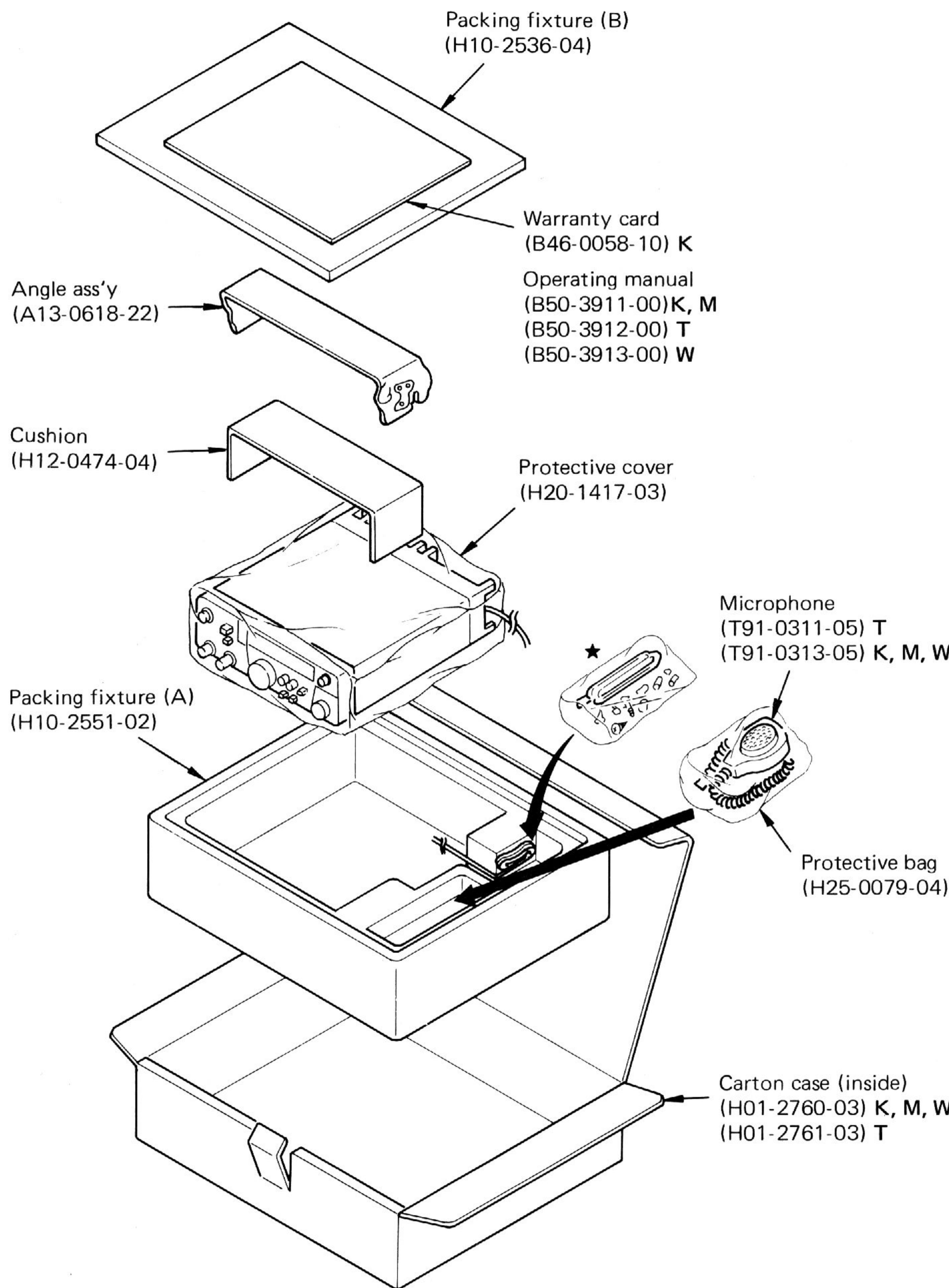


ADJUSTMENT

BOTTOM VIEW

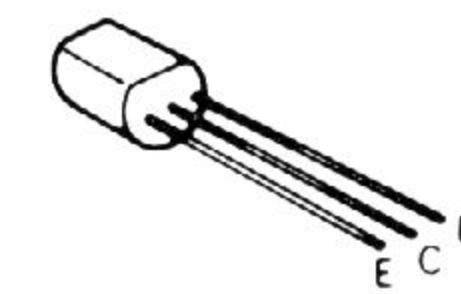
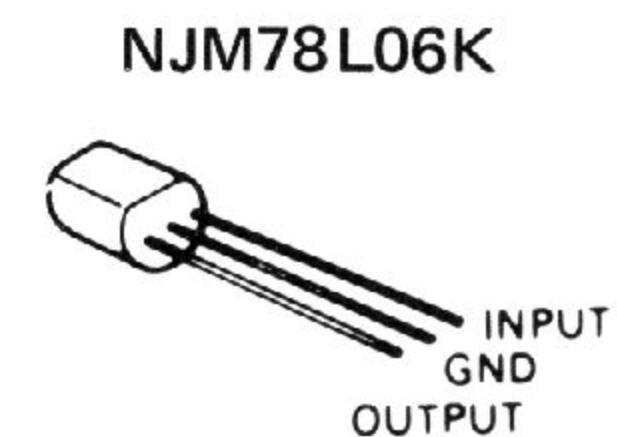


PACKING

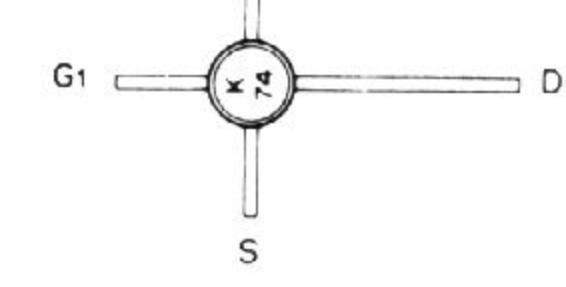


- ★ Protective bag (H25-0103-04)
- Phone plug (E12-0001-05)
- DC cord (C) (E30-1689-05)
- Fuse 6A (F05-6021-05)
- Foot x 2 (J02-0022-05) (Rear)
- Foot (J02-0420-04) (Front)
- Foot mounting hardware x 2 (J21-2676-04)
- Protective bag (H25-0029-04)
- Boss x 4 (J32-0748-04)
- Bind screw x 4 (N35-3012-45)
- Accessory bag (H25-0049-03)
- Round screw x 4 (N09-0008-04)
- Flange nut x 4 (N14-0510-04)
- Flat washer x 4 (N15-1060-46)
- Spring washer x 4 (N16-0060-46)
- Bind screw x 6 (N35-3006-45)

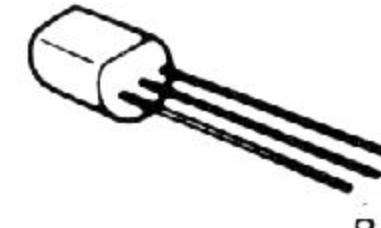
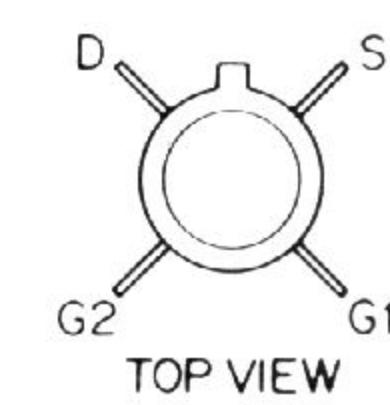
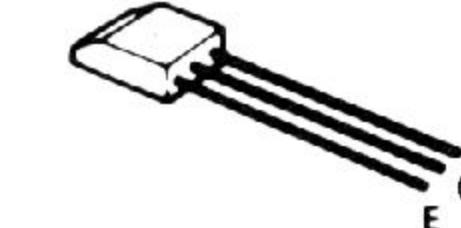
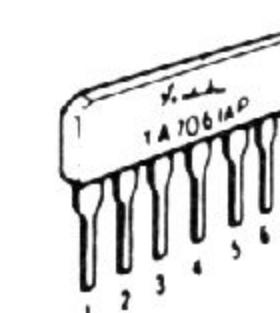
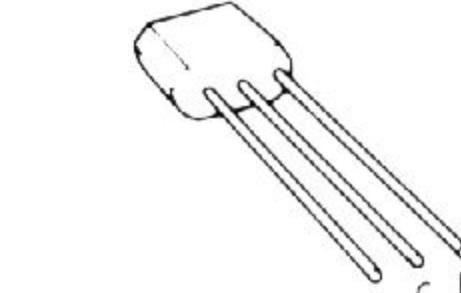
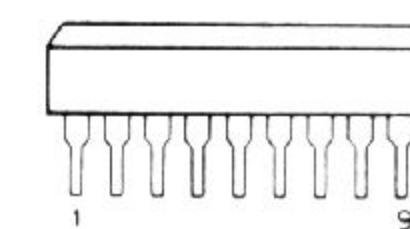
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2SC1923
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2SC2240



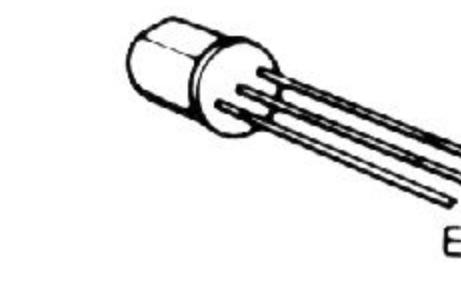
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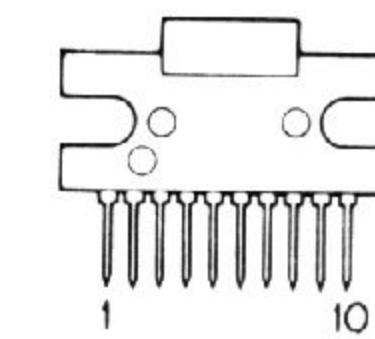
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3SK76
3SK922SC458
2SC460TC5081P
TC5082P-GL2SA1115
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TA7302P

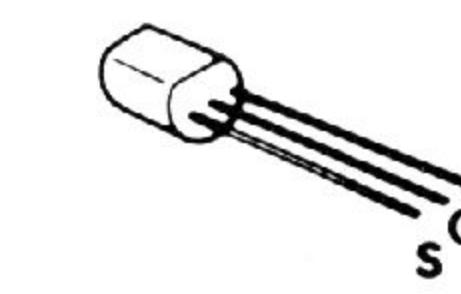
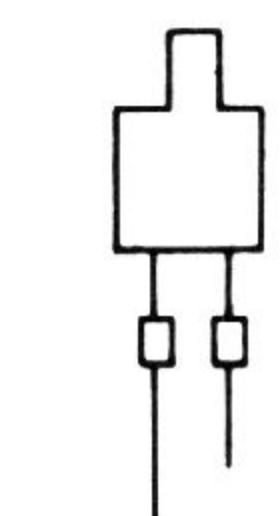
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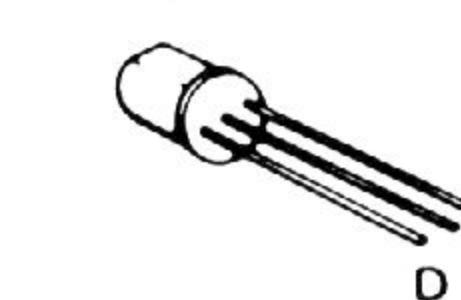
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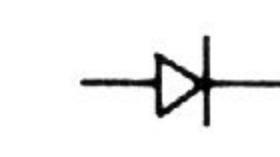
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LN333GP
LN433YP

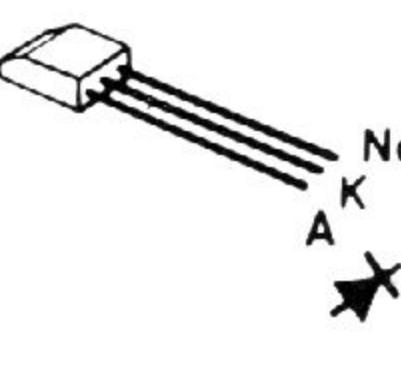
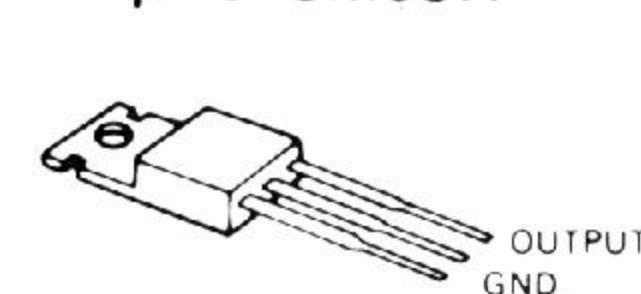
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
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μPC78M08H




SCHEMATIC DIAGRAM (K, M TYPE)

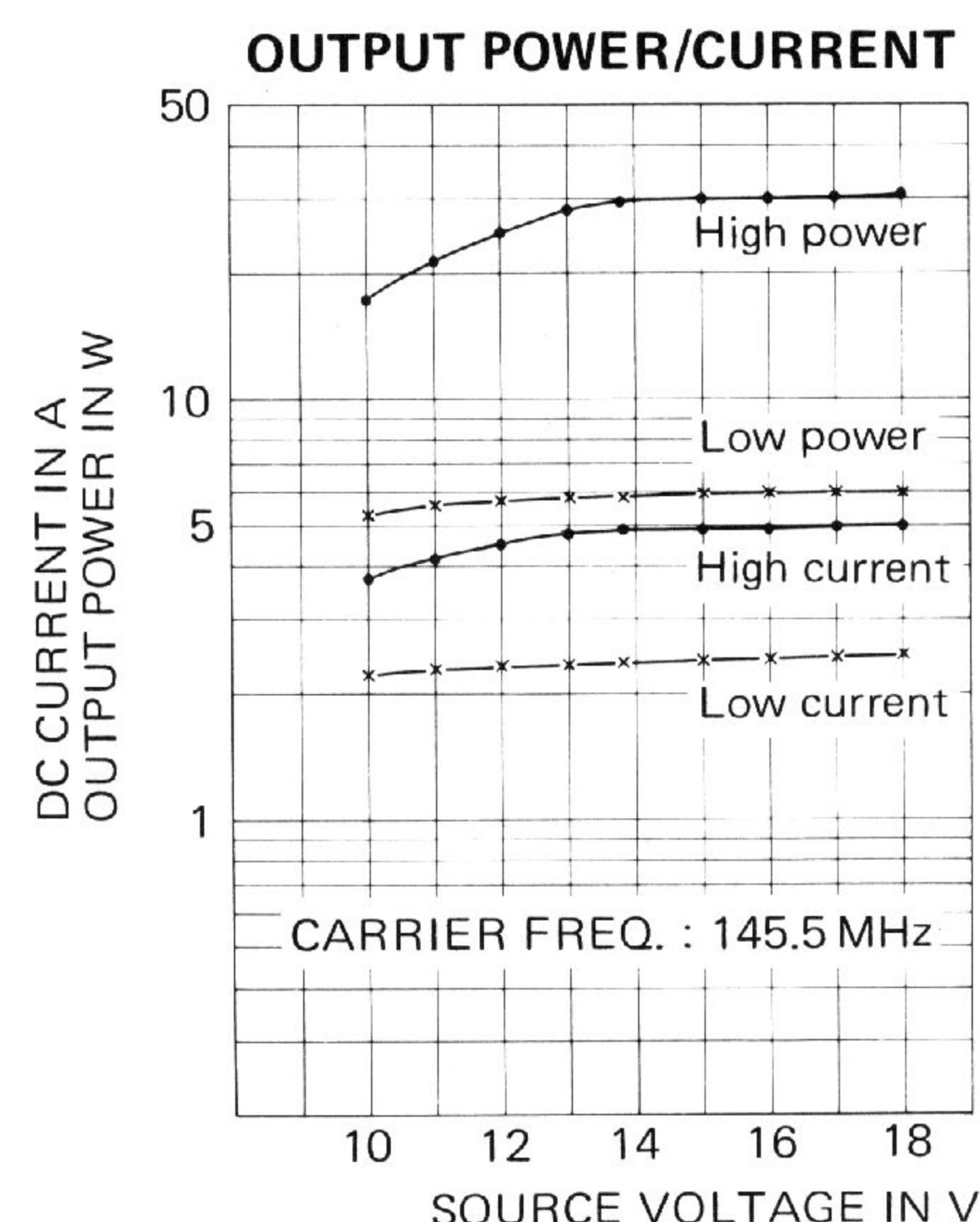
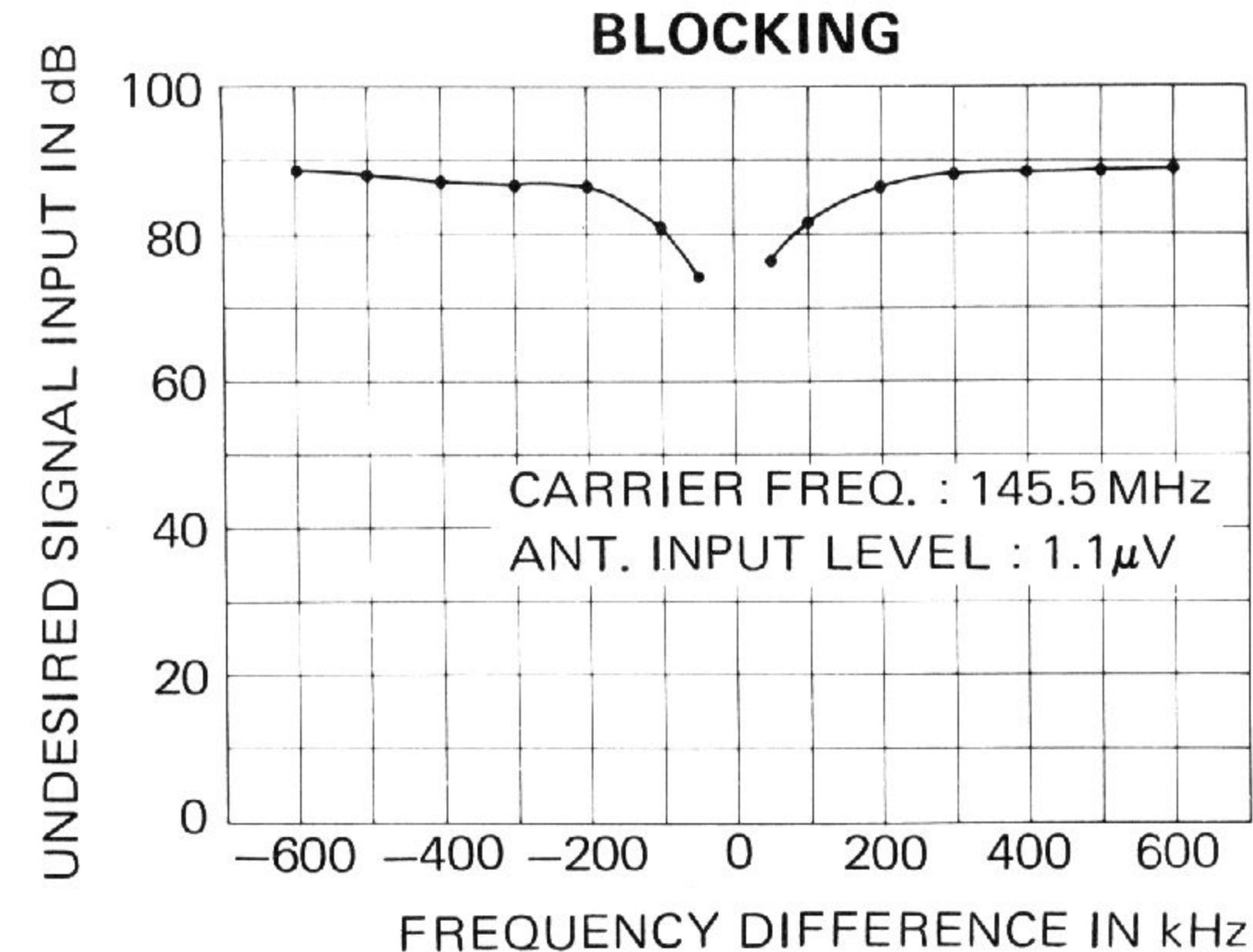
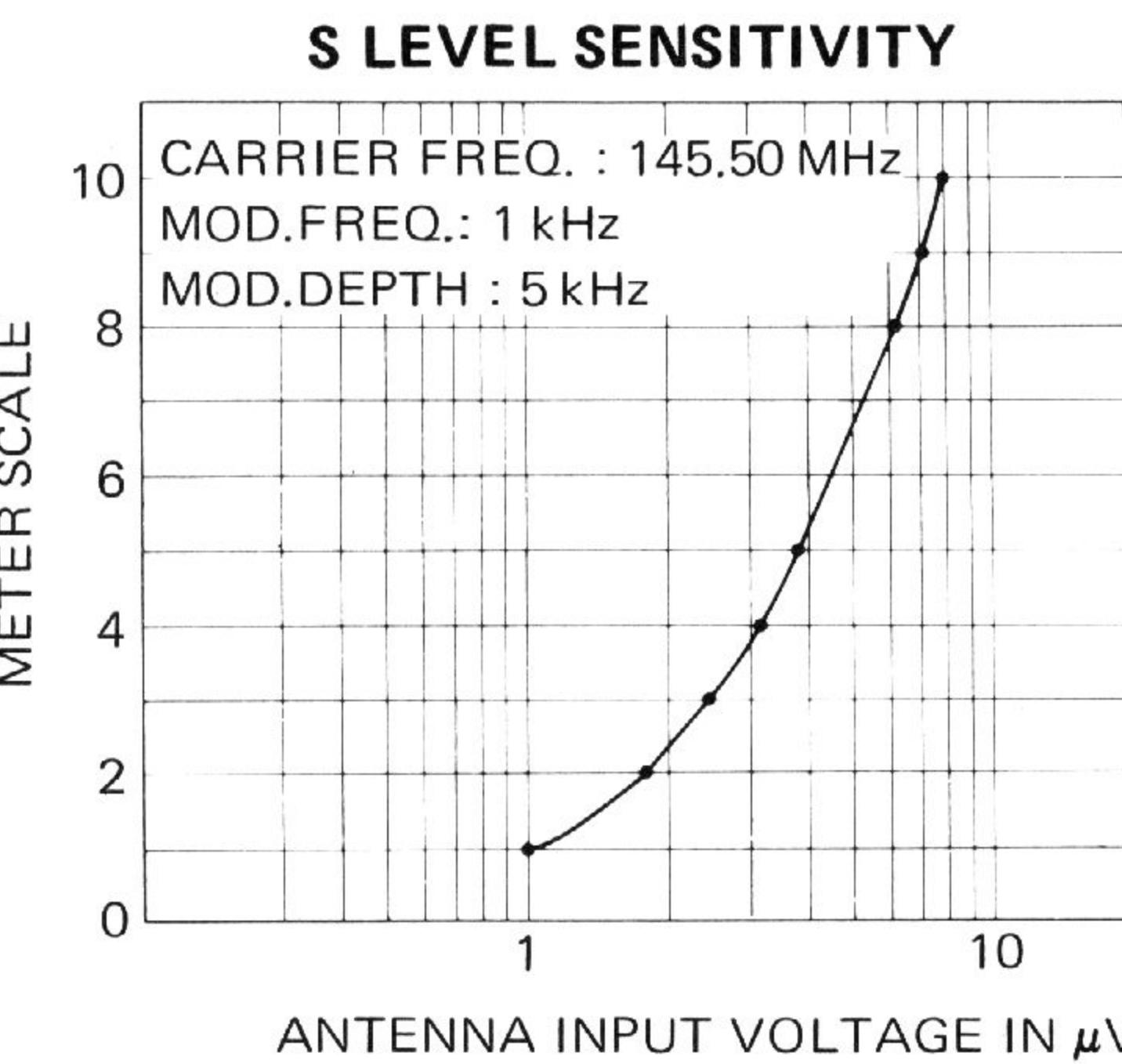
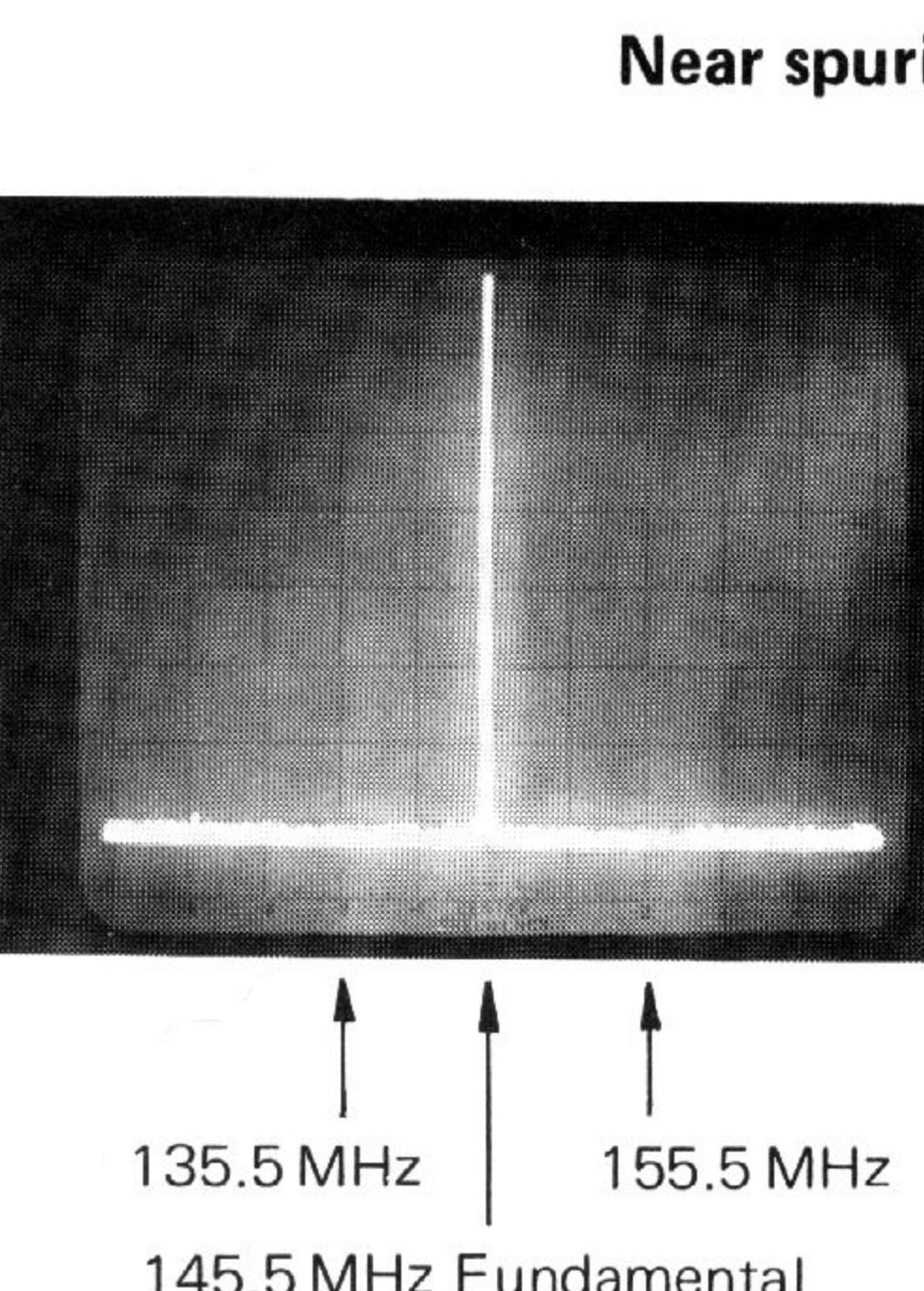
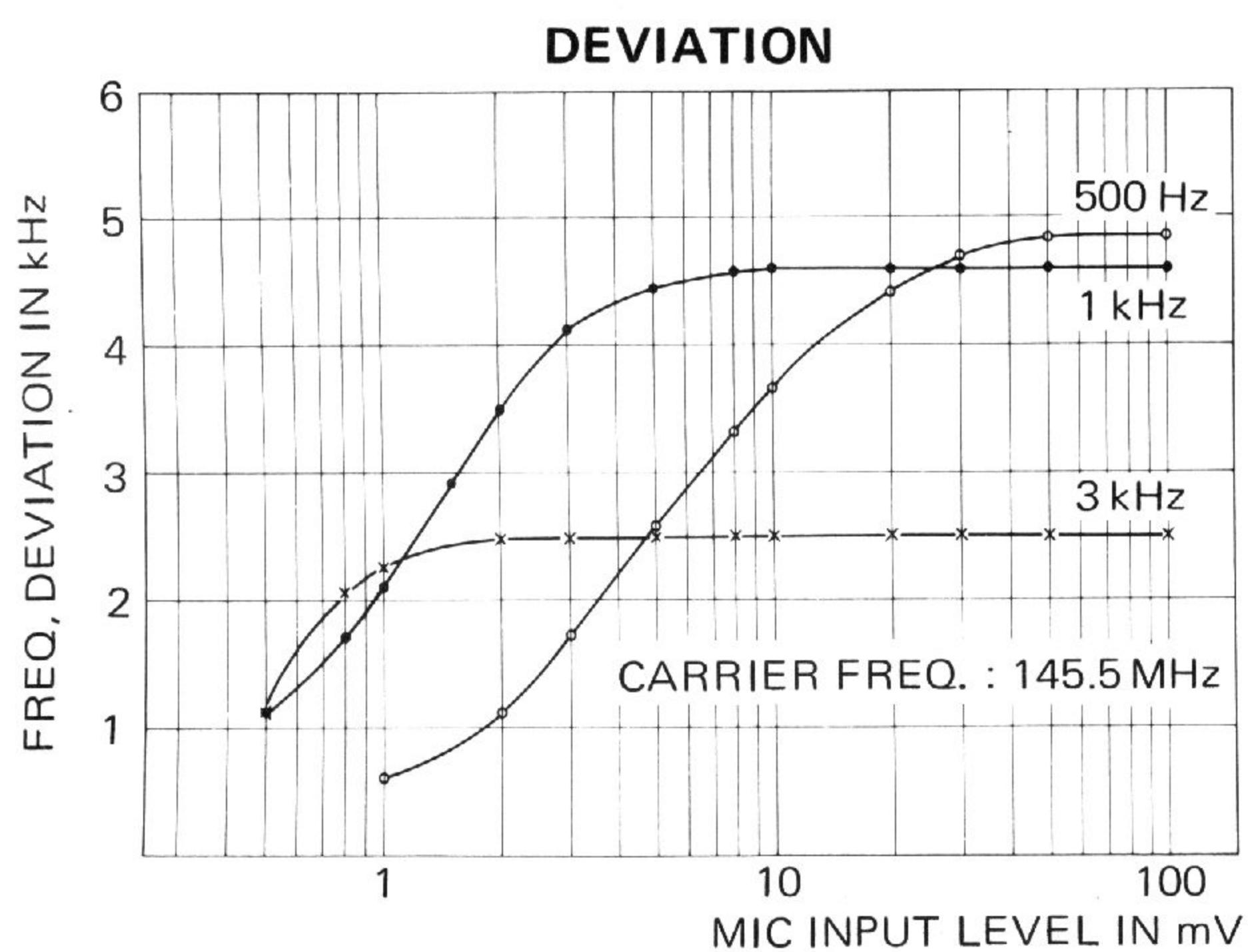
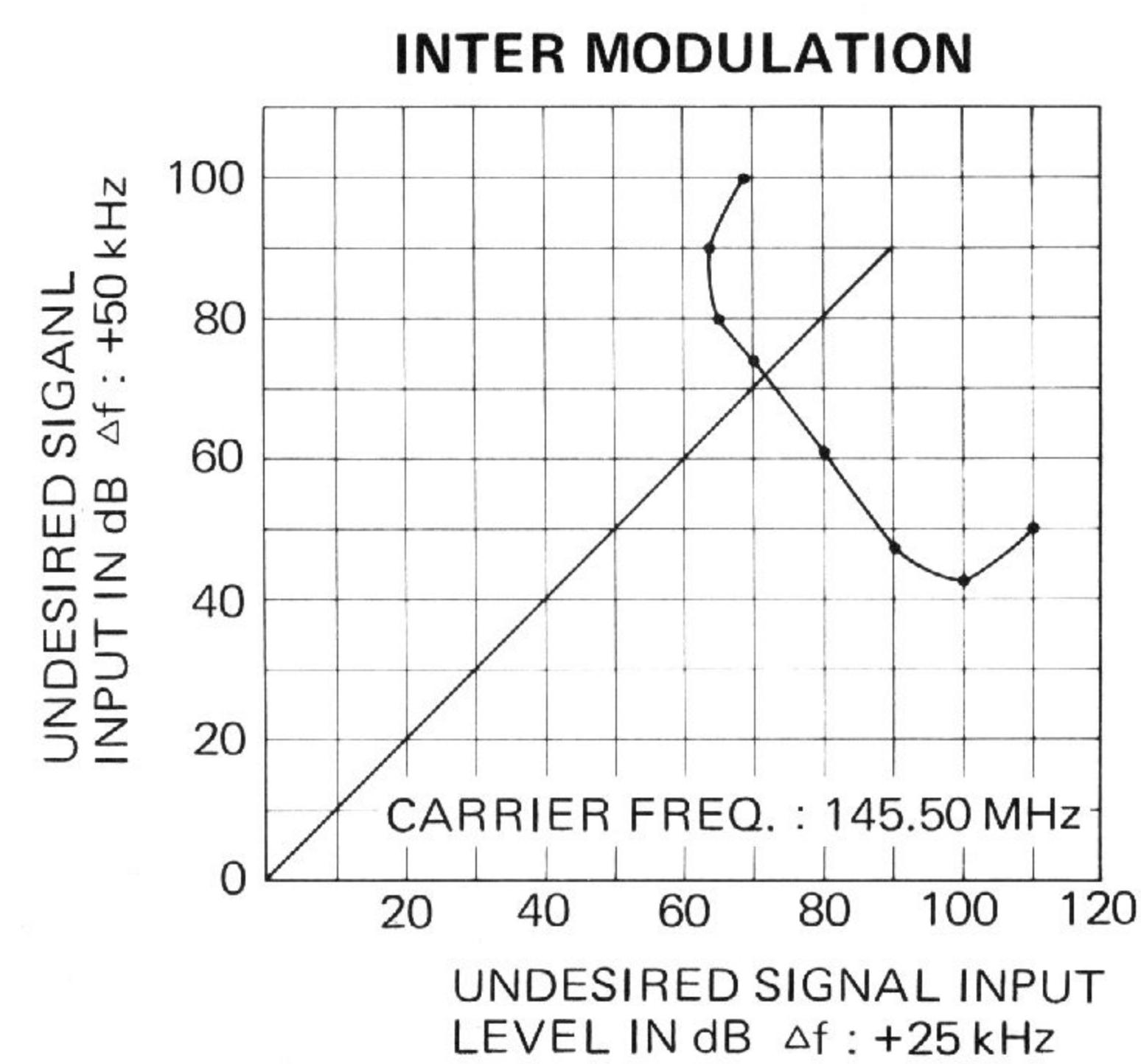
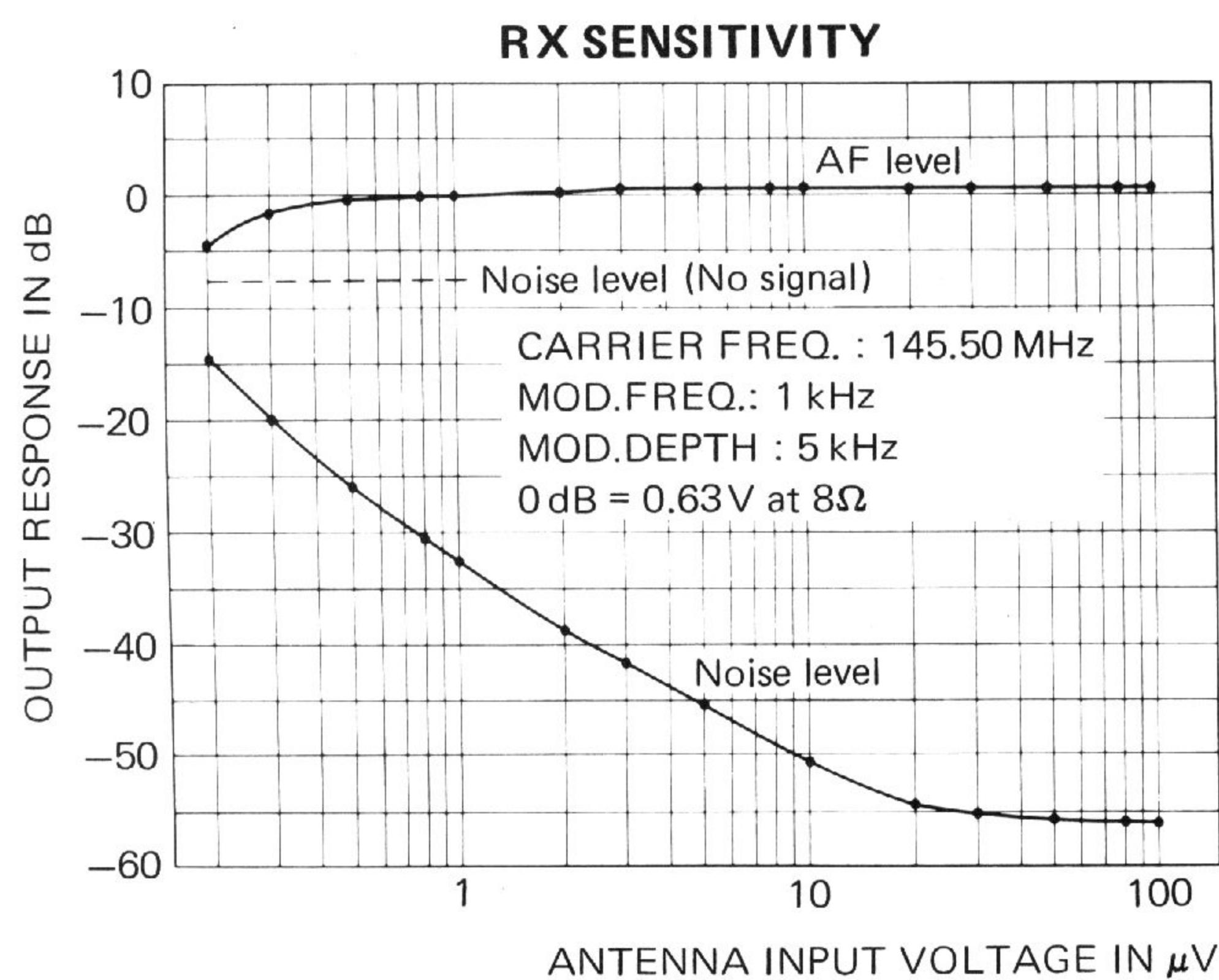


Voltage measurement conditions $f = 145.00\text{MHz}$, RX no signal, DC 13.8V, () : TX

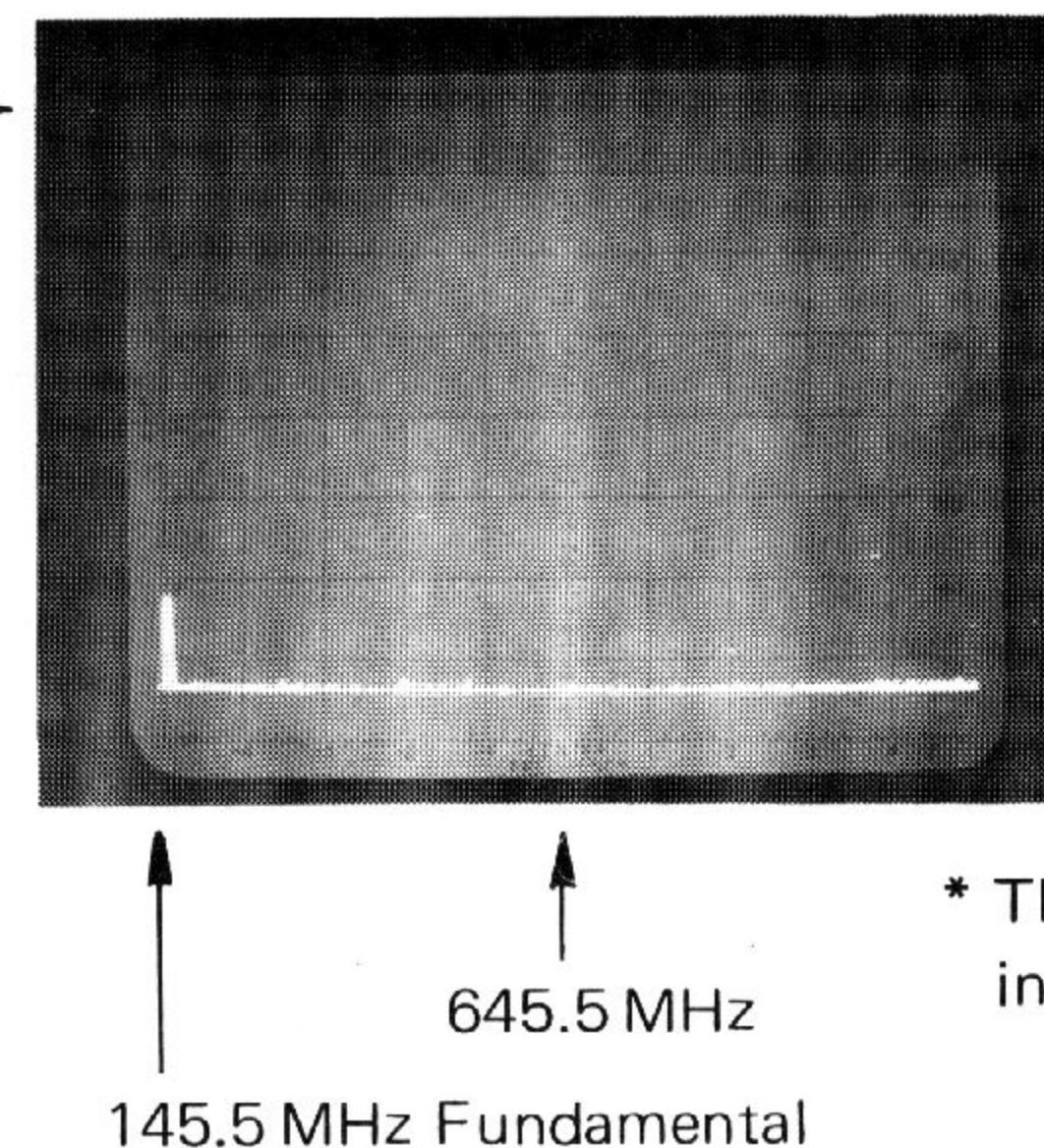
SCHEMATIC DIAGRAM (T, W TYPE)

Signal Line Control Line Common DC line



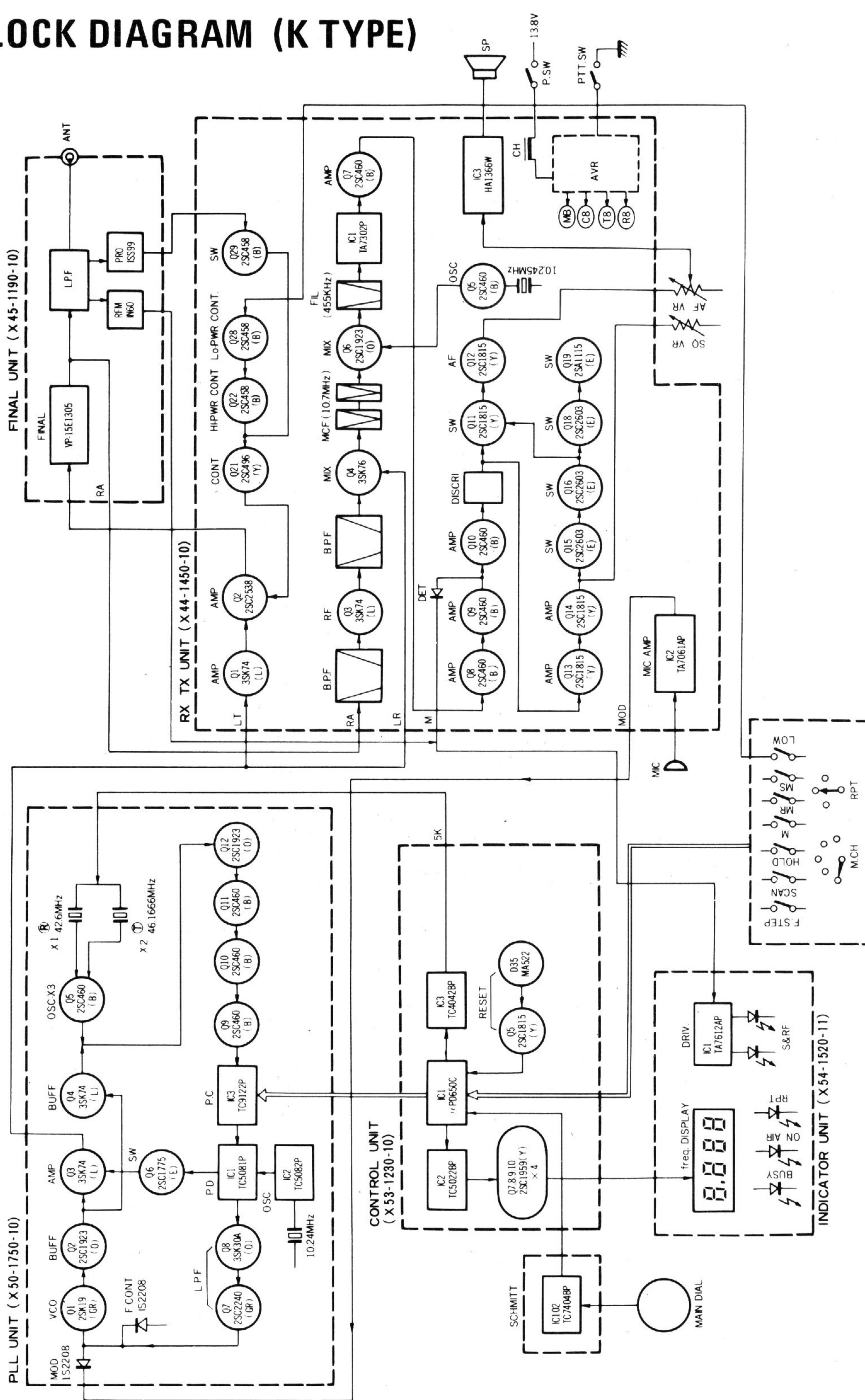


Fundamental signal level*



* The fundamental has been reduced in amplitude by the H.P.F.

TR-7730 BLOCK DIAGRAM (K TYPE)



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